32-bit RISC Microcontroller

CMOS

FR30 Series MB91101

MB91101

■ DESCRIPTION

The MB91101 is a standard single-chip microcontroller constructed around the 32-bit RISC CPU (FR* family) core with abundant I/O resources and bus control functions optimized for high-performance/high-speed CPU processing for embedded controller applications. To support the vast memory space accessed by the 32-bit CPU, the MB91101 normally operates in the external bus access mode and executes instructions on the internal 1 Kbyte cache memory and 2 Kbytes RAM for enhanced performance.

The MB91101 is optimized for applications requiring high-performance CPU processing such as navigation systems, high-performance FAXs and printer controllers.

*: FR Family stands for FUJITSU RISC controller.

■ FEATURES

FR CPU
• 32-bit RISC, load/store architecture, 5-stage pipeline
• Operating clock frequency: Internal 50 MHz/external 25 MHz (PLL used at source oscillation 12.5 MHz)
• General purpose registers: 32 bits × 16
• 16-bit fixed length instructions (basic instructions), 1 instruction/1 cycle
• Memory to memory transfer, bit processing, barrel shifter processing: Optimized for embedded applications
• Function entrance/exit instructions, multiple load/store instructions of register contents, instruction systems supporting high level languages
• Register interlock functions, efficient assembly language coding
• Branch instructions with delay slots: Reduced overhead time in branch executions

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■ PACKAGE

100-pin Plastic LQFP	100-pin Plastic QFP
(FPT-100P-M05)	(FPT-100P-M06)
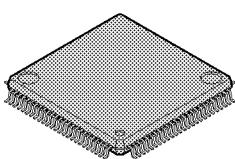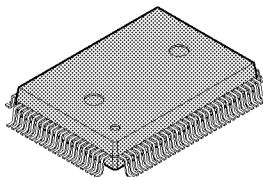
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- Internal multiplier/supported at instruction level
  Signed 32-bit multiplication: 5 cycles
  Signed 16-bit multiplication: 3 cycles
- Interrupt (push PC and PS): 6 cycles, 16 priority levels

External bus interface

- Clock doublure: Internal 50 MHz, external bus 25 MHz operation
- 25-bit address bus (32 Mbytes memory space)
- 8/16-bit data bus
- Basic external bus cycle: 2 clock cycles
- Chip select outputs for setting down to a minimum memory block size of 64 Kbytes: 6
- Interface supported for various memory technologies
  DRAM interface (area 4 and 5)
- Automatic wait cycle insertion: Flexible setting, from 0 to 7 for each area
- Unused data/address pins can be configured us input/output ports
- Little endian mode supported (Select 1 area from area 1 to 5)

DRAM interface

- 2 banks independent control (area 4 and 5)
- Normal mode (double CAS DRAM)/high-speed page mode (single CAS DRAM)/Hyper DRAM
- Basic bus cycle: Normally 5 cycles, 2-cycle access possible in high-speed page mode
- Programmable waveform: Automatic 1-cycle wait insertion to RAS and CAS cycles
- DRAM refresh
  CBR refresh (interval time configurable by 6-bit timer)
  Self-refresh mode
- Supports 8/9/10/12-bit column address width
- 2CAS/1WE, 2WE/1CAS selective

Cache memory

- 1-Kbyte instruction cache memory
- 2 way set associative
- Lock function: For specific program code to be resident in cashe memory

DMA controller (DMAC)

- 8 channels
- Transfer incident/external pins/internal resource interrupt requests
- Transfer sequence: Step transfer/block transfer/burst transfer/continuous transfer
- Transfer data length: 8 bits/16 bits/32 bits selective
- NMI/interrupt request enables temporary stop operation

UART

- 3 independent channels
- Full-duplex double buffer
- Data length: 7 bits to 9 bits (non-parity), 6 bits to 8 bits (parity)
- Asynchronous (start-stop system), CLK-synchronized communication selective
- Multi-processor mode
- Internal 16-bit timer (U-TIMER) operating as a proprietary baud rate generator: Generates any given baud rate
- Use external clock can be used as a transfer clock
- Error detection: Parity, frame, overrun

(Continued)

10-bit A/D converter (successive approximation conversion type)

• 10-bit resolution, 4 channels
• Successive approximation type: Conversion time of 5.6 μs at 25 MHz
• Internal sample and hold circuit
• Conversion mode: Single conversion/scanning conversion/repeated conversion/stop conversion selective
• Start: Software/external trigger/internal timer selective

16-bit reload timer

• 3 channels
• Internal clock: 2 clock cycle resolution, divide by 2/8/32 selective

Other interval timers

• 16-bit timer: 3 channels (U-TIMER)
• PWM timer: 4 channels
• Watchdog timer: 1 channel

Bit search module

First bit transition "1" or "0" from MSB can be detected in 1 cycle

Interrupt controller

• External interrupt input: Non-maskable interrupt ($\overline{\text{NMI}}$), normal interrupt × 4 (INT0 to INT3)
• Internal interrupt incident: UART, DMA controller (DMAC), A/D converter, U-TIMER and delayed interrupt
module
• Priority levels of interrupts are programmable except for non-maskable interrupt (in 16 steps)

Others

• Reset cause: Power-on reset/hardware standby/watchdog timer/software reset/external reset
• Low-power consumption mode: Sleep mode/stop mode
• Clock control
Gear function: Operating clocks for CPU and peripherals are independently selective
Gear clock can be selected from 1/1, 1/2, 1/4 and 1/8 (or 1/2, 1/4, 1/8 and 1/16)
However, operating frequency for peripherals is less than 25 MHz.
• Packages: LQFP-100 and QFP-100
• CMOS technology (0.35 μm)
• Power supply voltage
5 V: CPU power supply 5.0 V ±10% (internal regulator)
A/D power supply 2.7 V to 3.6 V
3 V: CPU power supply 2.7 V to 3.6 V (without internal regulator)
A/D power supply 2.7 V to 3.6 V

MB91101 Series

■ PIN ASSIGNMENT

(Top view)

Top pins (100–76):
RAS1/PB4/EOP2 (100), DW0/PB3 (99), CS0H/PB2 (98), CS0L/PB1 (97), RAS0/PB0 (96), INT0/PE0 (95), INT1/PE1 (94), Vcc5 (93), X0 (92), X1 (91), Vss (90), INT2/SC1/PE2 (89), INT3/SC2/PE3 (88), DREQ0/PE4 (87), DREQ1/PE5 (86), DACK0/PE6 (85), DACK1/PE7 (84), OCPA0/PF7/ATG (83), SO2/OCPA2/PF6 (82), SI2/OCPA1/PF5 (81), SO1/TRG3/PF4 (80), SI1/TRG2/PF3 (79), SC0/OCPA3/PF2 (78), SO0/TRG1/PF1 (77), SI0/TRG0/PF0 (76)

Left pins (1–25):

Pin	Name
1	CS1L/PB5/DREQ2
2	CS1H/PB6/DACK2
3	DW1/PB7
4	Vcc3
5	CLK/PA6
6	CS5/PA5
7	CS4/PA4
8	CS3/PA3/EOP1
9	CS2/PA2
10	CS1/PA1
11	CS0
12	NMI
13	HST
14	RST
15	Vss
16	MD0
17	MD1
18	MD2
19	RDY/P80
20	BGRNT/P81
21	BRQ/P82
22	RD
23	WR0
24	WR1/P85
25	D16/P20

Right pins (75–51):

Pin	Name
75	AN3
74	AN2
73	AN1
72	AN0
71	AVss/AVRL
70	AVRH
69	AVcc
68	A24/EOP0
67	A23/P67
66	A22/P66
65	Vss
64	A21/P65
63	A20/P64
62	A19/P63
61	A18/P62
60	A17/P61
59	A16/P60
58	A15
57	A14
56	A13
55	A12
54	A11
53	A10
52	A09
51	A08

Bottom pins (26–50):
D17/P21 (26), D18/P22 (27), D19/P23 (28), D20/P24 (29), D21/P25 (30), D22/P26 (31), D23/P27 (32), D24 (33), D25 (34), D26 (35), D27 (36), D28 (37), D29 (38), D30 (39), Vss (40), D31 (41), A00 (42), Vcc5 (43), A01 (44), A02 (45), A03 (46), A04 (47), A05 (48), A06 (49), A07 (50)

(FPT-100P-M05)

(Top view)

Top side pins (left to right, pins 100–81):

- 100 CS0L/PB1
- 99 RAS0/PB0
- 98 INT0/PE0
- 97 INT1/PE1
- 96 Vcc5
- 95 X0
- 94 X1
- 93 Vss
- 92 INT2/SC1/PE2
- 91 INT3/SC2/PE3
- 90 DREQ0/PE4
- 89 DREQ1/PE5
- 88 DACK0/PE6
- 87 DACK1/PE7
- 86 OCPA0/PF7/ATG
- 85 SO2/OCPA2/PF6
- 84 SI2/OCPA1/PF5
- 83 SO1/TRG3/PF4
- 82 SI1/TRG2/PF3
- 81 SC0/OCPA3/PF2

Left side pins (1–30):

- 1 CS0H/PB2
- 2 DW0/PB3
- 3 RAS1/PB4/EOP2
- 4 CS1L/PB5/DREQ2
- 5 CS1H/PB6/DACK2
- 6 DW1/PB7
- 7 Vcc3
- 8 CLK/PA6
- 9 CS5/PA5
- 10 CS4/PA4
- 11 CS3/PA3/EOP1
- 12 CS2/PA2
- 13 CS1/PA1
- 14 CS0
- 15 NMI
- 16 HST
- 17 RST
- 18 Vss
- 19 MD0
- 20 MD1
- 21 MD2
- 22 RDY/P80
- 23 BGRNT/P81
- 24 BRQ/P82
- 25 RD
- 26 WR0
- 27 WR1/P85
- 28 D16/P20
- 29 D17/P21
- 30 D18/P22

Right side pins (80–51):

- 80 SO0/TRG1/PF1
- 79 SI0/TRG0/PF0
- 78 AN3
- 77 AN2
- 76 AN1
- 75 AN0
- 74 AVss/AVRL
- 73 AVRH
- 72 AVcc
- 71 A24/EOP0
- 70 A23/P67
- 69 A22/P66
- 68 Vss
- 67 A21/P65
- 66 A20/P64
- 65 A19/P63
- 64 A18/P62
- 63 A17/P61
- 62 A16/P60
- 61 A15
- 60 A14
- 59 A13
- 58 A12
- 57 A11
- 56 A10
- 55 A09
- 54 A08
- 53 A07
- 52 A06
- 51 A05

Bottom side pins (31–50):

- 31 D19/P23
- 32 D20/P24
- 33 D21/P25
- 34 D22/P26
- 35 D23/P27
- 36 D24
- 37 D25
- 38 D26
- 39 D27
- 40 D28
- 41 D29
- 42 D30
- 43 Vss
- 44 D31
- 45 A00
- 46 Vcc5
- 47 A01
- 48 A02
- 49 A03
- 50 A04

(FPT-100P-M06)

MB91101 Series

■ PIN DESCRIPTION

Pin no.		Pin name	Circuit type	Function
LQFP*1	QFP*2			
25 to 32	28 to 35	D16 to D23	C	Bit 16 to bit 23 of external data bus
		P20 to P27		Can be configured as I/O ports when external data bus width is set to 8-bit.
33 to 39, 41	36 to 42, 44	D24 to D30, D31	C	Bit 24 to bit 31 of external data bus
42, 44 to 58	45, 47 to 61	A00, A01 to A15	F	Bit 00 to bit 15 of external address bus
59 to 64, 66, 67	62 to 67, 69, 70	A16 to A21, A22, A23	F	Bit 16 to bit 23 of external address bus
		P60 to P65, P66, P67		Can be configured as I/O ports when not used as address bus.
68	71	A24	L	Bit 24 of external address bus
		EOP0		Can be configured as DMAC EOP output (ch. 0) when DMAC EOP output is enabled.
19	22	RDY	C	External ready input Inputs "0" when bus cycle is being executed and not completed.
		P80		Can be configured as a port when RDY is not used.
20	23	$\overline{\text{BGRNT}}$	F	External bus release acknowledge output Outputs "L" level when external bus is released.
		P81		Can be configured as a port when $\overline{\text{BGRNT}}$ is not used.
21	24	BRQ	C	External bus release request input Inputs "1" when release of external bus is required.
		P82		Can be configured as a port when BRQ is not used.
22	25	$\overline{\text{RD}}$	L	Read strobe output pin for external bus
23	26	$\overline{\text{WR0}}$	L	Write strobe output pin for external bus Relation between control signals and effective byte locations is as follows:
24	27	$\overline{\text{WR1}}$	F	
		P85		Can be configured as a port when $\overline{\text{WR1}}$ is not used.

	16-bit bus width	8-bit bus width
D15 to D08	$\overline{\text{WR0}}$	$\overline{\text{WR0}}$
D07 to D00	$\overline{\text{WR1}}$	(I/O port enabled)

Note: $\overline{\text{WR1}}$ is Hi-Z during resetting.
Attach an external pull-up resister when using at 16-bit bus width.

*1: FPT-100P-M05
*2: FPT-100P-M06

(Continued)

Pin no.		Pin name	Circuit type	Function
LQFP*1	QFP*2			
11	14	$\overline{CS0}$	L	Chip select 0 output ("L" active)
10	13	$\overline{CS1}$	F	Chip select 1 output ("L" active)
		PA1		Can be configured as a port when $\overline{CS1}$ is not used.
9	12	$\overline{CS2}$	F	Chip select 2 output ("L" active)
		PA2		Can be configured as a port when $\overline{CS2}$ is not used.
8	11	$\overline{CS3}$	F	Chip select 3 output ("L" active)
		PA3		Can be configured as a port when $\overline{CS3}$ and EOP1 are not used.
		EOP1		EOP output pin for DMAC (ch. 1) This function is available when EOP output for DMAC is enabled.
7	10	$\overline{CS4}$	F	Chip select 4 output ("L" active)
		PA4		Can be configured as a port when $\overline{CS4}$ is not used.
6	9	$\overline{CS5}$	F	Chip select 5 output ("L" active)
		PA5		Can be configured as a port when $\overline{CS5}$ is not used.
5	8	CLK	F	System clock output Outputs clock signal of external bus operating frequency.
		PA6		Can be configured as a port when CLK is not used.
96	99	RAS0	F	RAS output for DRAM bank 0 Refer to the DRAM interface for details.
		PB0		Can be configured as a port when RAS0 is not used.
97	100	CS0L	F	CASL output for DRAM bank 0 Refer to the DRAM interface for details.
		PB1		Can be configured as a port when CS0L is not used.
98	1	CS0H	F	CASH output for DRAM bank 0 Refer to the DRAM interface for details.
		PB2		Can be configured as a port when CS0H is not used.
99	2	$\overline{DW0}$	F	$\overline{WE}$ output for DRAM bank 0 ("L" active) Refer to the DRAM interface for details.
		PB3		Can be configured as a port when $\overline{DW0}$ is not used.
100	3	RAS1	F	RAS output for DRAM bank 1 Refer to the DRAM interface for details.
		PB4		Can be configured as a port when RAS1 and EOP2 are not used.
		EOP2		DMAC EOP output (ch. 2) This function is available when DMAC EOP output is enabled.

*1: FPT-100P-M05
*2: FPT-100P-M06

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Pin no.		Pin name	Circuit type	Function
LQFP*1	QFP*2			
1	4	CS1L	F	CASL output for DRAM bank 1 Refer to the DRAM interface for details.
		PB5		Can be configured as a port when CS1L and DREQ are not used.
		DREQ2		External transfer request input pin for DMA This pin is used for input when external trigger is selected to cause DMAC operation, and it is necessary to disable output for other functions from this pin unless such output is made intentionally.
2	5	CS1H	F	CASH output for DRAM bank 1 Refer to the DRAM interface for details.
		PB6		Can be configured as a port when CS1H and DACK2 are not used.
		DACK2		External transfer request acknowledge output pin for DMAC (ch. 2) This function is available when transfer request output for DMAC is enabled.
3	6	$\overline{\text{DWT}}$	F	$\overline{\text{WE}}$ output for DRAM bank 1 ("L" active) Refer to the DRAM interface for details.
		PB7		Can be configured as a port when $\overline{\text{DWT}}$ is not used.
16 to 18	19 to 21	MD0 to MD2	G	Mode pins 0 to 2 MCU basic operation mode is set by these pins. Directly connect these pins with V_{CC} or V_{SS} for use.
92	95	X0	A	Clock (oscillator) input
91	94	X1	A	Clock (oscillator) output
14	17	$\overline{\text{RST}}$	B	External reset input
13	16	$\overline{\text{HST}}$	H	Hardware standby input ("L" active)
12	15	$\overline{\text{NMI}}$	H	NMI (non-maskable interrupt pin) input ("L" active)
95, 94	98, 97	INT0, INT1	F	External interrupt request input pins These pins are used for input during corresponding interrupt is enabled, and it is necessary to disable output for other functions from these pins unless such output is made intentionally.
		PE0, PE1		Can be configured as a port when INT0, INT1 are not used.
89	92	INT2	F	External interrupt request input pin This pin is used for input during corresponding interrupt is enabled, and it is necessary to disable output for other functions from this pin unless such output is made intentionally.
		SC1		Clock I/O pin for UART1 Clock output is available when clock output of UART1 is enabled.
		PE2		Can be configured as a port when INT2 and SC1 are not used. This function is available when UART1 clock output is disabled.

*1: FPT-100P-M05
*2: FPT-100P-M06

(Continued)

Pin no.		Pin name	Circuit type	Function
LQFP*1	QFP*2			
88	91	INT3	F	External interrupt request input pin This pin is used for input during corresponding interrupt is enabled, and it is necessary to disable output for other functions from this pin unless such output is made intentionally.
		SC2		UART2 clock I/O pin Clock output is available when UART2 clock output is enabled.
		PE3		Can be configured as a port when INT3 and SC2 are not used. This function is available when UART2 clock output is disabled.
87, 86	90, 89	DREQ0, DREQ1	F	External transfer request input pins for DMA These pins are used for input when external trigger is selected to cause DMAC operation, and it is necessary to disable output for other functions from these pins unless such output is made intentionally.
		PE4, PE5		Can be configured as a port when DREQ0, DREQ1 are not used.
85	88	DACK0	F	External transfer request acknowledge output pin for DMAC (ch. 0) This function is available when transfer request output for DMAC is enabled.
		PE6		Can be configured as a port when DACK0 is not used. This function is available when transfer request acknowledge output for DMAC or DACK0 output is disabled.
84	87	DACK1	F	External transfer request acknowledge output pin for DMAC (ch. 1) This function is available when transfer request output for DMAC is enabled.
		PE7		Can be configured as a port when DACK1 is not used. This function is available when transfer request output for DMAC or DACK1 output is disabled.
76	79	SI0	F	UART0 data input pin This pin is used for input during UART0 is in input operation, and it is necessary to disable output for other functions from this pin unless such output is made intentionally.
		TRG0		PWM timer external trigger input pin This pin is used for input during PWM timer external trigger is in input operation, and it is necessary to disable output for other functions from this pin unless such output is made intentionally.
		PF0		Can be configured as a port when SI0 and TRG0 are not used.

*1: FPT-100P-M05
*2: FPT-100P-M06

(Continued)

Pin no.		Pin name	Circuit type	Function
LQFP*1	QFP*2			
77	80	SO0	F	UART0 data output pin This function is available when UART0 data output is enabled.
		TRG1		PWM timer external trigger input pin This function is available when serial data output of PF1, UART0 are disabled.
		PF1		Can be configured as a port when SO0 and TRG1 are not used. This function is available when serial data output of UART0 is disabled.
78	81	SC0	F	UART0 clock I/O pin Clock output is available when UART0 clock output is enabled.
		OCPA3		PWM timer output pin This function is available when PWM timer output is enabled.
		PF2		Can be configured as a port when SC0 and OCPA3 are not used. This function is available when UART0 clock output is disabled.
79	82	SI1	F	UART1 data input pin This pin is used for input during UART1 is in input operation, and it is necessary to disable output for other functions from this pin unless such output is made intentionally.
		TRG2		PWM timer external trigger input pin This pin is used for input during PWM timer external trigger is in input operation, and it is necessary to disable output for other functions from this pin unless such output is made intentionally.
		PF3		Can be configured as a port when SI1 and TRG2 are not used.
80	83	SO1	F	UART1 data output pin This function is available when UART1 data output is enabled.
		TRG3		PWM timer external trigger input pin This function is available when PF4, UART1 data outputs are disabled.
		PF4		Can be configured as a port when SO1 and TRG3 are not used. This function is available when UART1 data output is disabled.
81	84	SI2	F	UART2 data input pin This pin is used for input during UART2 is in input operation, and it is necessary to disable output for other functions from this pin unless such output is made intentionally.
		OCPA1		PWM timer output pin This function is available when PWM timer output is enabled.
		PF5		Can be configured as a port when SI2 and OCPA2 are not used.

*1: FPT-100P-M05
*2: FPT-100P-M06

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Pin no.		Pin name	Circuit type	Function
LQFP*1	QFP*2			
82	85	SO2	F	UART2 data output pin This function is available when UART2 data output is enabled.
		OCPA2		PWM timer output pin This function is available when PWM timer output is enabled.
		PF6		Can be configured as a port when SO2 and OCPA2 are not used. This function is available when UART2 data output is disabled.
83	86	OCPA0	F	PWM timer output pin This function is available when PWM timer output is enabled.
		PF7		Can be configured as a port when OCPA0 and $\overline{\text{ATG}}$ are not used. This function is available when PWM timer output is disabled.
		$\overline{\text{ATG}}$		External trigger input pin for A/D converter This pin is used for input when external trigger is selected to cause A/D converter operation, and it is necessary to disable output for other functions from this pin unless such output is made intentionally.
72 to 75	75 to 78	AN0 to AN3	D	Analog input pins of A/D converter This function is available when AIC register is set to specify analog input mode.
69	72	AV_{CC}	—	Power supply pin (V_{CC}) for A/D converter
70	73	AVRH	—	Reference voltage input (high) for A/D converter Make sure to turn on and off this pin with potential of AVRH or more applied to V_{CC}.
71	74	AV_{SS}, AVRL	—	Power supply pin (V_{SS}) for A/D converter and reference voltage input pin (low)
43, 93	46, 96	$V_{CC}5$	—	5 V power supply pin (V_{CC}) for digital circuit Always two pins must be connected to the power supply (connect to 3 V power supply when operating at 3 V).
4	7	$V_{CC}3$	—	Bypass capacitor pin for internal capacitor. Also connect this pin to 3 V power supply when operating at 3 V.
15, 40, 65, 90	18, 43, 68, 93	V_{SS}	—	Earth level (V_{SS}) for digital circuit

*1: FPT-100P-M05
*2: FPT-100P-M06

Note: In most of the above pins, I/O port and resource I/O are multiplexed e.g. P82 and BRQ. In case of conflict between output of I/O port and resource I/O, priority is always given to the output of resource I/O.

■ DRAM CONTROL PIN

| Pin name	Data bus 16-bit mode		Data bus 8-bit mode	Remarks
	2CAS/1WR mode	1CAS/2WR mode	—	
RAS0	Area 4 RAS	Area 4 RAS	Area 4 RAS	Correspondence of "L" "H" to lower address 1 bit (A0) in data bus 16-bit mode
RAS1	Area 5 RAS	Area 5 RAS	Area 5 RAS	"L": "0" "H": "1"
CS0L	Area 4 CASL	Area 4 CAS	Area 4 CAS	CASL: CAS which A0 corresponds to "0" area
CS0H	Area 4 CASH	Area 4 $\overline{\text{WEL}}$	Area 4 CAS	CASH: CAS which A0 corresponds to "1" area
CS1L	Area 5 CASL	Area 5 CAS	Area 5 CAS	$\overline{\text{WEL}}$: $\overline{\text{WE}}$ which A0 corresponds to "0" area
CS1H	Area 5 CASH	Area 5 $\overline{\text{WEL}}$	Area 5 CAS	$\overline{\text{WEH}}$: $\overline{\text{WE}}$ which A0 corresponds to "1" area
$\overline{\text{DW0}}$	Area 4 $\overline{\text{WE}}$	Area 4 $\overline{\text{WEH}}$	Area 4 $\overline{\text{WE}}$	
$\overline{\text{DW1}}$	Area 5 $\overline{\text{WE}}$	Area 5 $\overline{\text{WEH}}$	Area 5 $\overline{\text{WE}}$	

■ I/O CIRCUIT TYPE

Type	Circuit	Remarks
A	 X1 X0 Clock input Standby control signal	• Oscillation feedback resistance 1 MΩ approx. With standby control
B	 Vcc P-ch P-ch N-ch R Vss Digital input	• CMOS level Hysteresis input Without standby control With pull-up resistance
C	 P-ch — Digital output N-ch — Digital output R Digital input Standby control signal	• CMOS level I/O With standby control
D	 P-ch — Digital output N-ch — Digital output R Analog input	• Analog input
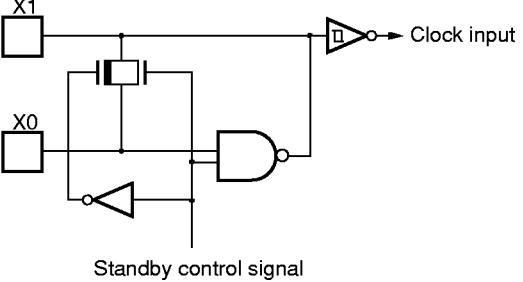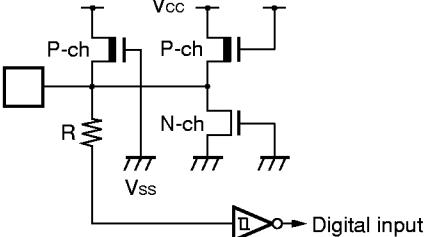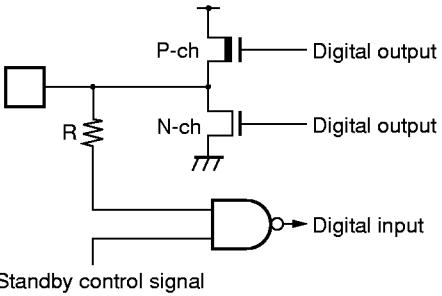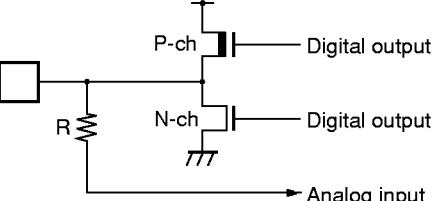
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Type	Circuit	Remarks
E		• N-ch open-drain output • CMOS level input With standby control
F		• CMOS level output • CMOS level Hysteresis input With standby control
G		• CMOS level input Without standby control
H		• CMOS level Hysteresis input Without standby control

(Continued)

(Continued)

Type	Circuit	Remarks
I	P-ch — Digital output N-ch — Digital output R Digital input	• CMOS level output • CMOS level Hysteresis input Without standby control
J	P-ch — Digital output N-ch — Digital output R Digital input Standby control signal TTL	• CMOS level output • TTL level input With standby control
K	P-ch — Digital output N-ch — Digital output R Digital input Standby control signal	• CMOS level input/output With standby control • Large current drive
L	P-ch — Digital output N-ch — Digital output	• CMOS level output

MB91101 Series

■ HANDLING DEVICES

1. Preventing Latchup

In CMOS ICs, applying voltage higher than V_{CC} or lower than V_{SS} to input/output pin or applying voltage over rating across V_{CC} and V_{SS} may cause latchup.

This phenomenon rapidly increases the power supply current, which may result in thermal breakdown of the device. Make sure to prevent the voltage from exceeding the maximum rating.

Take care that the analog power supply (AV_{CC} AVR) and the analog input do not exceed the digital power supply (V_{CC}) when the analog power supply turned on or off.

2. Treatment of Unused Pins

Unused pins left open may cause malfunctions. Make sure to connect them to pull-up or pull-down resistors.

3. External Reset Input

It takes at least 5 machine cycle to input "L" level to the $\overline{RST}$ pin and to ensure inner reset operation properly.

4. Remarks for External Clock Operation

When external clock is selected, supply it to X0 pin generally, and simultaneously the opposite phase clock to X0 must be supplied to X1 pin. However, in this case the stop mode must not be used (because X1 pin stops at "H" output in stop mode).

And can be used to supply only to X0 pin with 5 V power supply at 12.5 MHz and less than.

• **Using an external clock**
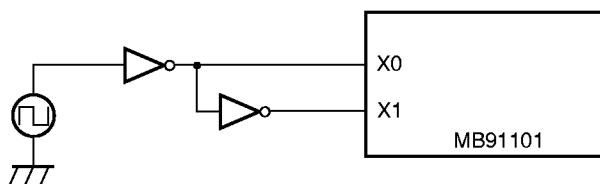
Using an external clock (normal)
Note: Can not be used stop mode (oscillation stop mode).
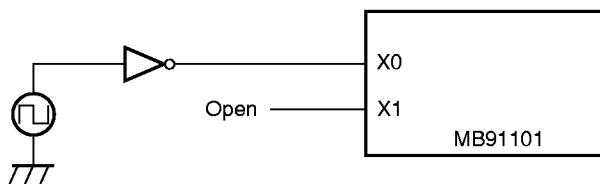
Using an external clock (can be used at 12.5 MHz and less than.)
(5 V power supply only)

---

5. Power Supply Pins

When there are several Vcc and Vss pins, each of them is equipotentially connected to its counterpart inside of the device, minimizing the risk of malfunctions such as latch up. To further reduce the risk of malfunctions, to prevent EMI radiation, to prevent strobe signal malfunction resulting from creeping-up of ground level and to observe the total output current standard, connect all Vcc and Vss pins to the power supply or GND.

It is preferred to connect Vcc and Vss of MB91101 to power supply with minimal impedance possible.

It is also recommended to connect a ceramic capacitor as a bypass capacitor of about 0.1 μF between Vcc and Vss at a position as close as possible to MB91101.

MB91101 has an internal regulator. When using with 5 V power supply, supply 5 V to Vcc5 pin and make sure to connect about 0.1 μF bypass capacitor to Vcc3 pin for regulator. And another 3 V power supply is needed for the A/D convertor. When using with 3 V power supply, connect both Vcc5 pin and Vcc3 pin to the 3 V power supply.

• Connecting to a power supply

[Using with 5 V power supply]

5 V — Vcc5   Vcc3
3 V — AVcc
AVRH
AVss   About 0.1 μF
Vss

GND

[Using with 3 V power supply]

3 V
Vcc5   Vcc3
AVcc
AVRH
AVss
GND   Vss
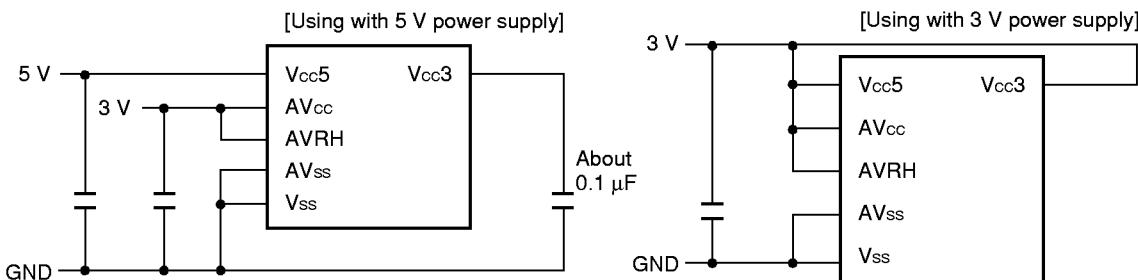
6. Crystal Oscillator Circuit

Noises around X0 and X1 pins may cause malfunctions of MB91101. In designing the PC board, layout X0, X1 and crystal oscillator (or ceramic oscillator) and bypass capacitor for grounding as close as possible.

It is strongly recommended to design PC board so that X1 and X0 pins are surrounded by grounding area for stable operation.

7. Turning-on Sequence of A/D Converter Power Supply and Analog Input

Make sure to turn on the digital power supply (Vcc) before turning on the A/D converter (AVcc, AVRH) and applying voltage to analog input (AN0 to AN3).

Make sure to turn off digital power supply after power supply to A/D converters and analog inputs have been switched off. (There are no such limitations in turning on power supplies. Analog and digital power supplies may be turned on simultaneously.) Make sure that AVRH never exceeds AVcc when turning on/off power supplies.

8. Treatment of N.C. Pins

Make sure to leave N.C. pins open.

9. Fluctuation of Power Supply Voltage

Warranty range for normal operation against fluctuation of power supply voltage V_{CC} is as given in rating. However, sudden fluctuation of power supply voltage within the warranty range may cause malfunctions. It is recommended to make every effort to stabilize the power supply voltage to IC. It is also recommended that by controlling power supply as a reference of stabilizing, V_{CC} ripple fluctuation (P-P value) at the commercial frequency (50 Hz to 60 Hz) should be less than 10% of the standard V_{CC} value and the transient regulation should be less than 0.1 V/ms at instantaneous deviation like turning off the power supply.

10. Mode Setting Pins (MD0 to MD2)

Connect mode setting pins (MD0 to MD2) directly to V_{CC} or V_{SS}.

Arrange each mode setting pin and V_{CC} or V_{SS} patterns on the printed circuit board as close as possible and make the impedance between them minimal to prevent mistaken entrance to the test mode caused by noises.

11. Internal DC Regulator

Internal DC regulator stops in stop mode. When the regulator stops owing to the increase of inner leakage current (ICCH) in stop mode, malfunction caused by noise or any troubles about power supply in normal operation, the internal 3 V power supply voltage may decrease less than the warranty range for normal operation. So when using the internal regulator and stop mode with 5 V power supply, never fail to support externally so that 3 V power supply voltage might not decrease. However, even in such a case, the internal regulator can be restarted by inputting the reset procedure. (In this case, set the reset to "L" level within the oscillation stabilizing waiting time.)

> • **Using STOP mode with 5 V power supply**
>
> 5 V
>
> $V_{CC}5$ 3.6 kΩ
>
> $V_{CC}3$
>
> V_{SS} 0.1 μF approx.   6.8 kΩ
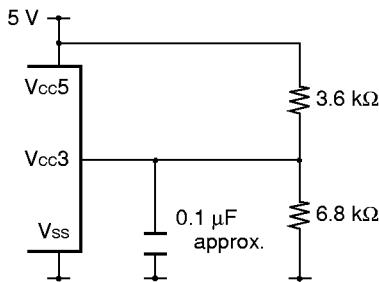
12. Turning on the Power Supply

When turning on the power supply, never fail to start from setting the $\overline{RST}$ pin to "L" level. And after the power supply voltage goes to V_{CC} level, at least after ensuring the time for 5 machine cycle, then set to "H" level.

13. Pin Condition at Turning on the Power Supply

The pin condition at turning on the power supply is unstable. The circuit starts being initialized after turning on the power supply and then starting oscillation and then the operation of the internal regulator becomes stable. So it takes about 42 ms for the pin to be initialized from the oscillation starting at the source oscillation 12.5 MHz. Take care that the pin condition may be output condition at initial unstable condition.

14. Source Oscillation Input at Turning on the Power Supply

At turning on the power supply, never fail to input the clock before cancellation of the oscillation stabilizing waiting.

## 15. Hardware Stand-by at Turning on the Power Supply

When turning on the power supply with the $\overline{\text{HST}}$ pin being set to "L" level, the hardware doesn't stand by. However the $\overline{\text{HST}}$ pin becomes available after the reset cancellation, the $\overline{\text{HST}}$ pin must once be back to "H" level.

16. Power on Reset

Make sure to make power on reset at turning on the power supply or returning on the power supply when the power supply voltage is below the warranty range for normal operation.

■ BLOCK DIAGRAM


Note: Pins are display for functions (Actually some pins are multiplexer).
When using REALOS, time control should be done by using external interrupt or inner timer.
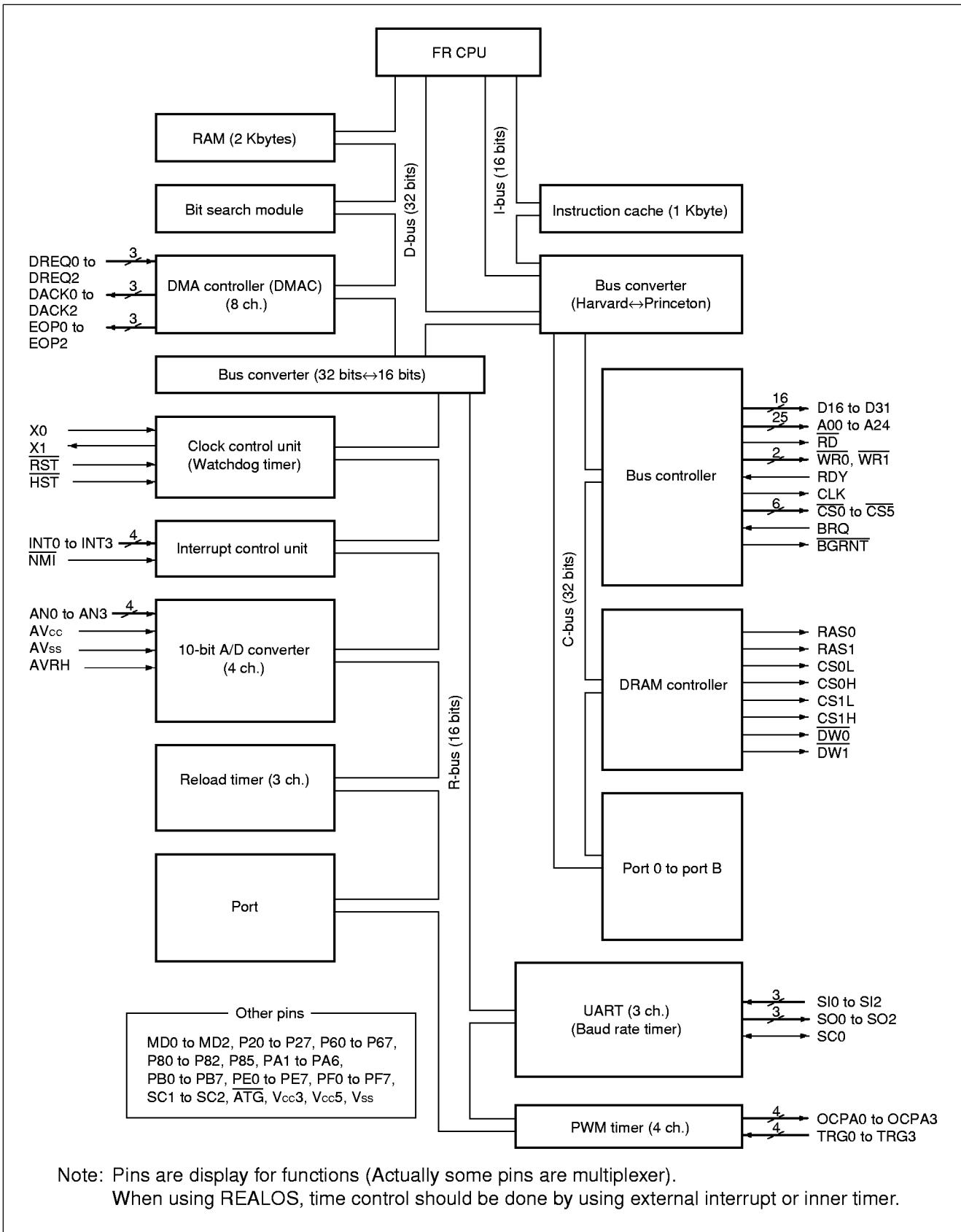
■ CPU CORE

1. Memory Space

The FR family has a logical address space of 4 Gbytes (2^{32} bytes) and the CPU linearly accesses the memory space.

• **Memory space**

Address	External ROM/external bus mode	
0000 0000H		
	I/O area	} Direct addressing area
0000 0400H		
	I/O area	} See "■ I/O MAP"
0000 0800H		
	Access inhibited	
0000 1000H		
	Embedded RAM	
0000 1800H		
	Access inhibited	
0001 0000H		
	External area	
FFFF FFFFH		
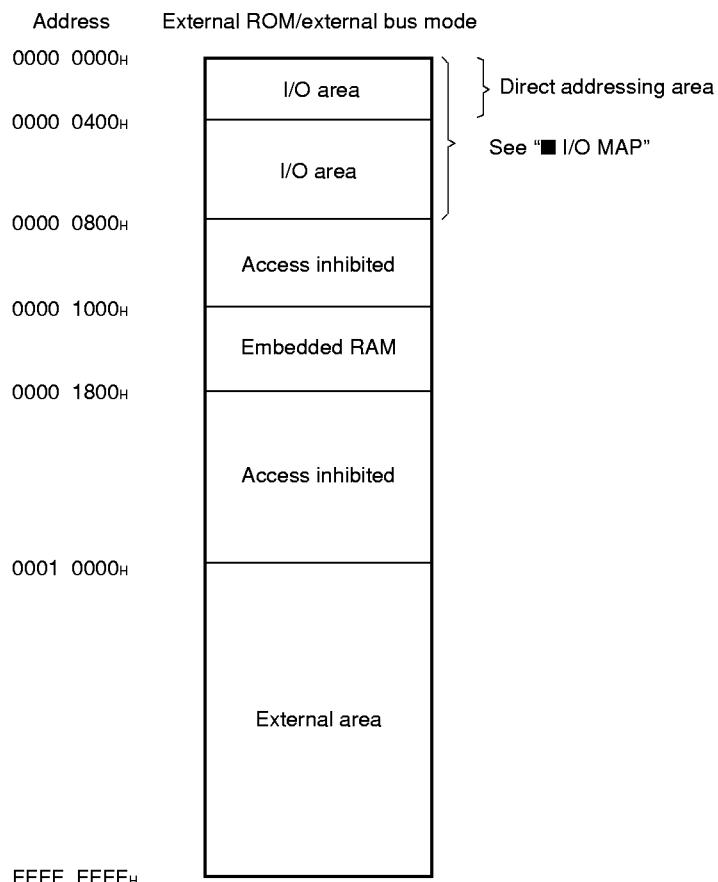
• **Direct addressing area**

The following areas on the memory space are assigned to direct addressing area for I/O. In these areas, an address can be specified in a direct operand of a code.

Direct areas consists of the following areas dependent on accessible data sizes.

    Byte data access: 000H to 0FFH
    Half word data access: 000H to 1FFH
    Word data access: 000H to 3FFH

2. Registers

The FR family has two types of registers; dedicated registers embedded on the CPU and general-purpose registers on memory.

• **Dedicated registers**

Program counter (PC):	32-bit length, indicates the location of the instruction to be executed.
Program status (PS):	32-bit length, register for storing register pointer or condition codes
Table base register (TBR):	Holds top address of vector table used in EIT (Exceptional/Interrupt/Trap) processing.
Return pointer (RP):	Holds address to resume operation after returning from a subroutine.
System stack pointer (SSP):	Indicates system stack space.
User's stack pointer (USP):	Indicates user's stack space.
Multiplication/division result register (MDH/MDL):	32-bit length, register for multiplication/division
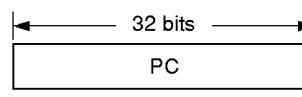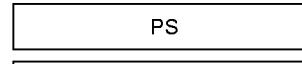
```
          ◄──── 32 bits ────►                                          Initial value
          ┌──────────────────┐
          │        PC        │   Program counter                       XXXX  XXXXʜ    Indeterminate
          └──────────────────┘
          ┌──────────────────┐
          │        PS        │   Program status
          └──────────────────┘
          ┌──────────────────┐
          │       TBR        │   Table base register                   000F  FC00ʜ
          └──────────────────┘
          ┌──────────────────┐
          │        RP        │   Return pointer                        XXXX  XXXXʜ    Indeterminate
          └──────────────────┘
          ┌──────────────────┐
          │       SSP        │   System stack pointer                  0000  0000ʜ
          └──────────────────┘
          ┌──────────────────┐
          │       USP        │   User's stack pointer                  XXXX  XXXXʜ    Indeterminate
          └──────────────────┘
          ┌──────────────────┐
          │       MDH        │                                         XXXX  XXXXʜ    Indeterminate
          ├──────────────────┤   Multiplication/division result register
          │       MDL        │                                         XXXX  XXXXʜ    Indeterminate
          └──────────────────┘
```
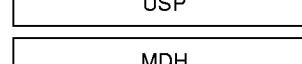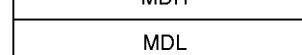
• **Program status (PS)**

The PS register is for holding program status and consists of a condition code register (CCR), a system condition code register (SCR) and a interrupt level mask register (ILM).

31	20	19	18	17	16		10	9	8	7	6	5	4	3	2	1	0
PS —	ILM4	ILM3	ILM2	ILM1	ILM0	—	D1	D0	T	—	—	S	I	N	Z	V	C
	└────── ILM ──────┘						└─── SCR ───┘			└──────── CCR ────────┘						
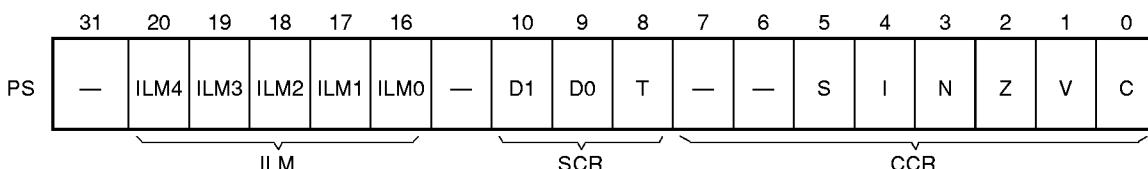
• **Condition code register (CCR)**

S-flag: Specifies a stack pointer used as R15.
I-flag: Controls user interrupt request enable/disable.
N-flag: Indicates sign bit when division result is assumed to be in the 2's complement format.
Z-flag: Indicates whether or not the result of division was "0".
V-flag: Assumes the operand used in calculation in the 2's complement format and indicates whether or not overflow has occurred.
C-flag: Indicates if a carry or borrow from the MSB has occurred.

• **System condition code register (SCR)**

T-flag: Specifies whether or not to enable step trace trap.

• **Interrupt level mask register (ILM)**

ILM4 to ILM0: Register for holding interrupt level mask value. The value held by this register is used as a level mask. When an interrupt request issued to the CPU is higher than the level held by ILM, the interrupt request is accepted.

ILM4	ILM3	ILM2	ILM1	ILM0	Interrupt level	High-low
0	0	0	0	0	0	High
		⋮			⋮	
0	1	0	0	0	15	
		⋮			⋮	
1	1	1	1	1	31	Low

■ GENERAL-PURPOSE REGISTERS

R0 to R15 are general-purpose registers embedded on the CPU. These registers functions as an accumulator and a memory access pointer (field for indicating address).

• **Register bank structure**

```
                           32 bits
                    ┌──────────────────────────┐   Initial value
          R0        │                          │   XXXX  XXXXн
          R1        │                          │        ⋮
                    │                          │
                    │            ⋮             │
                    │                          │
          R12       │                          │        ⋮
          R13       │     AC (accumulator)     │        ⋮
          R14       │     FP (frame pointer)   │   XXXX  XXXXн
          R15       │     SP (stack pointer)   │   0000  0000н
                    └──────────────────────────┘
```
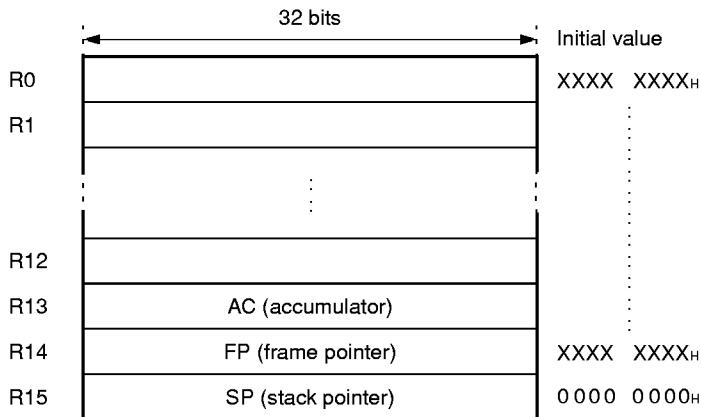
Of the above 16 registers, following registers have special functions. To support the special functions, part of the instruction set has been sophisticated to have enhanced functions.

R13: Virtual accumulator (AC)
R14: Frame pointer (FP)
R15: Stack pointer (SP)

Upon reset, values in R0 to R14 are not fixed. Value in R15 is initialized to be 0000 0000н (SSP value).

■ SETTING MODE

1. Pin

• **Mode setting pins and modes**

Mode setting pins			Mode name	Reset vector access area	External data bus width	Bus mode
MD2	MD1	MD0				
0	0	0	External vector mode 0	External	8 bits	External ROM/external bus mode
0	0	1	External vector mode 1	External	16 bits	
0	1	0	—	—	—	Inhibited
0	1	1	Internal vector mode	Internal	(Mode register)	Single-chip mode*
1	—	—	—	—	—	Inhibited

* : MB91101 does not support single-chip mode.

2. Registers

• **Mode setting registers (MODR) and modes**

```
         Address                                                          Initial value        Access

        0000 07FFH     │ M1 │ M0 │ * │ * │ * │ * │ * │ * │              XXXX XXXXB              W
                          └──────┬──────┘
                                 ▲                                        ───── Bus mode setting bit



    W :  Write only
    X :  Indeterminate
    *  :  Always write "0" except for M1 and M0.
```
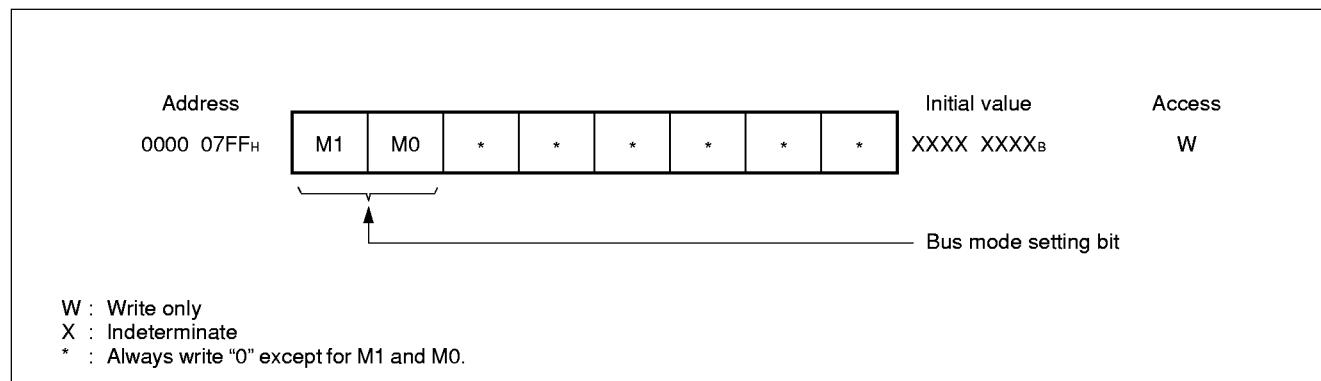
• **Bus mode setting bits and functions**

M1	M0	Functions	Note
0	0	Single-chip mode	
0	1	Internal ROM/external bus mode	
1	0	External ROM/external bus mode	
1	1	—	Inhibited

Note: Because of without internal ROM, MB91101 allows "10B" setting value only.

MB91101 Series

■ I/O MAP

Address	Register name (abbreviated)	Register name	Read/write	Initial value
0000H		(Vacancy)		
0001H	PDR2	Port 2 data register	R/W	X X X X X X X X B
0002H to 0004H		(Vacancy)		
0005H	PDR6	Port 6 data register	R/W	X X X X X X X X B
0006H		(Vacancy)		
0007H				
0008H	PDRB	Port B data register	R/W	X X X X X X X X B
0009H	PDRA	Port A data register	R/W	– X X X X X X – B
000AH		(Vacancy)		
000BH	PDR8	Port 8 data register	R/W	– – X – – X X X B
000CH to 0011H		(Vacancy)		
0012H	PDRE	Port E data register	R/W	X X X X X X X X B
0013H	PDRF	Port F data register	R/W	X X X X X X X X B
0014H to 001BH		(Vacancy)		
001CH	SSR0	Serial status register 0	R/W	0 0 0 0 1 – 0 0 B
001DH	SIDR0/SODR0	Serial input register 0/serial output register 0	R/W	X X X X X X X X B
001EH	SCR0	Serial control register 0	R/W	0 0 0 0 0 1 0 0 B
001FH	SMR0	Serial mode register 0	R/W	0 0 – – 0 – 0 0 B
0020H	SSR1	Serial status register 1	R/W	0 0 0 0 1 – 0 0 B
0021H	SIDR1/SODR1	Serial input register 1/serial output register 1	R/W	X X X X X X X X B
0022H	SCR1	Serial control register 1	R/W	0 0 0 0 0 1 0 0 B
0023H	SMR1	Serial mode register 1	R/W	0 0 – – 0 – 0 0 B
0024H	SSR2	Serial status register 2	R/W	0 0 0 0 1 – 0 0 B
0025H	SIDR2/SODR2	Serial input register 2/serial output register 2	R/W	X X X X X X X X B
0026H	SCR2	Serial control register 2	R/W	0 0 0 0 0 1 0 0 B
0027H	SMR2	Serial mode register 2	R/W	0 0 – – 0 – 0 0 B

(Continued)

Address	Register name (abbreviated)	Register name	Read/write	Initial value
0028H	TMRLR0	16-bit reload register ch. 0	W	X X X X X X X X B
0029H				X X X X X X X X B
002AH	TMR0	16-bit timer register ch. 0	R	X X X X X X X X B
002BH				X X X X X X X X B
002CH		(Vacancy)		
002DH				
002EH	TMCSR0	16-bit reload timer control status register ch. 0	R/W	– – – – 0 0 0 0 B
002FH				0 0 0 0 0 0 0 0 B
0030H	TMRLR1	16-bit reload register ch. 1	W	X X X X X X X X B
0031H				X X X X X X X X B
0032H	TMR1	16-bit timer register ch. 1	R	X X X X X X X X B
0033H				X X X X X X X X B
0034H		(Vacancy)		
0035H				
0036H	TMCSR1	16-bit reload timer control status register ch. 1	R/W	– – – – 0 0 0 0 B
0037H				0 0 0 0 0 0 0 0 B
0038H	ADCR	A/D converter data register	R	– – – – – – X X B
0039H				X X X X X X X X B
003AH	ADCS	A/D converter control status register	R/W	0 0 0 0 0 0 0 0 B
003BH				0 0 0 0 0 0 0 0 B
003CH	TMRLR2	16-bit reload register ch. 2	W	X X X X X X X X B
003DH				X X X X X X X X B
003EH	TMR2	16-bit timer register ch. 2	R	X X X X X X X X B
003FH				X X X X X X X X B
0040H		(Vacancy)		
0041H				
0042H	TMCSR2	16-bit reload timer control status register ch. 2	R/W	– – – – 0 0 0 0 B
0043H				0 0 0 0 0 0 0 0 B
0044H to 0077H		(Vacancy)		

(Continued)

Address	Register name (abbreviated)	Register name	Read/write	Initial value
0078H	UTIM0/UTIMR0	U-TIMER register ch. 0/reload register ch. 0	R/W	0 0 0 0 0 0 0 0 B
0079H				0 0 0 0 0 0 0 0 B
007AH	(Vacancy)			
007BH	UTIMC0	U-TIMER control register ch. 0	R/W	0 − − 0 0 0 0 1 B
007CH	UTIM1/UTIMR1	U-TIMER register ch. 1/reload register ch. 1	R/W	0 0 0 0 0 0 0 0 B
007DH				0 0 0 0 0 0 0 0 B
007EH	(Vacancy)			
007FH	UTIMC1	U-TIMER control register ch. 1	R/W	0 − − 0 0 0 0 1 B
0080H	UTIM2/UTIMR2	U-TIMER register ch. 2/reload register ch. 0	R/W	0 0 0 0 0 0 0 0 B
0081H				0 0 0 0 0 0 0 0 B
0082H	(Vacancy)			
0083H	UTIMC2	U-TIMER control register ch. 2	R/W	0 − − 0 0 0 0 1 B
0084H to 0093H	(Vacancy)			
0094H	EIRR	External interrupt cause register	R/W	0 0 0 0 0 0 0 0 B
0095H	ENIR	Interrupt enable register	R/W	0 0 0 0 0 0 0 0 B
0096H to 0098H	(Vacancy)			
0099H	ELVR	External interrupt request level setting register	R/W	0 0 0 0 0 0 0 0 B
009AH to 00D1H	(Vacancy)			
00D2H	DDRE	Port E data direction register	W	0 0 0 0 0 0 0 0 B
00D3H	DDRF	Port F data direction register	W	0 0 0 0 0 0 0 0 B
00D4H to 00DBH	(Vacancy)			
00DCH	GCN1	General control register 1	R/W	0 0 1 1 0 0 1 0 B
00DDH				0 0 0 1 0 0 0 0 B
00DEH	(Vacancy)			
00DFH	GCN2	General control register 2	R/W	0 0 0 0 0 0 0 0 B

(Continued)

Address	Register name (abbreviated)	Register name	Read/write	Initial value
00E0$_H$	PTMR0	Ch. 0 timer register	R	1 1 1 1 1 1 1 1 $_B$
00E1$_H$				1 1 1 1 1 1 1 1 $_B$
00E2$_H$	PCSR0	Ch. 0 cycle setting register	W	X X X X X X X X $_B$
00E3$_H$				X X X X X X X X $_B$
00E4$_H$	PDUT0	Ch. 0 duty setting register	W	X X X X X X X X $_B$
00E5$_H$				X X X X X X X X $_B$
00E6$_H$	PCNH0	Ch. 0 control status register H	R/W	0 0 0 0 0 0 0 − $_B$
00E7$_H$	PCNL0	Ch. 0 control status register L	R/W	0 0 0 0 0 0 0 0 $_B$
00E8$_H$	PTMR1	Ch. 1 timer register	R	1 1 1 1 1 1 1 1 $_B$
00E9$_H$				1 1 1 1 1 1 1 1 $_B$
00EA$_H$	PCSR1	Ch. 1 cycle setting register	W	X X X X X X X X $_B$
00EB$_H$				X X X X X X X X $_B$
00EC$_H$	PDUT1	Ch. 1 duty setting register	W	X X X X X X X X $_B$
00ED$_H$				X X X X X X X X $_B$
00EE$_H$	PCNH1	Ch. 1 control status register H	R/W	0 0 0 0 0 0 0 − $_B$
00EF$_H$	PCNL1	Ch. 1 control status register L	R/W	0 0 0 0 0 0 0 0 $_B$
00F0$_H$	PTMR2	Ch. 2 timer register	R	1 1 1 1 1 1 1 1 $_B$
00F1$_H$				1 1 1 1 1 1 1 1 $_B$
00F2$_H$	PCSR2	Ch. 2 cycle setting register	W	X X X X X X X X $_B$
00F3$_H$				X X X X X X X X $_B$
00F4$_H$	PDUT2	Ch. 2 duty setting register	W	X X X X X X X X $_B$
00F5$_H$				X X X X X X X X $_B$
00F6$_H$	PCNH2	Ch. 2 control status register H	R/W	0 0 0 0 0 0 0 − $_B$
00F7$_H$	PCNL2	Ch. 2 control status register L	R/W	0 0 0 0 0 0 0 0 $_B$
00F8$_H$	PTMR3	Ch. 3 timer register	R	1 1 1 1 1 1 1 1 $_B$
00F9$_H$				1 1 1 1 1 1 1 1 $_B$
00FA$_H$	PCSR3	Ch. 3 cycle setting register	W	X X X X X X X X $_B$
00FB$_H$				X X X X X X X X $_B$
00FC$_H$	PDUT3	Ch. 3 duty setting register	W	X X X X X X X X $_B$
00FD$_H$				X X X X X X X X $_B$
00FE$_H$	PCNH3	Ch. 3 control status register H	R/W	0 0 0 0 0 0 0 − $_B$
00FF$_H$	PCNL3	Ch. 3 control status register L	R/W	0 0 0 0 0 0 0 0 $_B$

(Continued)

Address	Register name (abbreviated)	Register name	Read/write	Initial value
0100H to 01FFH		(Vacancy)		
0200H	DPDP	DMAC parameter descriptor pointer	R/W	X X X X X X X X B
0201H				X X X X X X X X B
0202H				X X X X X X X X B
0203H				X 0 0 0 0 0 0 0 B
0204H	DACSR	DMAC control status register	R/W	0 0 0 0 0 0 0 0 B
0205H				0 0 0 0 0 0 0 0 B
0206H				0 0 0 0 0 0 0 0 B
0207H				0 0 0 0 0 0 0 0 B
0208H	DATCR	DMAC pin control register	R/W	X X X X X X X X B
0209H				X X X X 0 0 0 0 B
020AH				X X X X 0 0 0 0 B
020BH				X X X X 0 0 0 0 B
020CH to 03E3H		(Vacancy)		
03E4H	ICHCR	Instruction cache control register	R/W	– – – – – – – – B
03E5H				– – – – – – – – B
03E6H				– – – – – – – – B
03E7H				– – 0 0 0 0 0 0 B
03E8H to 03EFH		(Vacancy)		
03F0H	BSD0	Bit search module 0-detection data register	W	X X X X X X X X B
03F1H				X X X X X X X X B
03F2H				X X X X X X X X B
03F3H				X X X X X X X X B
03F4H	BSD1	Bit search module 1-detection data register	R/W	X X X X X X X X B
03F5H				X X X X X X X X B
03F6H				X X X X X X X X B
03F7H				X X X X X X X X B

(Continued)

Address	Register name (abbreviated)	Register name	Read/write	Initial value
03F8H	BSDC	Bit search module transition-detection data register	W	X X X X X X X X B
03F9H				X X X X X X X X B
03FAH				X X X X X X X X B
03FBH				X X X X X X X X B
03FCH	BSRR	Bit search module detection result register	R	X X X X X X X X B
03FDH				X X X X X X X X B
03FEH				X X X X X X X X B
03FFH				X X X X X X X X B
0400H	ICR00	Interrupt control register 0	R/W	− − − 1 1 1 1 1 B
0401H	ICR01	Interrupt control register 1	R/W	− − − 1 1 1 1 1 B
0402H	ICR02	Interrupt control register 2	R/W	− − − 1 1 1 1 1 B
0403H	ICR03	Interrupt control register 3	R/W	− − − 1 1 1 1 1 B
0404H	ICR04	Interrupt control register 4	R/W	− − − 1 1 1 1 1 B
0405H	ICR05	Interrupt control register 5	R/W	− − − 1 1 1 1 1 B
0406H	ICR06	Interrupt control register 6	R/W	− − − 1 1 1 1 1 B
0407H	ICR07	Interrupt control register 7	R/W	− − − 1 1 1 1 1 B
0408H	ICR08	Interrupt control register 8	R/W	− − − 1 1 1 1 1 B
0409H	ICR09	Interrupt control register 9	R/W	− − − 1 1 1 1 1 B
040AH	ICR10	Interrupt control register 10	R/W	− − − 1 1 1 1 1 B
040BH	ICR11	Interrupt control register 11	R/W	− − − 1 1 1 1 1 B
040CH	ICR12	Interrupt control register 12	R/W	− − − 1 1 1 1 1 B
040DH	ICR13	Interrupt control register 13	R/W	− − − 1 1 1 1 1 B
040EH	ICR14	Interrupt control register 14	R/W	− − − 1 1 1 1 1 B
040FH	ICR15	Interrupt control register 15	R/W	− − − 1 1 1 1 1 B
0410H	ICR16	Interrupt control register 16	R/W	− − − 1 1 1 1 1 B
0411H	ICR17	Interrupt control register 17	R/W	− − − 1 1 1 1 1 B
0412H	ICR18	Interrupt control register 18	R/W	− − − 1 1 1 1 1 B
0413H	ICR19	Interrupt control register 19	R/W	− − − 1 1 1 1 1 B
0414H	ICR20	Interrupt control register 20	R/W	− − − 1 1 1 1 1 B
0415H	ICR21	Interrupt control register 21	R/W	− − − 1 1 1 1 1 B
0416H	ICR22	Interrupt control register 22	R/W	− − − 1 1 1 1 1 B

(Continued)

Address	Register name (abbreviated)	Register name	Read/write	Initial value
0417H	ICR23	Interrupt control register 23	R/W	– – – 1 1 1 1 1 B
0418H	ICR24	Interrupt control register 24	R/W	– – – 1 1 1 1 1 B
0419H	ICR25	Interrupt control register 25	R/W	– – – 1 1 1 1 1 B
041AH	ICR26	Interrupt control register 26	R/W	– – – 1 1 1 1 1 B
041BH	ICR27	Interrupt control register 27	R/W	– – – 1 1 1 1 1 B
041CH	ICR28	Interrupt control register 28	R/W	– – – 1 1 1 1 1 B
041DH	ICR29	Interrupt control register 29	R/W	– – – 1 1 1 1 1 B
041EH	ICR30	Interrupt control register 30	R/W	– – – 1 1 1 1 1 B
041FH	ICR31	Interrupt control register 31	R/W	– – – 1 1 1 1 1 B
042FH	ICR47	Interrupt control register 47	R/W	– – – 1 1 1 1 1 B
0430H	DICR	Delayed interrupt control register	R/W	– – – – – – – 0 B
0431H	HRCL	Hold request cancel request level setting register	R/W	– – – 1 1 1 1 1 B
0432H to 047FH		(Vacancy)		
0480H	RSRR/WTCR	Reset cause register/ watchdog peripheral control register	R/W	1 X X X X – 0 0 B
0481H	STCR	Standby control register	R/W	0 0 0 1 1 1 – – B
0482H	PDRR	DMA controller request squelch register	R/W	– – – – 0 0 0 0 B
0483H	CTBR	Timebase timer clear register	W	X X X X X X X X B
0484H	GCR	Gear control register	R/W	1 1 0 0 1 1 – 1 B
0485H	WPR	Watchdog reset occurrence postpone register	W	X X X X X X X X B
0486H		(Vacancy)		
0487H				
0488H	PCTR	PLL control register	R/W	0 0 – – 0 – – – B
0489H to 0600H		(Vacancy)		
0601H	DDR2	Port 2 data direction register	W	0 0 0 0 0 0 0 0 B
0602H to 0604H		(Vacancy)		
0605H	DDR6	Port 6 data direction register	W	0 0 0 0 0 0 0 0 B
0606H		(Vacancy)		
0607H				

(Continued)

Address	Register name (abbreviated)	Register name	Read/write	Initial value
0608H	DDRB	Port B data direction register	W	0 0 0 0 0 0 0 0 B
0609H	DDRA	Port A data direction register	W	− 0 0 0 0 0 0 − B
060AH		(Vacancy)		
060BH	DDR8	Port 8 data direction register	W	− − 0 − − 0 0 0 B
060CH	ASR1	Area select register 1	W	0 0 0 0 0 0 0 0 B
060DH				0 0 0 0 0 0 0 1 B
060EH	AMR1	Area mask register 1	W	0 0 0 0 0 0 0 0 B
060FH				0 0 0 0 0 0 0 0 B
0610H	ASR2	Area select register 2	W	0 0 0 0 0 0 0 0 B
0611H				0 0 0 0 0 0 1 0 B
0612H	AMR2	Area mask register 2	W	0 0 0 0 0 0 0 0 B
0613H				0 0 0 0 0 0 0 0 B
0614H	ASR3	Area select register 3	W	0 0 0 0 0 0 0 0 B
0615H				0 0 0 0 0 0 1 1 B
0616H	AMR3	Area mask register 3	W	0 0 0 0 0 0 0 0 B
0617H				0 0 0 0 0 0 0 0 B
0618H	ASR4	Area select register 4	W	0 0 0 0 0 0 0 0 B
0619H				0 0 0 0 0 1 0 0 B
061AH	AMR4	Area mask register 4	W	0 0 0 0 0 0 0 0 B
061BH				0 0 0 0 0 0 0 0 B
061CH	ASR5	Area select register 5	W	0 0 0 0 0 0 0 0 B
061DH				0 0 0 0 0 1 0 1 B
061EH	AMR5	Area mask register 5	W	0 0 0 0 0 0 0 0 B
061FH				0 0 0 0 0 0 0 0 B
0620H	AMD0	Area mode register 0	R/W	− − − 0 0 1 1 1 B
0621H	AMD1	Area mode register 1	R/W	0 − − 0 0 0 0 0 B
0622H	AMD32	Area mode register 32	R/W	0 0 0 0 0 0 0 0 B
0623H	AMD4	Area mode register 4	R/W	0 − − 0 0 0 0 0 B
0624H	AMD5	Area mode register 5	R/W	0 − − 0 0 0 0 0 B
0625H	DSCR	DRAM signal control register	W	0 0 0 0 0 0 0 0 B
0626H	RFCR	Refresh control register	R/W	− − X X X X X X B
0627H				0 0 − − − 0 0 0 B

(Continued)

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(Continued)

Address	Register name (abbreviated)	Register name	Read/write	Initial value
0628$_H$	EPCR0	External pin control register 0	W	$----1100_B$
0629$_H$				-1111111_B
062A$_H$	(Vacancy)			
062B$_H$	EPCR1	External pin control register 1	W	11111111_B
062C$_H$	DMCR4	DRAM control register 4	R/W	00000000_B
062D$_H$				$0000000-_B$
062E$_H$	DMCR5	DRAM control register 5	R/W	00000000_B
062F$_H$				$0000000-_B$
0630$_H$ to 07FD$_H$	(Vacancy)			
07FE$_H$	LER	Little endian register	W	$-----000_B$
07FF$_H$	MODR	Mode register	W	$XXXXXXXX_B$

Note: Do not use (vacancy).

■ INTERRUPT CAUSES, INTERRUPT VECTORS AND INTERRUPT CONTROL REGISTER ALLOCATIONS

Interrupt causes	Interrupt number		Interrupt level		TBR default address
	Decimal	Hexadecimal	Register	Offset	
Reset	0	00	—	3FC$_H$	000FFFFC$_H$
Reserved for system	1	01	—	3F8$_H$	000FFFF8$_H$
Reserved for system	2	02	—	3F4$_H$	000FFFF4$_H$
Reserved for system	3	03	—	3F0$_H$	000FFFF0$_H$
Reserved for system	4	04	—	3EC$_H$	000FFFEC$_H$
Reserved for system	5	05	—	3E8$_H$	000FFFE8$_H$
Reserved for system	6	06	—	3E4$_H$	000FFFE4$_H$
Reserved for system	7	07	—	3E0$_H$	000FFFE0$_H$
Reserved for system	8	08	—	3DC$_H$	000FFFDC$_H$
Reserved for system	9	09	—	3D8$_H$	000FFFD8$_H$
Reserved for system	10	0A	—	3D4$_H$	000FFFD4$_H$
Reserved for system	11	0B	—	3D0$_H$	000FFFD0$_H$
Reserved for system	12	0C	—	3CC$_H$	000FFFCC$_H$
Reserved for system	13	0D	—	3C8$_H$	000FFFC8$_H$
Exception for undefined instruction	14	0E	—	3C4$_H$	000FFFC4$_H$
NMI request	15	0F	F$_H$ fixed	3C0$_H$	000FFFC0$_H$
External interrupt 0	16	10	ICR00	3BC$_H$	000FFFBC$_H$
External interrupt 1	17	11	ICR01	3B8$_H$	000FFFB8$_H$
External interrupt 2	18	12	ICR02	3B4$_H$	000FFFB4$_H$
External interrupt 3	19	13	ICR03	3B0$_H$	000FFFB0$_H$
UART0 receive complete	20	14	ICR04	3AC$_H$	000FFFAC$_H$
UART1 receive complete	21	15	ICR05	3A8$_H$	000FFFA8$_H$
UART2 receive complete	22	16	ICR06	3A4$_H$	000FFFA4$_H$
UART0 transmit complete	23	17	ICR07	3A0$_H$	000FFFA0$_H$
UART1 transmit complete	24	18	ICR08	39C$_H$	000FFF9C$_H$
UART2 transmit complete	25	19	ICR09	398$_H$	000FFF98$_H$
DMAC0 (complete, error)	26	1A	ICR10	394$_H$	000FFF94$_H$
DMAC1 (complete, error)	27	1B	ICR11	390$_H$	000FFF90$_H$
DMAC2 (complete, error)	28	1C	ICR12	38C$_H$	000FFF8C$_H$
DMAC3 (complete, error)	29	1D	ICR13	388$_H$	000FFF88$_H$
DMAC4 (complete, error)	30	1E	ICR14	384$_H$	000FFF84$_H$
DMAC5 (complete, error)	31	1F	ICR15	380$_H$	000FFF80$_H$

(Continued)

Interrupt causes	Interrupt number		Interrupt level		TBR default address
	Decimal	Hexadecimal	Register	Offset	
DMAC6 (complete, error)	32	20	ICR16	37C$_H$	000FFF7C$_H$
DMAC7 (complete, error)	33	21	ICR17	378$_H$	000FFF78$_H$
A/D converter (successive approximation conversion type)	34	22	ICR18	374$_H$	000FFF74$_H$
16-bit reload timer 0	35	23	ICR19	370$_H$	000FFF70$_H$
16-bit reload timer 1	36	24	ICR20	36C$_H$	000FFF6C$_H$
16-bit reload timer 2	37	25	ICR21	368$_H$	000FFF68$_H$
PWM 0	38	26	ICR22	364$_H$	000FFF64$_H$
PWM 1	39	27	ICR23	360$_H$	000FFF60$_H$
PWM 2	40	28	ICR24	35C$_H$	000FFF5C$_H$
PWM 3	41	29	ICR25	358$_H$	000FFF58$_H$
U-TIMER 0	42	2A	ICR26	354$_H$	000FFF54$_H$
U-TIMER 1	43	2B	ICR27	350$_H$	000FFF50$_H$
U-TIMER 2	44	2C	ICR28	34C$_H$	000FFF4C$_H$
Reserved for system	45	2D	ICR29	348$_H$	000FFF48$_H$
Reserved for system	46	2E	ICR30	344$_H$	000FFF44$_H$
Reserved for system	47	2F	ICR31	340$_H$	000FFF40$_H$
Reserved for system	48	30	ICR32	33C$_H$	000FFF3C$_H$
Reserved for system	49	31	ICR33	338$_H$	000FFF38$_H$
Reserved for system	50	32	ICR34	334$_H$	000FFF34$_H$
Reserved for system	51	33	ICR35	330$_H$	000FFF30$_H$
Reserved for system	52	34	ICR36	32C$_H$	000FFF2C$_H$
Reserved for system	53	35	ICR37	328$_H$	000FFF28$_H$
Reserved for system	54	36	ICR38	324$_H$	000FFF24$_H$
Reserved for system	55	37	ICR39	320$_H$	000FFF20$_H$
Reserved for system	56	38	ICR40	31C$_H$	000FFF1C$_H$
Reserved for system	57	39	ICR41	318$_H$	000FFF18$_H$
Reserved for system	58	3A	ICR42	314$_H$	000FFF14$_H$
Reserved for system	59	3B	ICR43	310$_H$	000FFF10$_H$
Reserved for system	60	3C	ICR44	30C$_H$	000FFF0C$_H$
Reserved for system	61	3D	ICR45	308$_H$	000FFF08$_H$
Reserved for system	62	3E	ICR46	304$_H$	000FFF04$_H$
Delayed interrupt cause bit	63	3F	ICR47	300$_H$	000FFF00$_H$

(Continued)

(Continued)

Interrupt causes	Interrupt number		Interrupt level		TBR default address
	Decimal	Hexadecimal	Register	Offset	
Reserved for system (used in REALOS*)	64	40	—	2FC$_H$	000FFEFC$_H$
Reserved for system (used in REALOS*)	65	41	—	2F8$_H$	000FFEF8$_H$
Used in INT instructions	66 to 255	42 to FF	—	2F4$_H$ to 000$_H$	000FFEF4$_H$ to 000FFC00$_H$

* : When using in REALOS/FR, interrupt 0x40, 0x41 for system code.

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■ PERIPHERAL RESOURCES

1. I/O Ports

There are 2 types of I/O port register structure; port data register (PDR0 to PDRF) and data direction register (DDR0 to DDRF), where bits PDR0 to PDRF and bits DDR0 to DDRF corresponds respectively. Each bit on the register corresponds to an external pin. In port registers input/output register of the port configures input/output function of the port, while corresponding bit (pin) configures input/output function in data direction registers. Bit "0" specifies input and "1" specifies output.

- For input (DDR = "0") setting;
  PDR reading operation: reads level of corresponding external pin.
  PDR writing operation: writes set value to PDR.
- For output (DDR = "1") setting;
  PDR reading operation: reads PDR value.
  PDR writing operation: outputs PDR value to corresponding external pin.

- **Block diagram**
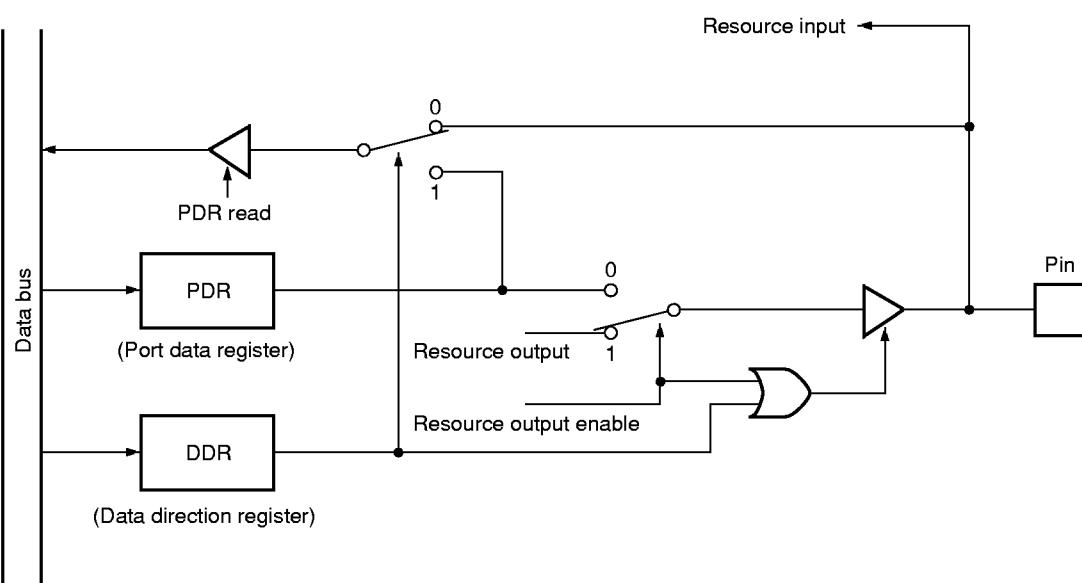
• **Port data register**

Address	bit 7		bit 0	Initial value	
000001H		PDR1		X X X X X X X X B	(R/W)
000005H		PDR6		X X X X X X X X B	(R/W)
00000BH		PDR8		- - X - - X X X B	(R/W)
000009H		PDRA		- X X X X X X - B	(R/W)
000008H		PDRB		X X X X X X X X B	(R/W)
000012H		PDRE		X X X X X X X X B	(R/W)
000013H		PDRF		X X X X X X X X B	(R/W)

( ) : Access
R/W : Readable and writable
X : Indeterminate

• **Data direction register**

Address	bit 7		bit 0	Initial value	
000601H		DDR2		0 0 0 0 0 0 0 0 B	(W)
000605H		DDR6		0 0 0 0 0 0 0 0 B	(W)
00060BH		DDR8		- - 0 - - 0 0 0 B	(W)
000609H		DDRA		- 0 0 0 0 0 0 - B	(W)
000608H		DDRB		0 0 0 0 0 0 0 0 B	(W)
0000D2H		DDRE		0 0 0 0 0 0 0 0 B	(W)
0000D3H		DDRF		0 0 0 0 0 0 0 0 B	(W)

( ) : Access
W : Write only
— : Unused

2. DMA Controller (DMAC)

The DMA controller is a module embedded in FR family devices, and performs DMA (direct memory access) transfer.

DMA transfer performed by the DMA controller transfers data without intervention of CPU, contributing to enhanced performance of the system.

- 8 channels
- Mode: single/block transfer, burst transfer and continuous transfer: 3 kinds of transfer
- Transfer all through the area
- Max. 65536 of transfer cycles
- Interrupt function right after the transfer
- Selectable for address transfer increase/decrease by the software
- External transfer request input pin, external transfer request accept output pin, external transfer complete output pin three pins for each

- **Block diagram**
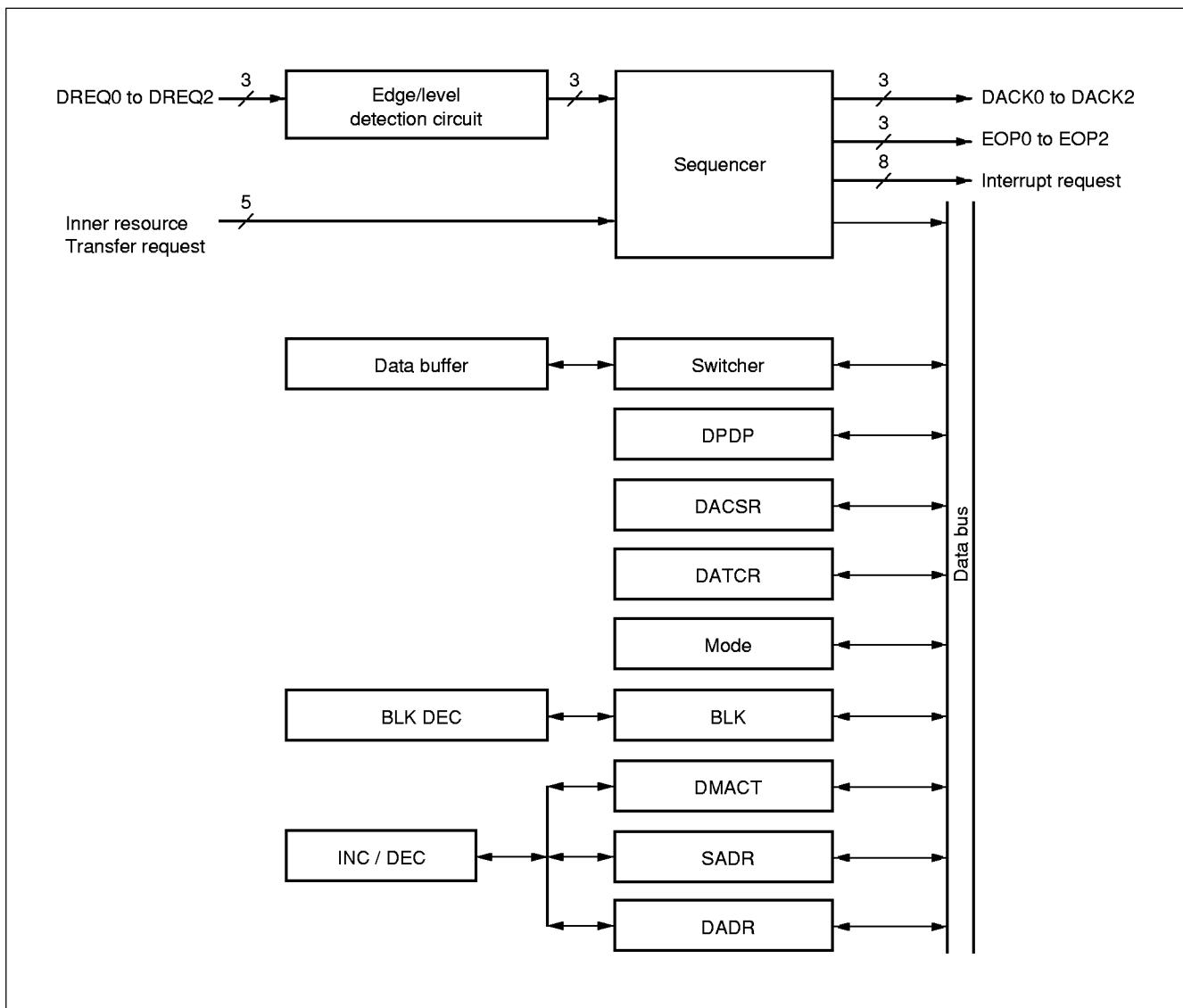
• **Registers (DMAC internal registers)**

Address   Initial value

00000200H	bit 31	bit 16	bit 0	X X X X X X X X B	
00000201H				X X X X X X X X B	
00000202H		DPDP		X X X X X X X X B	(R/W)
00000203H				X 0 0 0 0 0 0 0 B	
00000204H				0 0 0 0 0 0 0 0 B	
00000205H				0 0 0 0 0 0 0 0 B	
00000206H		DACSR		0 0 0 0 0 0 0 0 B	(R/W)
00000207H				0 0 0 0 0 0 0 0 B	
00000208H				X X X X X X X X B	
00000209H				X X X X 0 0 0 0 B	
0000020AH		DATCR		X X X X 0 0 0 0 B	(R/W)
0000020BH				X X X X 0 0 0 0 B	

( ) : Access
R/W : Readable and writable
X   : Indeterminate

• **Registers (DMA descriptor)**

Address   bit 31   bit 0

DPDP + 0H		DMA ch.0 Descriptor
DPDP + 0CH		DMA ch.1 Descriptor
DPDP + 54H		DMA ch.7 Descriptor
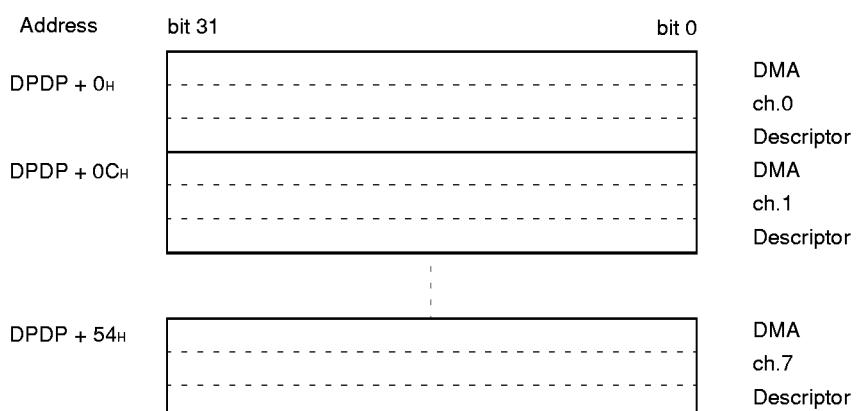
MB91101 Series

3. UART

The UART is a serial I/O port for supporting asynchronous (start-stop system) communication or CLK synchronous communication, and it has the following features.

The MB91101 consists of 3 channels of UART.

- Full double double buffer
- Both a synchronous (start-stop system) communication and CLK synchronous communication are available.
- Supporting multi-processor mode
- Perfect programmable baud rate
  Any baud rate can be set by internal timer (refer to section "4. U-TIMER").
- Any baud rate can be set by external clock.
- Error checking function (parity, framing and overrun)
- Transfer signal: NRZ code
- Enable DMA transfer/start by interrupt.

• **Block diagram**
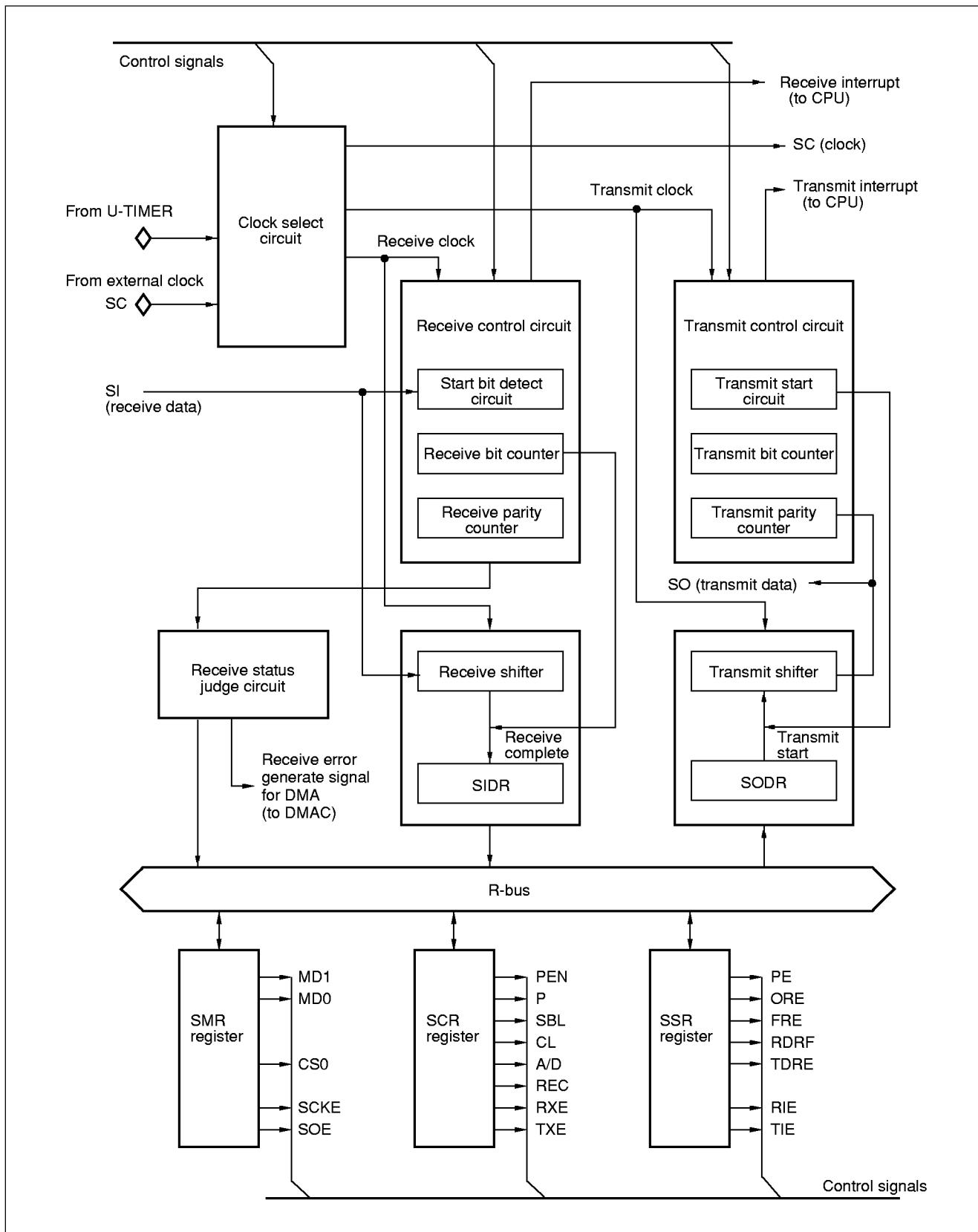
• **Register configuration**

Address	bit 15		bit 8		bit 0	Initial value	
0000001E_H		SCR0				0 0 0 0 0 1 0 0 B	(R/W)
00000022_H		SCR1				0 0 0 0 0 1 0 0 B	(R/W)
00000026_H		SCR2				0 0 0 0 0 1 0 0 B	(R/W)
0000001F_H				SMR0		0 0 - - 0 - 0 0 B	(R/W)
00000023_H				SMR1		0 0 - - 0 - 0 0 B	(R/W)
00000027_H				SMR2		0 0 - - 0 - 0 0 B	(R/W)
0000001C_H		SSR0				0 0 0 0 1 - 0 0 B	(R/W)
00000020_H		SSR1				0 0 0 0 1 - 0 0 B	(R/W)
00000024_H		SSR2				0 0 0 0 1 - 0 0 B	(R/W)
0000001D_H				SIDR0/SODR0		X X X X X X X X B	(R/W)
00000021_H				SIDR1/SIDR1		X X X X X X X X B	(R/W)
00000002_H				SIDR2/SIDR2		X X X X X X X X B	(R/W)

( ) : Access
R/W : Readable and writable
  − : Unused
  X : Indeterminate

4. U-TIMER (16-bit Timer for UART Baud Rate Generation)

The U-TIMER is a 16-bit timer for generating UART baud rate. Combination of chip operating frequency and reload value of U-TIMER allows flexible setting of baud rate.

The U-TIMER operates as an interval timer by using interrupt issued on counter underflow.

The MB91101 has 3 channel U-TIMER embedded on the chip. An interval of up to $2^{16} \times \phi$ can be counted.

- **Block diagram**

- **Register configuration**

5. PWM Timer

The PWM timer can output high accurate PWM waves efficiently.

MB91101 has inner 4-channel PWM timers, and has the following features.

- Each channel consists of a 16-bit down counter, a 16-bit data resister with a buffer for scyde setting, a 16-bit compare resister with a buffer for duty setting, and a pin controller.
- The count clock of a 16-bit down counter can be selected from the following four inner clocks.
    Inner clock ϕ, $\phi/4$, $\phi/16$, $\phi/64$
- The counter value can be initialized "FFFF$_H$" by the resetting or the counter borrow.
- PWM output (each channel)
- Resister description

- **Block diagram (general construction)**
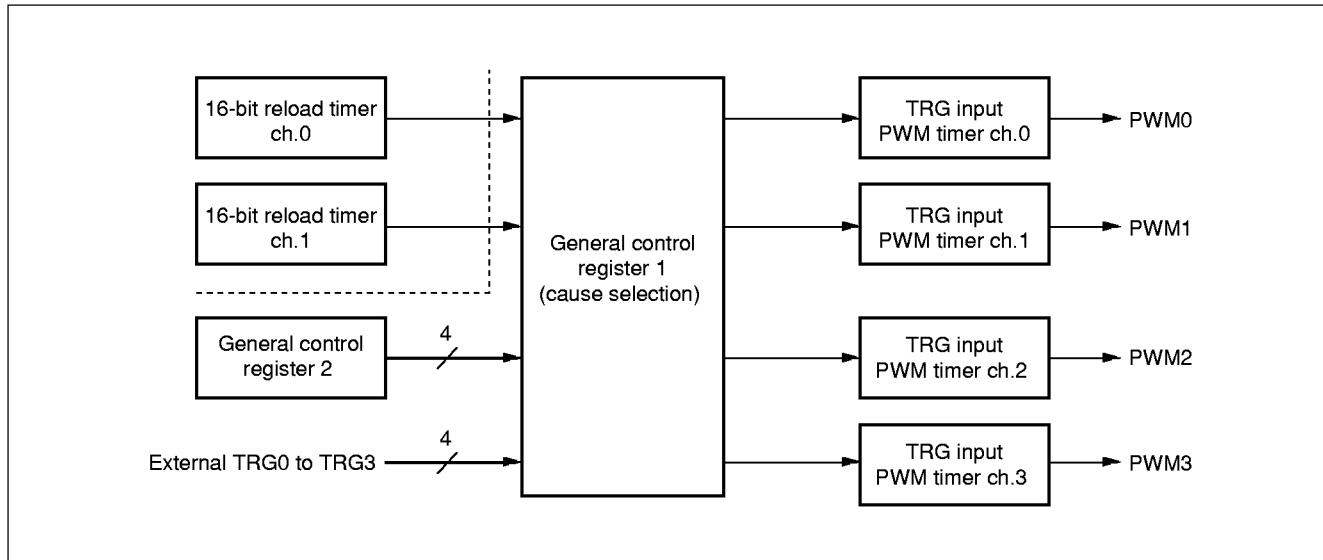
- **Block diagram (for one channel)**
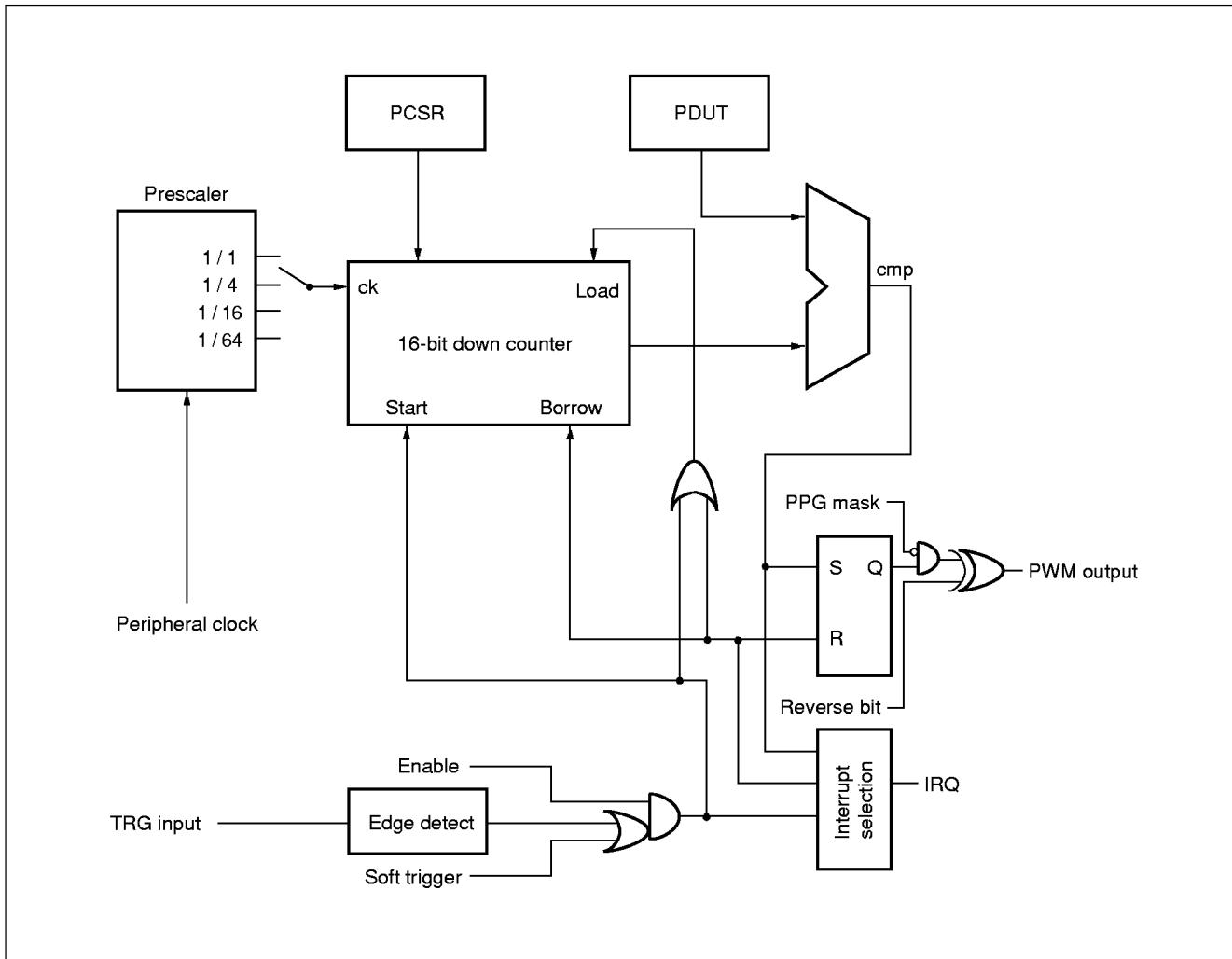
• **Register configuration**

Address		Initial value	Access
	bit 15　　　　　bit 8　　　　　bit 0		
000000DC$_H$ 000000DD$_H$	GCN1	0 0 1 1 0 0 1 0 $_B$ 0 0 0 1 0 0 0 0 $_B$	(R/W)
000000DF$_H$	GCN2	0 0 0 0 0 0 0 0 $_B$	(R/W)
000000E0$_H$ 000000E1$_H$	PTMR0	1 1 1 1 1 1 1 1 $_B$ 1 1 1 1 1 1 1 1 $_B$	(R)
000000E2$_H$ 000000E3$_H$	PCSR0	X X X X X X X X $_B$ X X X X X X X X $_B$	(W)
000000E4$_H$ 000000E5$_H$	PDUT0	X X X X X X X X $_B$ X X X X X X X X $_B$	(W)
000000E6$_H$	PCNH0	0 0 0 0 0 0 0 - $_B$	(R/W)
000000E7$_H$	PCNL0	0 0 0 0 0 0 0 0 $_B$	(R/W)
000000E8$_H$ 000000E9$_H$	PTMR1	1 1 1 1 1 1 1 1 $_B$ 1 1 1 1 1 1 1 1 $_B$	(R)
000000EA$_H$ 000000EB$_H$	PCSR1	X X X X X X X X $_B$ X X X X X X X X $_B$	(W)
000000EC$_H$ 000000ED$_H$	PDUT1	X X X X X X X X $_B$ X X X X X X X X $_B$	(W)
000000EE$_H$	PCNH1	0 0 0 0 0 0 0 - $_B$	(R/W)
000000EF$_H$	PCNL1	0 0 0 0 0 0 0 0 $_B$	(R/W)
000000F0$_H$ 000000F1$_H$	PTMR2	1 1 1 1 1 1 1 1 $_B$ 1 1 1 1 1 1 1 1 $_B$	(R)
000000F2$_H$ 000000F3$_H$	PCSR2	X X X X X X X X $_B$ X X X X X X X X $_B$	(W)
000000F4$_H$ 000000F5$_H$	PDUT2	X X X X X X X X $_B$ X X X X X X X X $_B$	(W)
000000F6$_H$	PCNH2	0 0 0 0 0 0 0 - $_B$	(R/W)
000000F7$_H$	PCNL2	0 0 0 0 0 0 0 0 $_B$	(R/W)
000000F8$_H$ 000000F9$_H$	PTMR3	1 1 1 1 1 1 1 1 $_B$ 1 1 1 1 1 1 1 1 $_B$	(R)
000000FA$_H$ 000000FB$_H$	PCSR3	X X X X X X X X $_B$ X X X X X X X X $_B$	(W)
000000FC$_H$ 000000FD$_H$	PDUT3	X X X X X X X X $_B$ X X X X X X X X $_B$	(W)
000000FE$_H$	PCNH3	0 0 0 0 0 0 0 - $_B$	(R/W)
000000FF$_H$	PCNL3	0 0 0 0 0 0 0 0 $_B$	(R/W)

( ) : Access
R/W : Readable and writable
R　 : Read only
W　 : Write only
−　 : Unused
X　 : Indeterminate

6. 16-bit Reload Timer

The 16-bit reload timer consists of a 16-bit down counter, a 16-bit reload timer, a prescaler for generating internal count clock and control registers.

Internal clock can be selected from 3 types of internal clocks (divided by 2/8/32 of machine clock).

The DMA transfer can be started by the interruption.

The MB91101 consists of 3 channels of the 16-bit reload timer.

• **Block diagram**
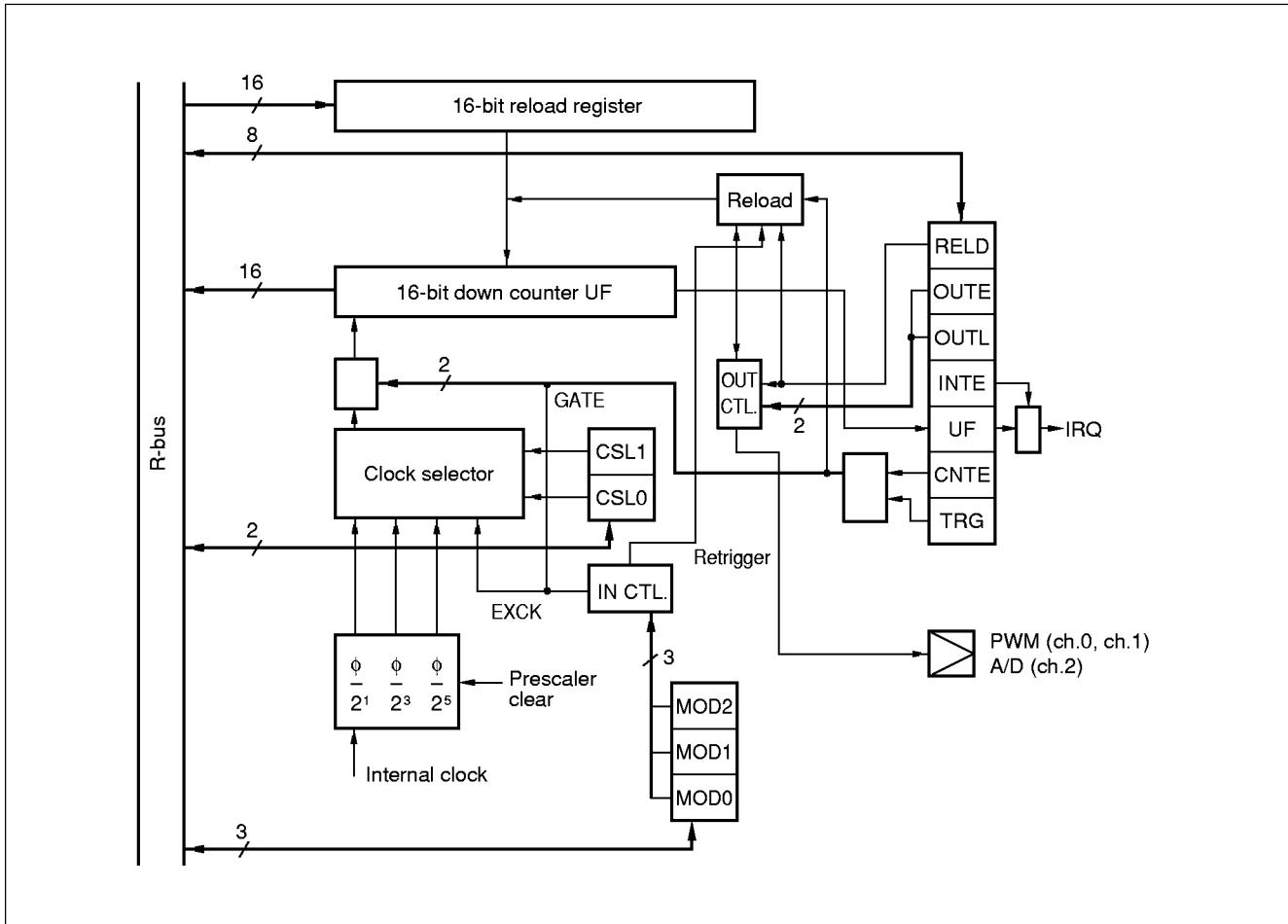
• **Register configuration**

Address	bit 15		bit 0	Initial value	
0000002E$_H$ 0000002F$_H$		TMCSR0		- - - - 0 0 0 0 $_B$ 0 0 0 0 0 0 0 0 $_B$	(R/W)
00000036$_H$ 00000037$_H$		TMCSR1		- - - - 0 0 0 0 $_B$ 0 0 0 0 0 0 0 0 $_B$	(R/W)
00000042$_H$ 00000043$_H$		TMCSR2		- - - - 0 0 0 0 $_B$ 0 0 0 0 0 0 0 0 $_B$	(R/W)
0000002A$_H$ 0000002B$_H$		TMR0		X X X X X X X X $_B$ X X X X X X X X $_B$	(R)
00000032$_H$ 00000033$_H$		TMR1		X X X X X X X X $_B$ X X X X X X X X $_B$	(R)
0000003E$_H$ 0000003F$_H$		TMR2		X X X X X X X X $_B$ X X X X X X X X $_B$	(R)
00000028$_H$ 00000029$_H$		TMRLR0		X X X X X X X X $_B$ X X X X X X X X $_B$	(W)
00000030$_H$ 00000031$_H$		TMRLR1		X X X X X X X X $_B$ X X X X X X X X $_B$	(W)
0000003C$_H$ 0000003D$_H$		TMRLR2		X X X X X X X X $_B$ X X X X X X X X $_B$	(W)

( ) : Access
R/W : Readable and writable
R : Read only
W : Write only
− : Unused
X : Indeterminate

7. Bit Search Module

The bit search module detects transitions of data (0 to 1/1 to 0) on the data written on the input registers and returns locations of the transitions.

- **Block diagram**
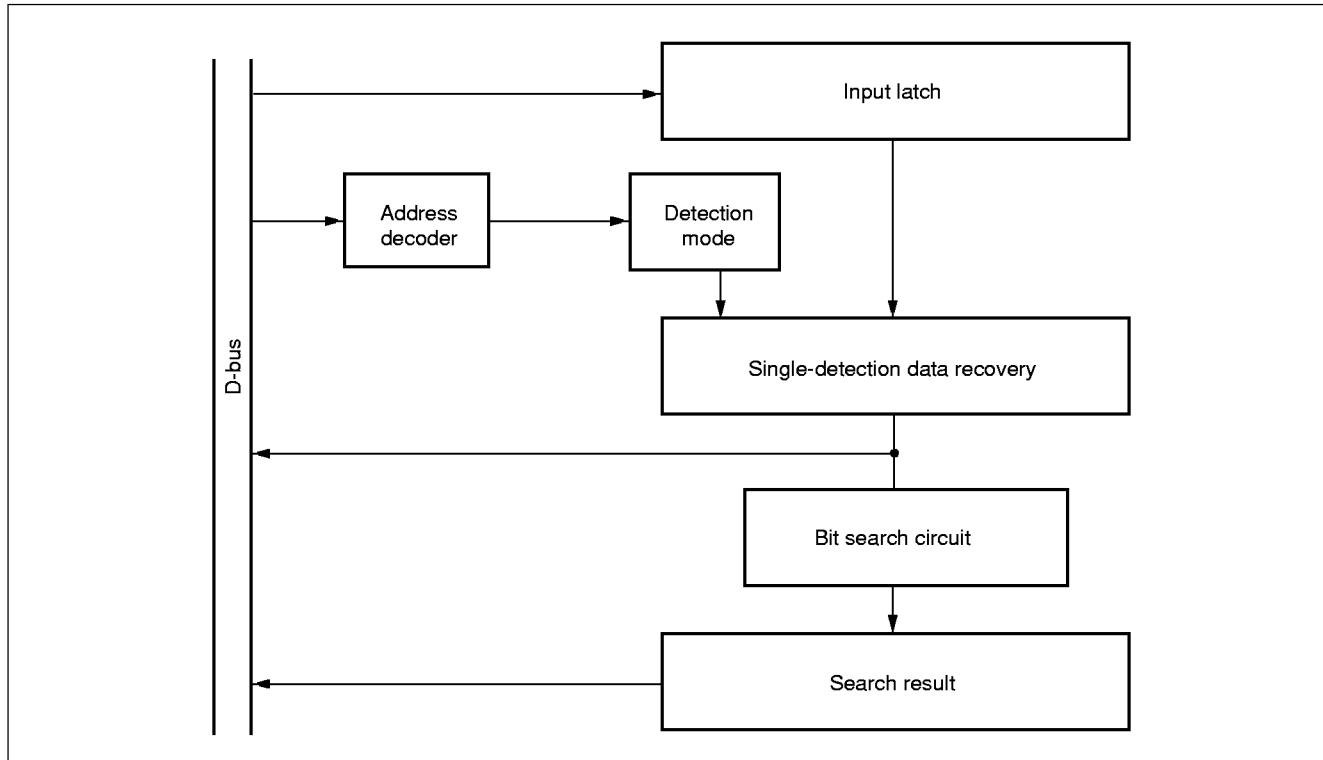
- **Register configuration**

Address	bit 31	bit 16	bit 0	Initial value	
000003F0H				XXXXXXXXB	
000003F1H		BSD0		XXXXXXXXB	(W)
000003F2H				XXXXXXXXB	
000003F3H				XXXXXXXXB	
000003F4H				XXXXXXXXB	
000003F5H		BSD1		XXXXXXXXB	(W)
000003F6H				XXXXXXXXB	
000003F7H				XXXXXXXXB	
000003F8H				XXXXXXXXB	
000003F9H		BSDC		XXXXXXXXB	(W)
000003FAH				XXXXXXXXB	
000003FBH				XXXXXXXXB	
000003FCH				XXXXXXXXB	
000003FEH		BSRR		XXXXXXXXB	(W)
000003FDH				XXXXXXXXB	
000003FFH				XXXXXXXXB	

( ) : Access
R/W : Readable and writable
R : Read only
W : Write only
X : Indeterminate

8. 10-bit A/D Converter (Successive Approximation Conversion Type)

The A/D converter is the module which converts an analog input voltage to a digital value, and it has following features.

- Minimum converting time: 5.6 μs/ch. (system clock: 25 MHz)
- Inner sample and hold circuit
- Resolution: 10 bits
- Analog input can be selected from 4 channels by program.
    - Single convert mode: 1 channel is selected and converted.
    - Scan convert mode: Converting continuous channels. Maximum 4 channels are programmable.
    - Continuous convert mode: Converting the specified channel repeatedly.
    - Stop convert mode: After converting one channel then stop and wait till next activation synchronising at the beginning of conversion can be peformed.
- DMA transfer operation is available by interruption.
- Operating factor can be selected from the software, the external trigger (falling edge), and 16-bit reload timer (rising edge).

- **Block diagram**
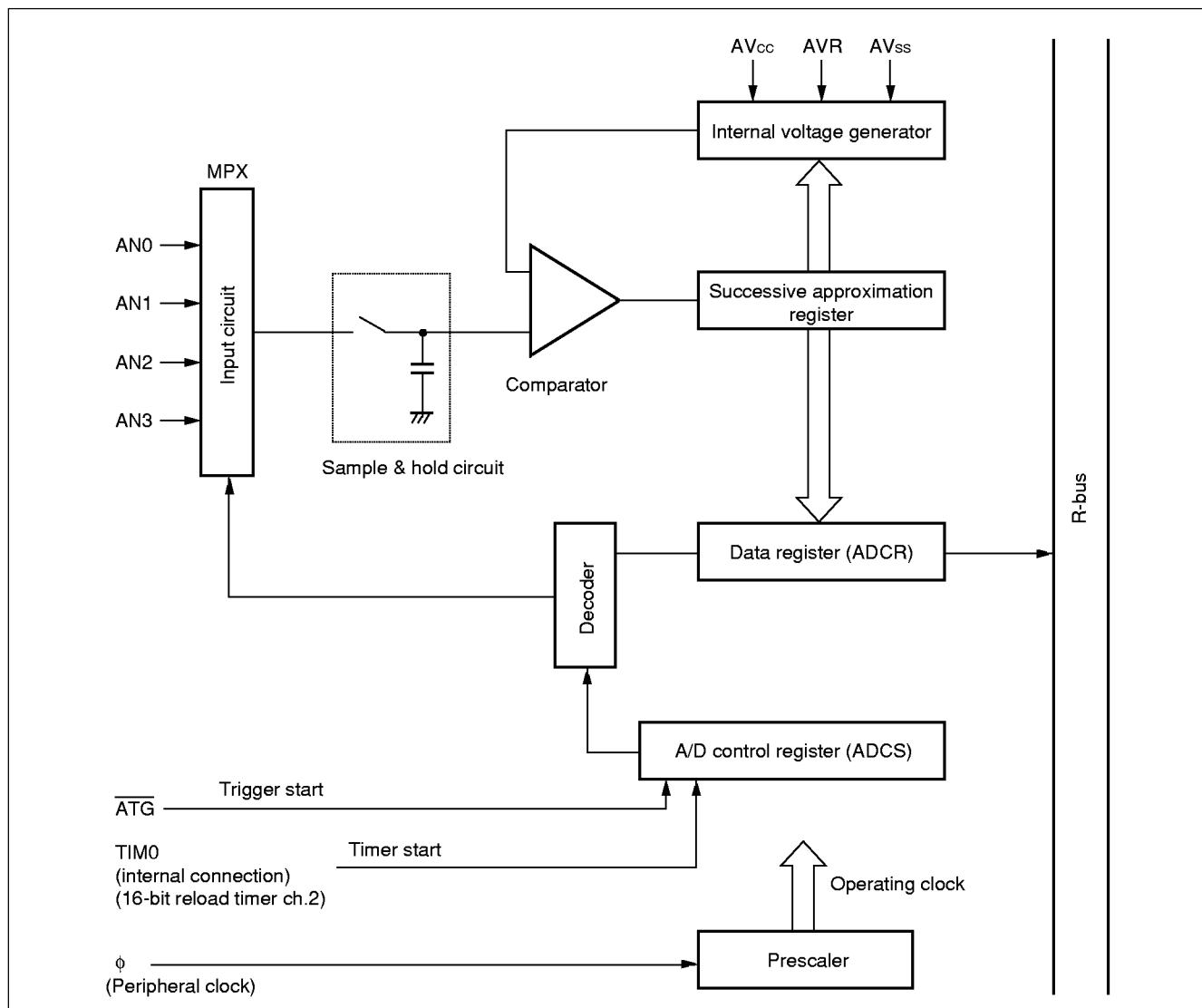
• **Register configuration**

Address

bit 15   bit 0   Initial value

0000003A$_H$
0000003B$_H$ | ADCS | 0 0 0 0 0 0 0 0 $_B$ (R/W)
                                                                              0 0 0 0 0 0 0 0 $_B$

00000038$_H$
00000039$_H$ | ADCR | - - - - - - X X $_B$ (R)
                                                                              X X X X X X X X $_B$

( ) : Access
R/W : Readable and writable
 R   : Read only
 –   : Unused
 X   : Indeterminate

9. Interrupt Controller

The interrupt controller processes interrupt acknowledgments and arbitration between interrupts.

• **Block diagram**
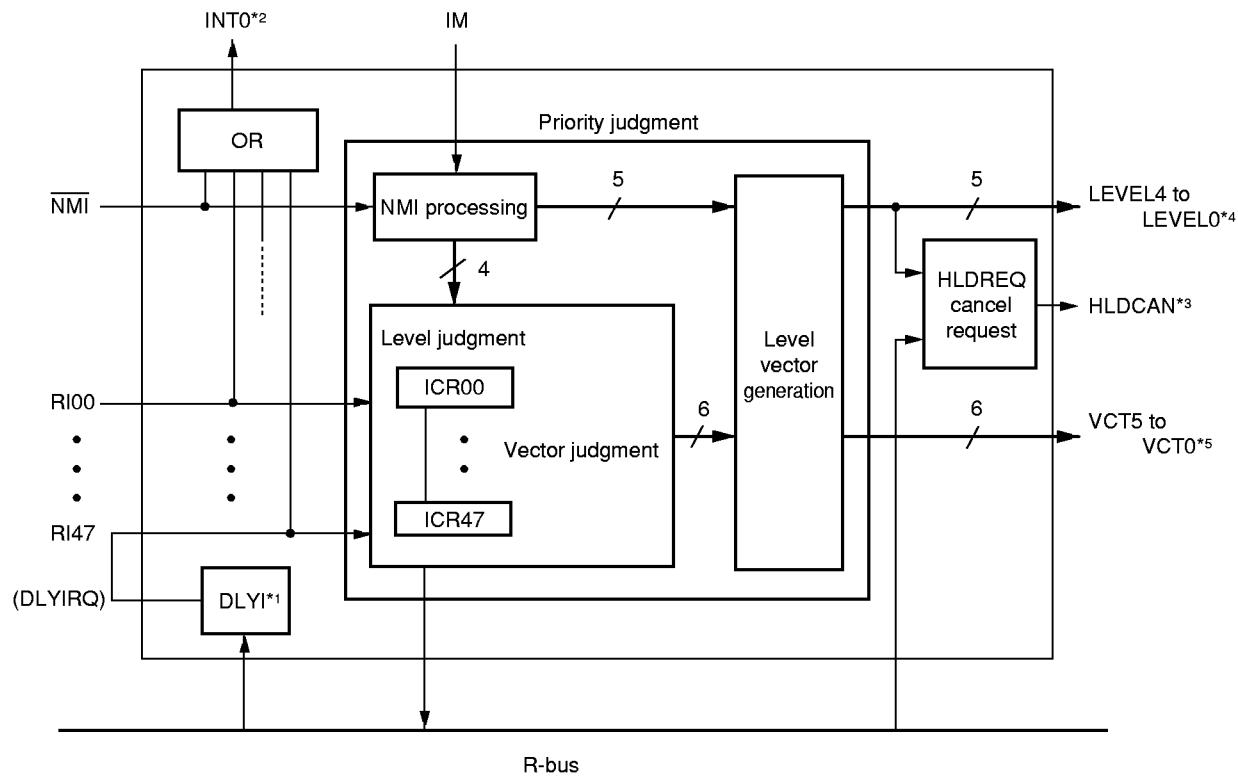
*1: DLYI stands for delayed interrupt module (delayed interrupt generation block) (refer to the section "11. Delayed Interrupt Module" for detail).

*2: INT0 is a wake-up signal to clock control block in the sleep or stop status.

*3: HLDCAN is a bus release request signal for bus masters other than CPU.

*4: LEVEL5 to LEVEL0 are interrupt level outputs.

*5: VCT5 to VCT0 are interrupt vector outputs.

• **Register configuration**

Address	bit 7 · · · bit 0	Initial value	Address	bit 7 · · · bit 0	Initial value
00000400н	ICR00	- - - 11111 в (R/W)	00000411н	ICR17	- - - 11111 в (R/W)
00000401н	ICR01	- - - 11111 в (R/W)	00000412н	ICR18	- - - 11111 в (R/W)
00000402н	ICR02	- - - 11111 в (R/W)	00000413н	ICR19	- - - 11111 в (R/W)
00000403н	ICR03	- - - 11111 в (R/W)	00000414н	ICR20	- - - 11111 в (R/W)
00000404н	ICR04	- - - 11111 в (R/W)	00000415н	ICR21	- - - 11111 в (R/W)
00000405н	ICR05	- - - 11111 в (R/W)	00000416н	ICR22	- - - 11111 в (R/W)
00000406н	ICR06	- - - 11111 в (R/W)	00000417н	ICR23	- - - 11111 в (R/W)
00000407н	ICR07	- - - 11111 в (R/W)	00000418н	ICR24	- - - 11111 в (R/W)
00000408н	ICR08	- - - 11111 в (R/W)	00000419н	ICR25	- - - 11111 в (R/W)
00000409н	ICR09	- - - 11111 в (R/W)	0000041Aн	ICR26	- - - 11111 в (R/W)
0000040Aн	ICR10	- - - 11111 в (R/W)	0000041Bн	ICR27	- - - 11111 в (R/W)
0000040Bн	ICR11	- - - 11111 в (R/W)	0000041Cн	ICR28	- - - 11111 в (R/W)
0000040Cн	ICR12	- - - 11111 в (R/W)	0000041Dн	ICR29	- - - 11111 в (R/W)
0000040Dн	ICR13	- - - 11111 в (R/W)	0000041Eн	ICR30	- - - 11111 в (R/W)
0000040Eн	ICR14	- - - 11111 в (R/W)	0000041Fн	ICR31	- - - 11111 в (R/W)
0000040Fн	ICR15	- - - 11111 в (R/W)	0000042Fн	ICR47	- - - 11111 в (R/W)
00000410н	ICR16	- - - 11111 в (R/W)	00000431н	HRCL	- - - 11111 в (R/W)
			00000430н	DICR	- - - - - - - 0 в (R/W)

( ) : Access
R/W : Redable and writable
– : Unused

10. External Interrupt/NMI Control Block

The external interrupt/NMI control block controls external interrupt request signals input to $\overline{\text{NMI}}$ pin and INT0 to INT3 pins.

Detecting levels can be selected from "H", "L", rising edge and falling edge (not for $\overline{\text{NMI}}$ pin).

• **Block diagram**
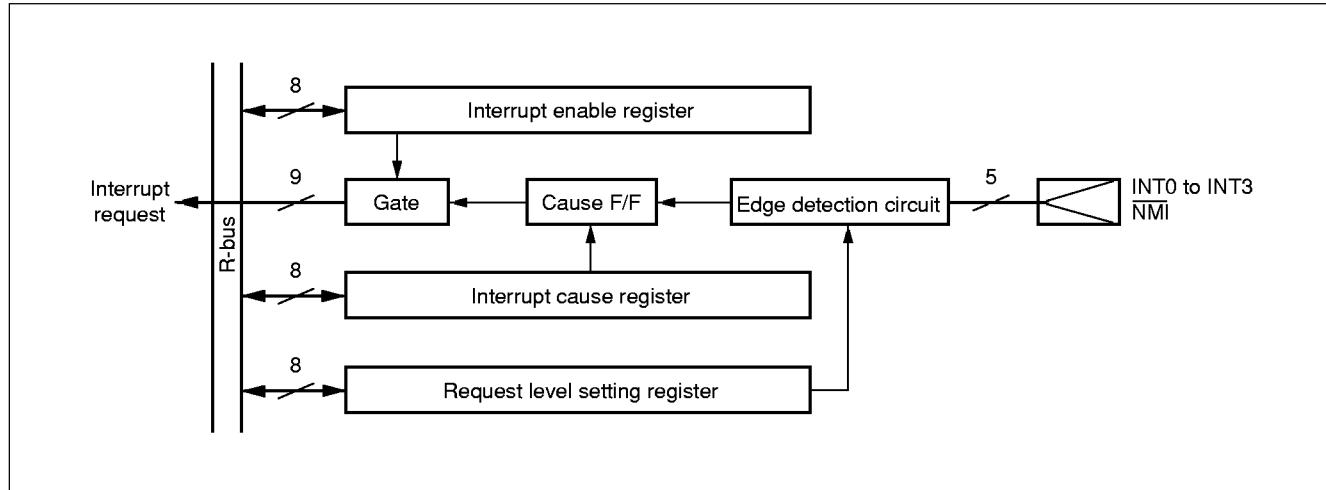
• **Register configuration**

Address	bit 15	bit 8	bit 0	Initial value	
00000095H		ENIR		00000000 B	(R/W)
00000094H	EIRR			00000000 B	(R/W)
00000099H	ELVR			00000000 B	(R/W)

( ) : Access
R/W : Redable and writable

11. Delayed Interrupt Module

Delayed interrupt module is a module which generates a interrupt for changing a task. By using this delayed interrupt module, an interrupt request to CPU can be generated/cancelled by the software.

Refer to the section "9. Interrupt Controller" for delayed interrupt module block diagram.

• **Register configuration**

Address   bit 7   bit 0   Initial value

00000430H   ┌──────────────────────────────────┐   - - - - - - - 0 ʙ (R/W)
                 │   DICR   │
                 └──────────────────────────────────┘

( ) : Access
R/W : Redable and writable
 −   : Unused

12. Clock Generation (Low-power consumption mechanism)

The clock control block is a module which undertakes the following functions.

• CPU clock generation (including gear function)
• Peripheral clock generation (including gear function)
• Reset generation and cause hold
• Standby function (including hardware standby)
• DMA request prohibit
• PLL (multiplier circuit) embedded

• **Block diagram**
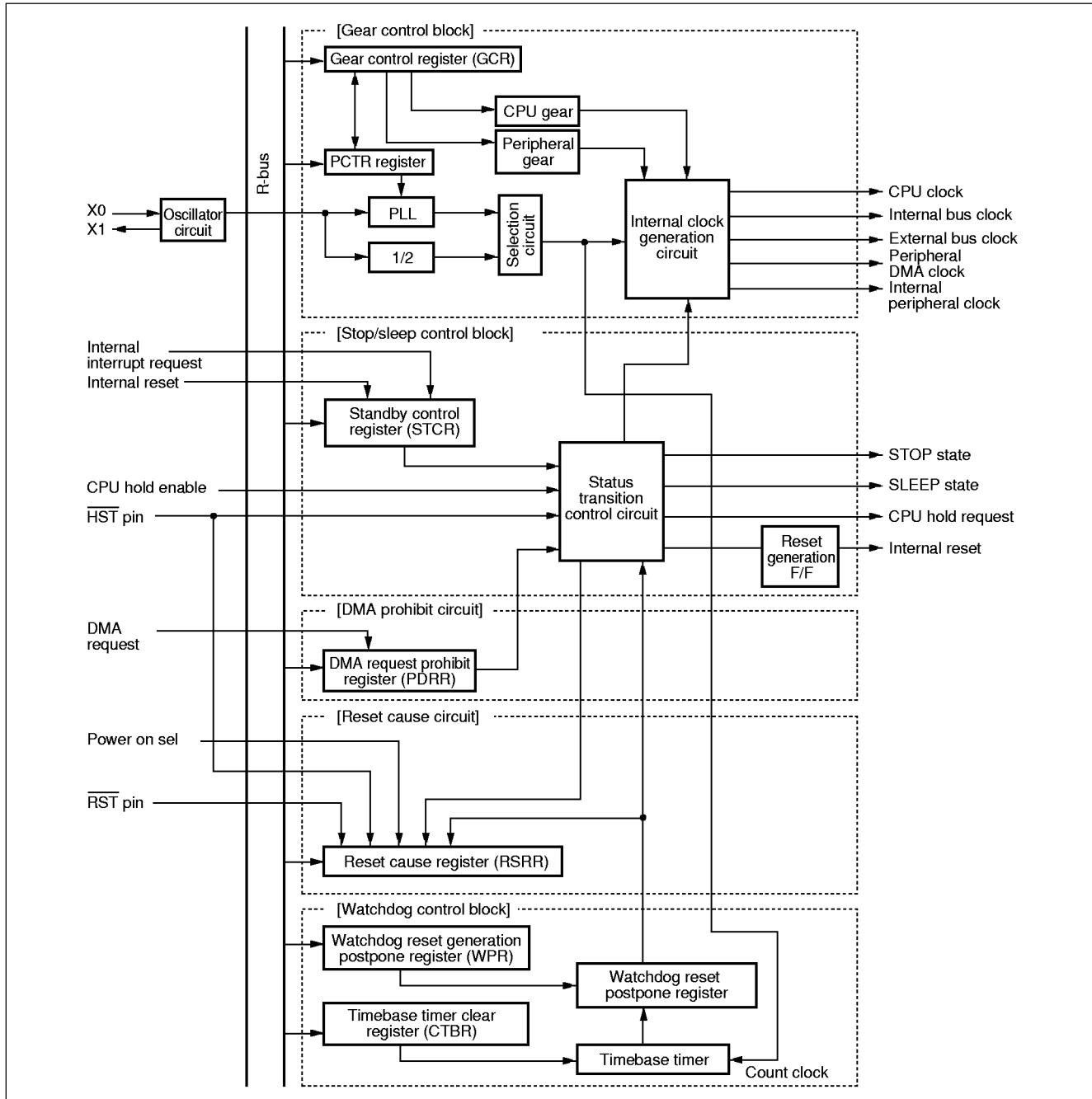
• **Register configuration**

Address	bit 15	bit 8	bit 0	Initial value	
00000480H	RSRR/WTCR			1 X X X X - 0 0 B	(R/W)
00000481H		STCR		0 0 0 1 1 1 - - B	(R/W)
00000482H	PDRR			- - - - 0 0 0 0 B	(R/W)
00000483H		CTBR		X X X X X X X X B	(W)
00000484H	GCR			1 1 0 0 1 1 - 1 B	(R/W)
00000485H		WPR		X X X X X X X X B	(W)

( ) : Access
R/W : Redable and writable
W : Write only
— : Unused
X : Indeterminate

13. External Bus Interface

The external bus interface controls the interface between the device and the external memory and also the external I/O, and has the following features.

- 25-bit (32 Mbytes) address output
- 6 independent banks owing to the chip select function.
  Can be set to anywhere on the logical address space for minimum unit 64 Kbytes.
  Total 32 Mbytes × 6 area setting is available by the address pin and the chip select pin.
- 8/16-bit bus width setting are available for every chip select area.
- Programmable automatic memory wait (max. for 7 cycles) can be inserted.
- DRAM interface support
  Three kinds of DRAM interface: Double CAS DRAM (normally DRAM I/F)
  Single CAS DRAM
  Hyper DRAM
  2 banks independent control (RAS, CAS, etc. control signals)
  DRAM select is available from 2CAS/1WE and 1CAS/2WE.
  Hi-speed page mode supported
  CBR/self refresh supported
  Programmable wave form
- Unused address/data pin can be used for I/O port.
- Little endian mode supported
- Clock doublure: Internal bus 50 MHz, external bus 25 MHz

• **Block diagram**

• **Register configuration**
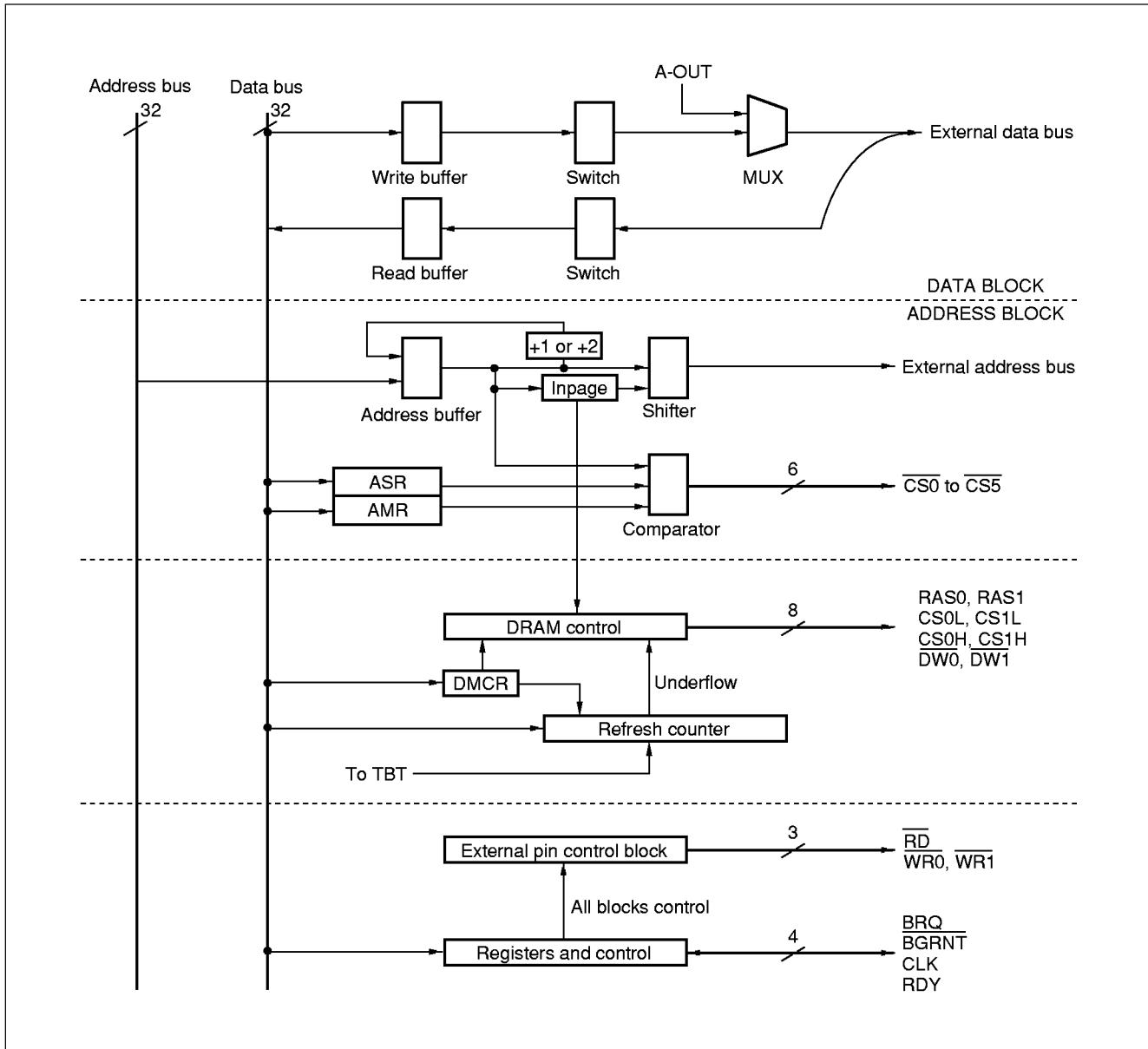
Address				Initial value	
	bit 31	bit 16	bit 0		


```
Address
             bit 31              bit 16              bit 0      Initial value

0000060CH    [      ASR1      ]                                0 0 0 0 0 0 0 0 B  (W)
0000060DH                                                      0 0 0 0 0 0 0 1 B  (W)

0000060EH                      [      AMR1      ]              0 0 0 0 0 0 0 0 B  (W)
0000060FH                                                      0 0 0 0 0 0 0 0 B  (W)

00000610H    [      ASR2      ]                                0 0 0 0 0 0 0 0 B  (W)
00000611H                                                      0 0 0 0 0 0 1 0 B  (W)

00000612H                      [      AMR2      ]              0 0 0 0 0 0 0 0 B  (W)
00000613H                                                      0 0 0 0 0 0 0 0 B  (W)

00000614H    [      ASR3      ]                                0 0 0 0 0 0 0 0 B  (W)
00000615H                                                      0 0 0 0 0 0 1 1 B  (W)

00000616H                      [      AMR3      ]              0 0 0 0 0 0 0 0 B  (W)
00000617H                                                      0 0 0 0 0 0 0 0 B  (W)

00000618H    [      ASR4      ]                                0 0 0 0 0 0 0 0 B  (W)
00000619H                                                      0 0 0 0 0 1 0 0 B  (W)

0000061AH                      [      AMR4      ]              0 0 0 0 0 0 0 0 B  (W)
0000061BH                                                      0 0 0 0 0 0 0 0 B  (W)

0000061CH    [      ASR5      ]                                0 0 0 0 0 0 0 0 B  (W)
0000061DH                                                      0 0 0 0 0 1 0 1 B  (W)

0000061EH                      [      AMR5      ]              0 0 0 0 0 0 0 0 B  (W)
0000061FH                                                      0 0 0 0 0 0 0 0 B  (W)

00000620H    [ AMD0 ]                                          - - - 0 0 1 1 1 B  (R/W)

00000621H         [ AMD1 ]                                     0 - - 0 0 0 0 0 B  (R/W)

00000622H              [ AMD32 ]                               0 0 0 0 0 0 0 0 B  (R/W)

00000623H                   [ AMD4 ]                           0 - - 0 0 0 0 0 B  (R/W)

00000624H    [ AMD5 ]                                          0 - - 0 0 0 0 0 B  (R/W)

00000625H         [ DSCR ]                                     0 0 0 0 0 0 0 0 B  (W)

00000626H                      [      RFCR      ]              - - X X X X X X B  (R/W)
00000627H                                                      0 0 - - - 0 0 0 B  (R/W)

00000628H    [      EPCR0     ]                                - - - 1 1 0 0 0 B  (W)
00000629H                                                      - 1 1 1 1 1 1 1 B  (W)

0000062BH                           [ EPCR1 ]                  1 1 1 1 1 1 1 1 B  (W)

0000062CH    [      DMCR4     ]                                0 0 0 0 0 0 0 0 B  (R/W)
0000062DH                                                      0 0 0 0 0 0 0 - B  (R/W)

0000062EH                      [      DMCR5     ]              0 0 0 0 0 0 0 0 B  (R/W)
0000062FH                                                      0 0 0 0 0 0 0 - B  (R/W)

000007FEH                      [ LER ]                         - - - - - 0 0 0 B  (W)

000007FFH                           [ MODR ]                   X X X X X X X X B  (W)
```

( ) : Access
R/W : Redable and writable
W   : Write only
−   : Unused
X   : Indeterminate

■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

$(V_{SS} = AV_{SS} = 0.0 \text{ V})$

Parameter		Symbol	Value		Unit	Remarks
			Min.	Max.		
Power supply voltage	At 5 V power supply	$V_{CC}5$	$V_{SS} - 0.3$	$V_{SS} + 6.5$	V	
		$V_{CC}3$	—	—	V	
	At 3 V power supply	$V_{CC}5$	$V_{CC}3 - 0.3$	$V_{SS} + 6.5$	V	*1
		$V_{CC}3$	$V_{SS} - 0.3$	$V_{SS} + 3.6$	V	*1
Analog supply voltage		AV_{CC}	$V_{SS} - 0.3$	$V_{SS} + 3.6$	V	*2
Analog reference voltage		AVRH	$V_{SS} - 0.3$	$V_{SS} + 3.6$	V	*2
Analog pin input voltage		V_{IA}	$V_{SS} - 0.3$	$AV_{CC} + 0.3$	V	
Input voltage		V_I	$V_{SS} - 0.3$	$V_{CC}5 + 0.3$	V	
Output voltage		V_O	$V_{SS} - 0.3$	$V_{CC}5 + 0.3$	V	
"L" level maximum output current		I_{OL}	—	10	mA	*3
"L" level average output current		I_{OLAV}	—	4	mA	*4
"L" level maximum total output current		ΣI_{OL}	—	100	mA	
"L" level average total output current		ΣI_{OLAV}	—	50	mA	*5
"H" level maximum output current		I_{OH}	—	−10	mA	*3
"H" level average output current		I_{OHAV}	—	−4	mA	*4
"H" level maximum total output current		ΣI_{OH}	—	−50	mA	
"H" level average total output current		ΣI_{OHAV}	—	−20	mA	*5
Power consumption		P_D	—	500	mW	
Operating temperature		T_A	0	+70	°C	
Storage temperature		Tstg	−55	+150	°C	

*1: $V_{CC}5$ must not be less than $V_{SS} - 0.3$ V.
*2: Make sure that the voltage does not exceed $V_{CC}5 + 0.3$ V, such as when turning on the device.
*3: Maximum output current is a peak current value measured at a corresponding pin.
*4: Average output current is an average current for a 100 ms period at a corresponding pin.
*5: Average total output current is an average current for a 100 ms period for all corresponding pins.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

2. Recommended Operating Conditions

(1) At 5 V operation (4.5 V to 5.5 V)

$(V_{SS} = AV_{SS} = 0.0\ V)$

Parameter	Symbol	Value		Unit	Remarks
		Min.	Max.		
Power supply voltage	$V_{CC}5$	4.5	5.5	V	Normal operation *1
	$V_{CC}5$	*1	*1	V	Retaining the RAM state in stop mode
	$V_{CC}3$	—	—	V	*2
Analog supply voltage	AV_{CC}	$V_{SS} + 2.7$	$V_{CC} + 3.6$	V	
Analog reference voltage	AVRH	$V_{SS} - 0.3$	AV_{CC}	V	
Operating temperature	T_A	0	+70	°C	
Smoothing capacitor	C_S	0.1	1.0	μF	$V_{CC}3$ pin *2

*1: At $V_{CC}5$, the RAM state holding is not warranted in stop mode.
*2: $V_{CC}3$ is used for the bypass capacitor pin.
*3: Use the ceramic capacitor or the capacitor whose frequency characteristic is equivalent to that of the ceramic capacitor.
And select the larger capacity smoothing condenser to connect to the power supply ($V_{CC}5$) than C_S.

(2) At 3 V operation (2.7 V to 3.6 V)

$(V_{SS} = AV_{SS} = 0.0\ V)$

| Parameter	Symbol	Value		Unit	Remarks
		Min.	Max.		
Power supply voltage	$V_{CC}5$	2.7	3.6	V	Normal operation
	$V_{CC}5$	2.7	3.6	V	Retaining the RAM state in stop mode
	$V_{CC}3$	2.7	3.6	V	*
Analog power supply voltage	AV_{CC}	$V_{SS} + 2.7$	$V_{CC} + 3.6$	V	
Analog reference voltage	AVRH	AV_{SS}	AV_{CC}	V	
Operating temperature	T_A	0	+70	°C	

* : Connect to $V_{CC}5$ for the power supply pin.

• **Connecting to a power supply**

Normal operation warranty range (TA = 0°C to +70°C)
Net masked area are fCPP.

Notes: • When using PLL, the external clock must be used between 10.0 MHz to 12.5 MHz.
 • PLL oscillation stabilizing period > 100 μs
 • The setting of internal clock must be within above ranges.
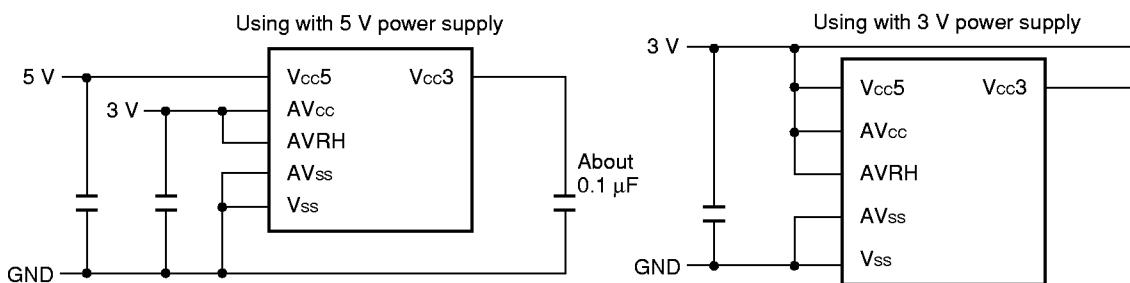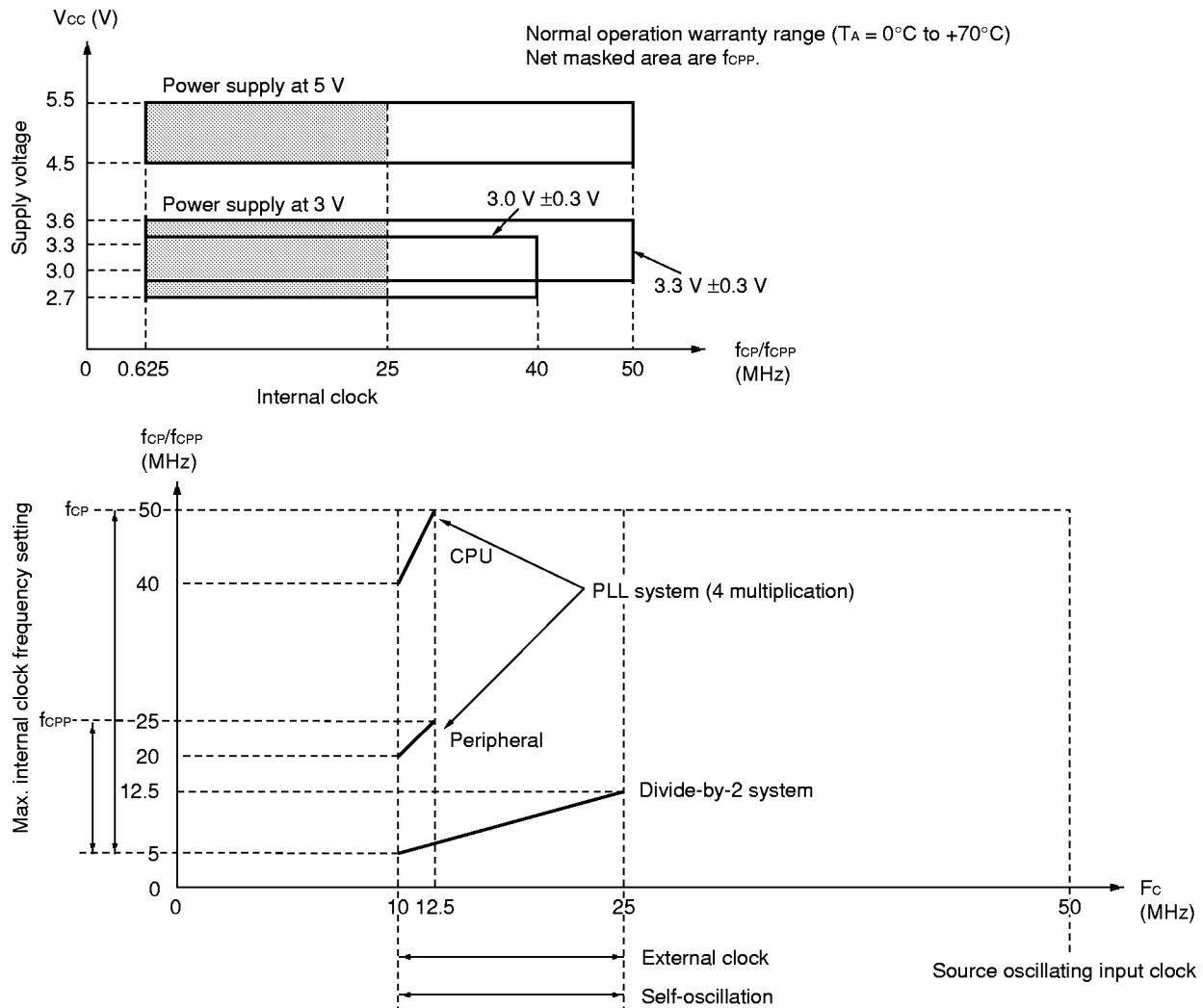
WARNING: Recommended operating conditions are normal operating ranges for the semiconductor device. All the device's electrical characteristics are warranted when operated within these ranges.

Always use semiconductor devices within the recommended operating conditions. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representative beforehand.

3. DC Characteristics

$(V_{CC}5 = 5.0 \text{ V} \pm 10\%, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

$(V_{CC}5 = V_{CC}3 = 2.7 \text{ V to } 3.6 \text{ V}, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

| Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min.	Typ.	Max.		
"H" level input voltage	V_{IH}	Input pin except for hysteresis input	—	$0.65 \times V_{CC}3$	—	$V_{CC}5 + 0.3$	V	*
	V_{IHS}	$\overline{HST}$, $\overline{NMI}$, $\overline{RST}$, PA1 to PA6, PB0 to PB7, PE0 to PE7, PF0 to PF7	—	$0.8 \times V_{CC}3$	—	$V_{CC}5 + 0.3$	V	Hysteresis input *
"L" level input voltage	V_{IL}	Input other than following symbols	—	$V_{SS} - 0.3$	—	$0.25 \times V_{CC}3$	V	*
	V_{ILS}	$\overline{HST}$, $\overline{NMI}$, $\overline{RST}$, PA1 to PA6, PB0 to PB7, PE0 to PE7, PF0 to PF7	—	$V_{SS} - 0.3$	—	$0.2 \times V_{CC}3$	V	Hysteresis input *
"H" level output voltage	V_{OH}	D16 to D31, A00 to A24, P6 to PF	$V_{CC}5 = 4.5 \text{ V}$ $I_{OH} = -4.0 \text{ mA}$	$V_{CC} - 0.5$	—	—	V	
"L" level output voltage	V_{OL}	D16 to D31, A00 to A24, P6 to PF	$V_{CC}5 = 4.5 \text{ V}$ $I_{OL} = 4.0 \text{ mA}$	—	—	0.4	V	
Input leakage current (Hi-Z output leakage current)	I_{LI}	D00 to D31, A00 to A23, P8 to PF	$V_{CC}5 = 5.5 \text{ V}$ $0.45 \text{ V} < V_I$ $< V_{CC}$	−5	—	+5	μA	
Pull-up resistance	R_{PULL}	$\overline{RST}$	$V_{CC}5 = 5.5 \text{ V}$ $V_I = 0.45 \text{ V}$	25	50	100	kΩ	
Power supply current	I_{CC}	V_{CC}	$F_C = 12.5 \text{ MHz}$ $V_{CC}5 = 5.5 \text{ V}$	—	75	100	mA	(4 multiplication) Operation at 50 MHz
	I_{CCS}	V_{CC}	$F_C = 12.5 \text{ MHz}$ $V_{CC}5 = 5.5 \text{ V}$	—	40	60	mA	Sleep mode
	I_{CCH}	V_{CC}	$T_A = +25°C$ $V_{CC}5 = 5.5 \text{ V}$	—	10	100	μA	Stop mode
Input capacitance	C_{IN}	Except for $V_{CC}5$, $V_{CC}3$, AV_{CC}, AV_{SS}, V_{SS}	—	—	10	—	pF	

* : $V_{CC}3 = 3.3 \pm 0.2 \text{ V}$ (internal regulator output voltage) when using 5 V power supply, $V_{CC}3$ = power supply voltage when using 3 V power supply (internal regulator unused)

4. AC Characteristics

(1) Measurement Conditions

- **Vcc = 5.0 V ±10%**

Parameter	Symbol	Value			Unit	Remarks
		Min.	Typ.	Max.		
"H" level input voltage	V_{IH}	—	2.4	—	V	
"L" level input voltage	V_{IL}	—	0.8	—	V	
"H" level output voltage	V_{OH}	—	2.4	—	V	
"L" level output voltage	V_{OL}	—	0.8	—	V	
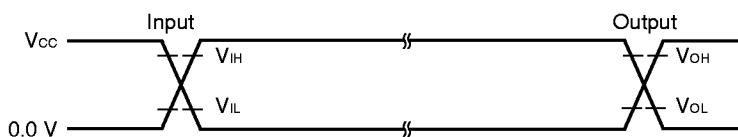
- **Vcc = 2.7 V to 3.6 V**

Parameter	Symbol	Value			Unit	Remarks
		Min.	Typ.	Max.		
"H" level input voltage	V_{IH}	—	$1/2 \times V_{CC}$	—	V	
"L" level input voltage	V_{IL}	—	$1/2 \times V_{CC}$	—	V	
"H" level output voltage	V_{OH}	—	$1/2 \times V_{CC}$	—	V	
"L" level output voltage	V_{OL}	—	$1/2 \times V_{CC}$	—	V	
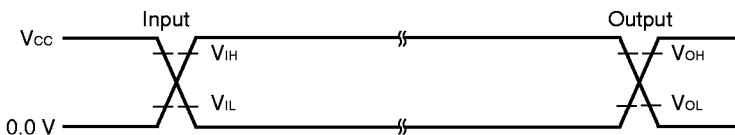
(2) Clock Timing Rating

$(V_{CC5} = 5.0 \text{ V} \pm 10\%, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

$(V_{CC5} = V_{CC3} = 2.7 \text{ V to } 3.6 \text{ V}, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

Parameter	Symbol	Pin name	Condition	Value Min.	Value Max.	Unit	Remarks
Clock frequency	F_C	X0, X1	When using PLL	10	12.5	MHz	
	F_C	X0, X1	Self-oscillation (divide-by-2 input)	10	25	MHz	
	F_C	X0, X1	External clock (divide-by-2 input)	10	25	MHz	
Clock cycle time	t_C	X0, X1	When using PLL	80	100	ns	
	t_C	X0, X1	—	40	100	ns	
Frequency shift ratio (when locked)	Δf	—	When using PLL	—	5	%	*1
Input clock pulse width	P_{WH}, P_{WL}	X0, X1	—	25	—	ns	Input to X0 only, when using 5 V power supply
	P_{WH}, P_{WL}	X0, X1		10	—	ns	Input to X0, X1
Input clock rising/falling time	t_{CR}, t_{CF}	X0, X1	—	—	8	ns	$(t_{CR} + t_{CF})$
Internal operating clock frequency	f_{CP}	—	CPU system	0.625*2	50	MHz	
	f_{CPB}	—	Bus system	0.625*2	25*3	MHz	
	f_{CPP}	—	Peripheral system	0.625*2	25	MHz	
Internal operating clock cycle time	t_{CP}	—	CPU system	20	1600*2	ns	
	t_{CPB}	—	Bus system	40*3	1600*2	ns	
	t_{CPP}	—	Peripheral system	40	1600*2	ns	

*1: Frequency shift ratio stands for deviation ratio of the operating clock from the center frequency in the clock multiplication system.

$$\Delta f = \frac{|\alpha|}{f_0} \times 100 \text{ (\%)}$$

Center frequency f_0
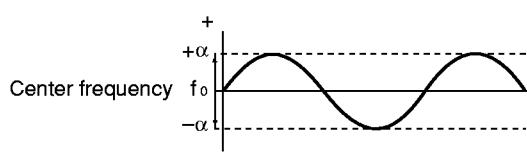
*2: These values are for a minimum clock of 10 MHz input to X0, a divide-by-2 system of the source oscillation and a 1/8 gear.

*3: Values when using the doublure and CPU operation at 50 MHz.

• **Load conditions**

Output pin ○————————┤├ C = 50 pF

• **Clock timing rating measurement conditions**

t_C

0.8 V_{CC}

0.2 V_{CC}

P_{WH} P_{WL} t_{CF} t_{CR}
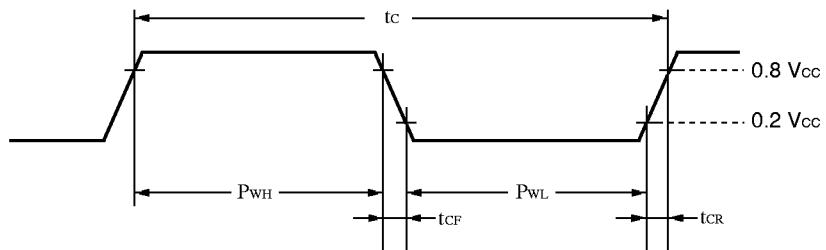
(3) Clock Output Timing

$$(V_{CC}5 = 5.0 \text{ V} \pm 10\%, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$$
$$(V_{CC}5 = V_{CC}3 = 2.7 \text{ V to } 3.6 \text{ V}, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$$

Parameter	Symbol	Pin name	Condition	Value Min.	Value Max.	Unit	Remarks
Cycle time	t_{CYC}	CLK	—	t_{CP}	—	ns	*1
	t_{CYC}	CLK	Using the doublure	t_{CPB}	—	ns	
CLK ↑ → CLK ↓	t_{CHCL}	CLK	—	$1/2 \times t_{CYC} - 10$	$1/2 \times t_{CYC} + 10$	ns	*2
CLK ↓ → CLK ↑	t_{CLCH}	CLK		$1/2 \times t_{CYC} - 10$	$1/2 \times t_{CYC} + 10$	ns	*3

t_{CP}, t_{CPB} (internal operating clock cycle time): Refer to "(2) Clock Timing Rating."

*1: t_{CYC} is a frequency for 1 clock cycle including a gear cycle.
Use the doublure when CPU frequency is above 25 MHz.
*2: Rating at a gear cycle of × 1.
When a gear cycle of 1/2, 1/4, 1/8 is selected, substitute "n" in the following equations with 1/2, 1/4, 1/8, respectively.
Min. : $(1 - n/2) \times t_{CYC} - 10$
Max. : $(1 - n/2) \times t_{CYC} + 10$
Select a gear cycle of × 1 when using the doublure.
*3: Rating at a gear cycle of × 1.
When a gear cycle of 1/2, 1/4, 1/8 is selected, substitute "n" in the following equations with 1/2, 1/4, 1/8, respectively.
Min. : $n/2 \times t_{CYC} - 10$
Max. : $n/2 \times t_{CYC} + 10$
Select a gear cycle of × 1 when using the doublure.
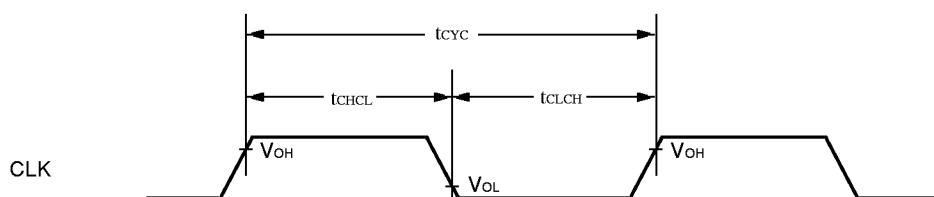
The relation between source oscillation input and CLK pin for configured by CHC/CCK1/CCK0 settings of GCR (gear control register) is as follows:

However, in this chart source oscillation input means X0 input clock.

Source oscillation input
(when using the doublure)

(1) PLL system
(CHC bit of GCR set to "0")

(a) Gear × 1 CLK pin
    CCK1/0: "00"

t_{CYC}

Source oscillation input

(2) 2 dividing system
(CHC bit of GCR set to "1")

(a) Gear × 1 CLK pin
    CCK1/0: "00"

t_{CYC}

(b) Gear × 1/2 CLK pin
    CCK1/0: "01"

t_{CYC}

(c) Gear × 1/4 CLK pin
    CCK1/0: "10"

t_{CYC}

(d) Gear × 1/8 CLK pin
    CCK1/0: "11"

t_{CYC}
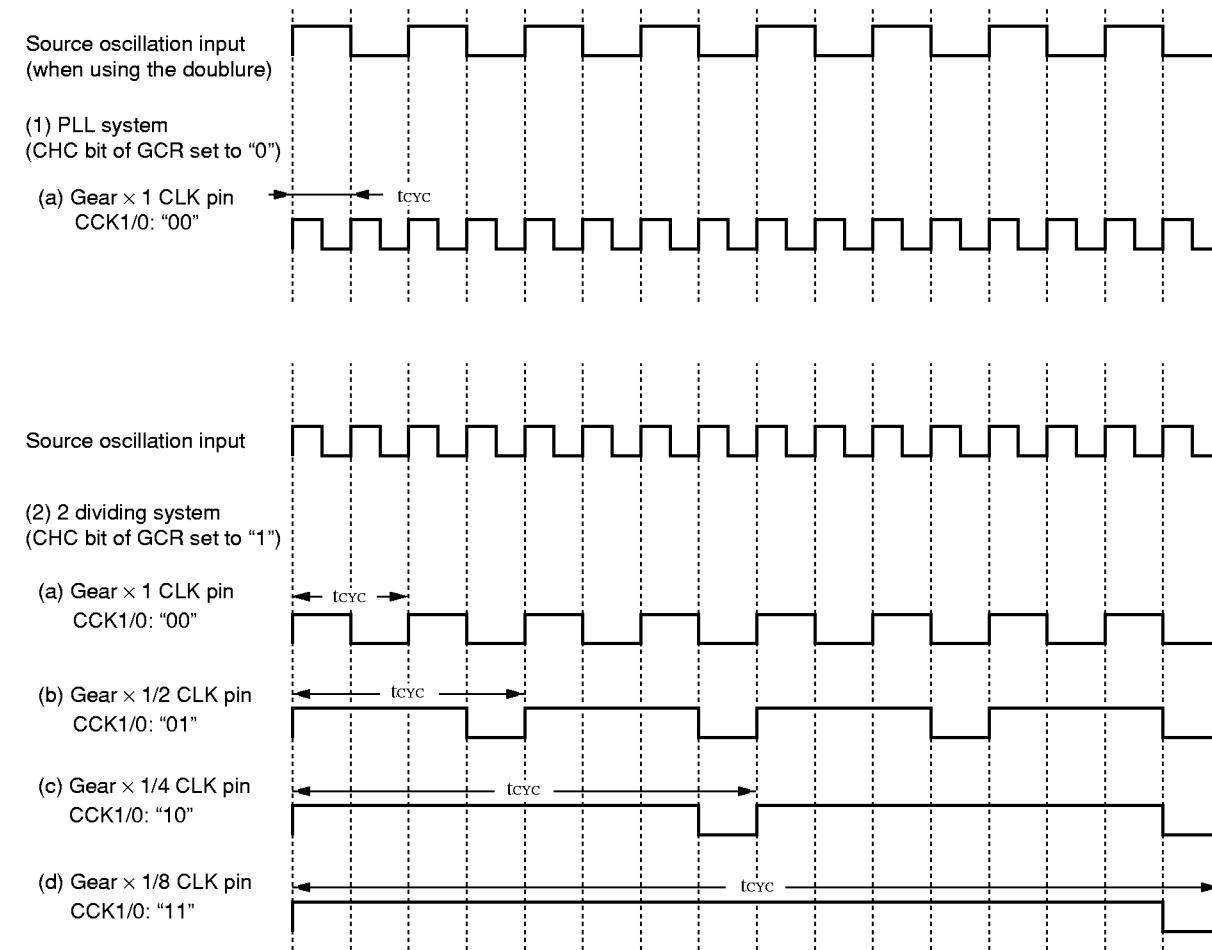
- **Ceramic oscillator applications**

Recommended circuit (2 contacts)
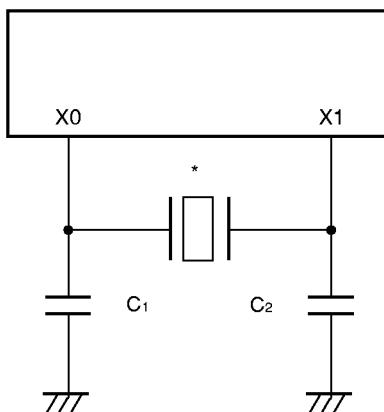
Recommended circuit (3 contacts)

X0   X1

X0   X1

C_1 C_2

C_1 C_2 C_1, C_2 internally connected.
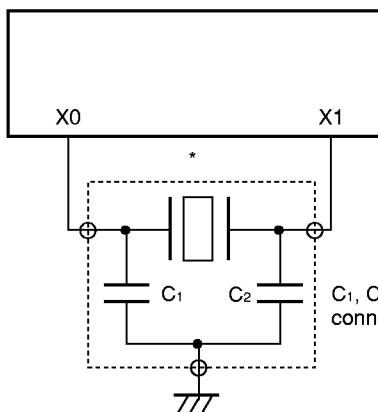
* : Murata Mfg. Co., Ltd.

- **Discreet type**

| Oscillation frequency [MHz]	Model	Load capacitance $C_1 = C_2$ [pF]	Power supply voltage $V_{CC}5$ [V]
5.00 to 6.30	CSA☐☐☐MG	30	2.9 to 5.5
	CST☐☐☐MGW	(30)	
	CSA☐☐☐MG093	30	2.7 to 5.5
	CST☐☐☐MGW093	(30)	
6.31 to 10.0	CSA☐☐☐MTZ	30	2.9 to 5.5
	CST☐☐☐MTW	(30)	
	CSA☐☐☐MTZ093	30	2.7 to 5.5
	CST☐☐☐MTW093	(30)	
10.1 to 13.0	CSA☐☐☐MTZ	30	3.0 to 5.5
	CST☐☐☐MTW	(30)	
	CSA☐☐☐MTZ093	30	2.9 to 5.5
	CST☐☐☐MTW093	(30)	
13.01 to 15.00	CSA☐☐☐MXZ040	15	3.2 to 5.5
	CST☐☐☐MXW0C3	(15)	

( ): C_1 and C_2 internally connected 3 contacts type.

(4) Reset/Hardware Standby Input Ratings

$(V_{CC}5 = 5.0 \text{ V} \pm 10\%, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

$(V_{CC}5 = V_{CC}3 = 2.7 \text{ V to } 3.6 \text{ V}, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Reset input time	t_{RSTL}	$\overline{RST}$	—	$t_{CP} \times 5$	—	ns	
Hardware standby input time	t_{HSTL}	$\overline{HST}$		$t_{CP} \times 5$	—	ns	

t_{CP} (internal operating clock cycle time): Refer to "(2) Clock Timing Rating."
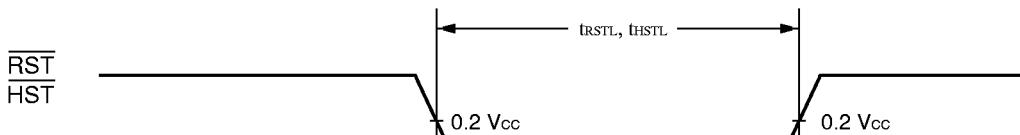
(5) Power on Supply Specifications (Power-on Reset)

$(V_{CC}5 = 5.0 \text{ V} \pm 10\%, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

$(V_{CC}5 = V_{CC}3 = 2.7 \text{ V to } 3.6 \text{ V}, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Power supply rising time	t_R	V_{CC}	$V_{CC} = 5.0 \text{ V}$	50	—	μs	*
	t_R	V_{CC}		—	30	ms	*
	t_R	V_{CC}	$V_{CC} = 3.0/$ 3.3 V	50	—	μs	*
	t_R	V_{CC}		—	18	ms	*
Power supply shut off time	t_{OFF}	V_{CC}	—	1	—	ms	Repeated operations
Oscillation stabilizing time	t_{OSC}	—		$2 \times t_C \times 2^{21}$ $+ 100 \text{ μs}$	—	ns	

t_C (clock cycle time): Refer to "(2) Clock Timing Rating."

* : $V_{CC} < 0.2 \text{ V}$ before the power supply rising
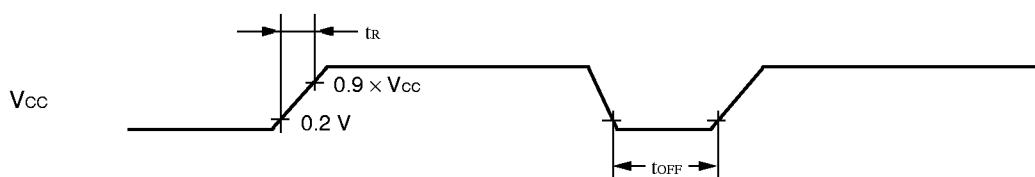
Note: Sudden change in supply voltage during operation may initiate a power-on sequence.
To change supply voltage during operation, it is recommended to smoothly raise the voltage to avoid rapid fluctuations in the supply voltage.

A voltage rising rate of 50 mV/ms or less is recommended.

42 ms approx. 336 ms approx. (@12.5 MHz)
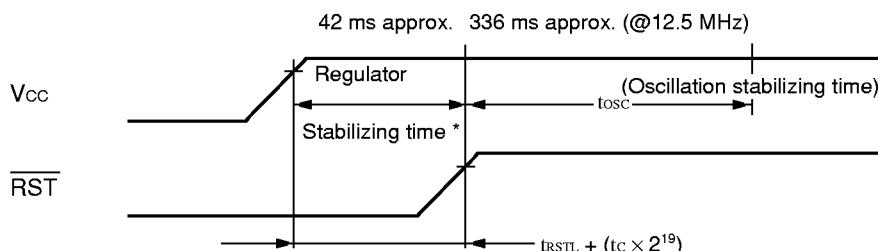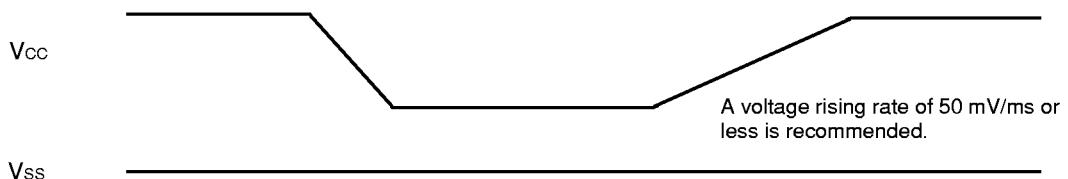
t_{RSTL}: Reset input time

*: Reset can't be done during regulator stabilizing time.

Note: Set $\overline{RST}$ pin to "L" level when turning on the device, at least the described above duration after the supply voltage reaches Vcc is necessary before turning the $\overline{RST}$ to "H" level.

(6) Normal Bus Access Read/write Operation

$(V_{CC}5 = 5.0\ V \pm 10\%,\ V_{SS} = AV_{SS} = 0.0\ V,\ T_A = 0°C\ to\ +70°C)$

$(V_{CC}5 = V_{CC}3 = 2.7\ V\ to\ 3.6\ V,\ V_{SS} = AV_{SS} = 0.0\ V,\ T_A = 0°C\ to\ +70°C)$

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
$\overline{CS0}$ to $\overline{CS5}$ delay time	t$_{CHCSL}$	CLK, $\overline{CS0}$ to $\overline{CS5}$		—	15	ns	
	t$_{CHCSH}$	CLK, $\overline{CS0}$ to $\overline{CS5}$		—	15	ns	
Address delay time	t$_{CHAV}$	CLK, A24 to A00		—	15	ns	
Data delay time	t$_{CHDV}$	CLK, D31 to D16		—	15	ns	
$\overline{RD}$ delay time	t$_{CLRL}$	CLK, $\overline{RD}$		—	6	ns	
	t$_{CLRH}$	CLK, $\overline{RD}$		—	6	ns	
$\overline{WR0}$, $\overline{WR1}$ delay time	t$_{CLWL}$	CLK, $\overline{WR0}$, $\overline{WR1}$	—	—	6	ns	
	t$_{CLWH}$	CLK, $\overline{WR0}$, $\overline{WR1}$		—	6	ns	
Valid address → valid data input time	t$_{AVDV}$	A24 to A00, D31 to D16		—	$3/2 \times t_{CYC}$ -25	ns	*1 *2
$\overline{RD}$ ↓→ valid data input time	t$_{RLDV}$	$\overline{RD}$, D31 to D16		—	$t_{CYC} - 10$	ns	*1
Data set up → $\overline{RD}$ ↑ time	t$_{DSRH}$	$\overline{RD}$, D31 to D16		10	—	ns	
$\overline{RD}$ ↑→ data hold time	t$_{RHDX}$	$\overline{RD}$, D31 to D16		0	—	ns	

t_{CYC} (a cycle time of peripheral system clock): Refer to "(3) Clock Output Timing."

*1: When bus timing is delayed by automatic wait insertion or RDY input, add (t_{CYC} × extended cycle number for delay) to this rating.

*2: Rating at a gear cycle of × 1.
When a gear cycle of 1/2, 1/4, 1/8 is selected, substitute "n" in the following equation with 1/2, 1/4, 1/8, respectively.
Equation: $(2 - n/2) \times t_{CYC} - 25$
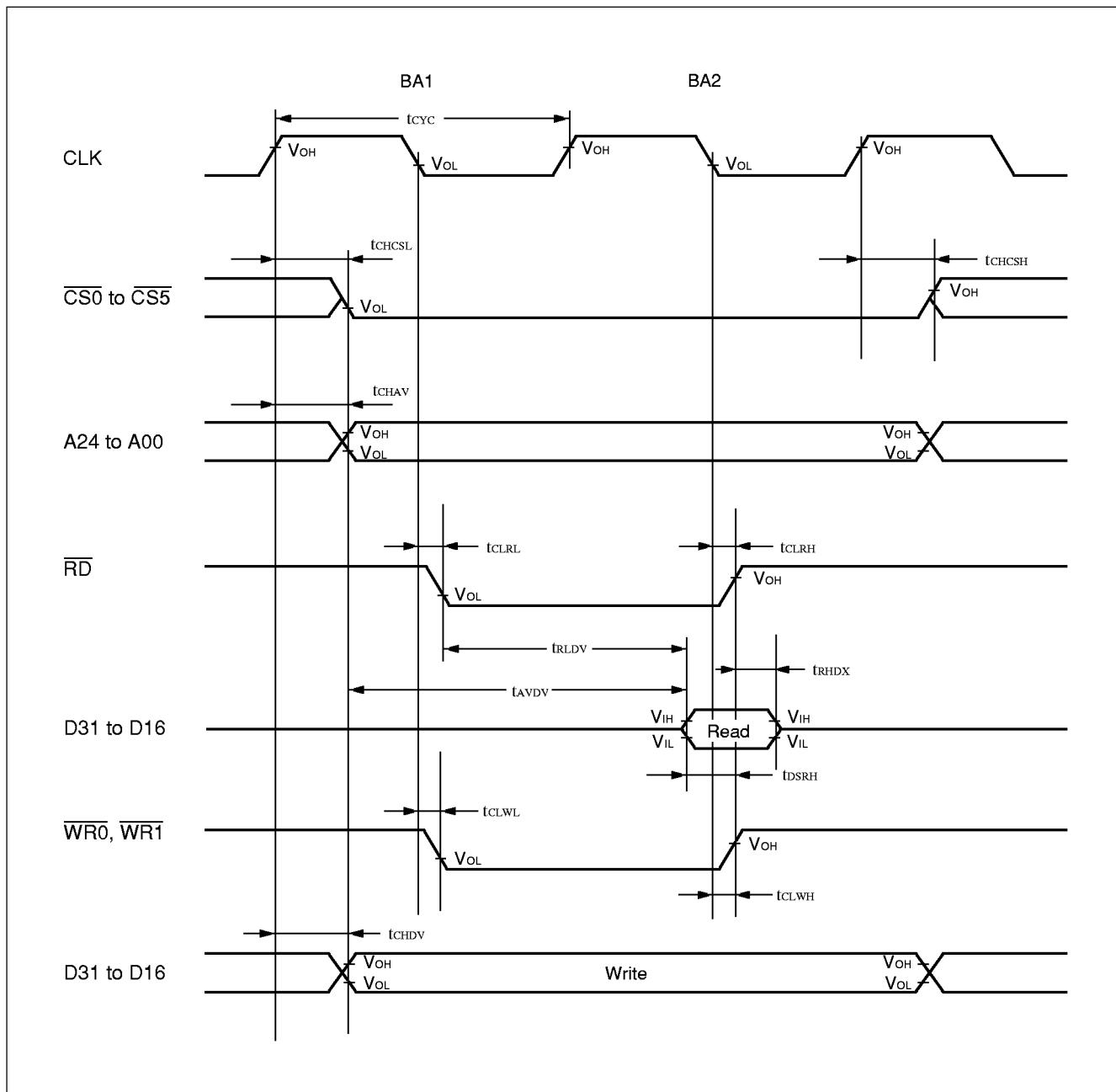
(7) Ready Input Timing

$(V_{CC}5 = 5.0\ V \pm 10\%, V_{SS} = AV_{SS} = 0.0\ V, T_A = 0°C\ to +70°C)$

$(V_{CC}5 = V_{CC}3 = 2.7\ V\ to\ 3.6\ V, V_{SS} = AV_{SS} = 0.0\ V, T_A = 0°C\ to +70°C)$

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
RDY set up time → CLK ↓	t_{RDYS}	RDY, CLK	—	15	—	ns	
CLK ↓ → RDY hold time	t_{RDYH}	CLK, RDY		0	—	ns	
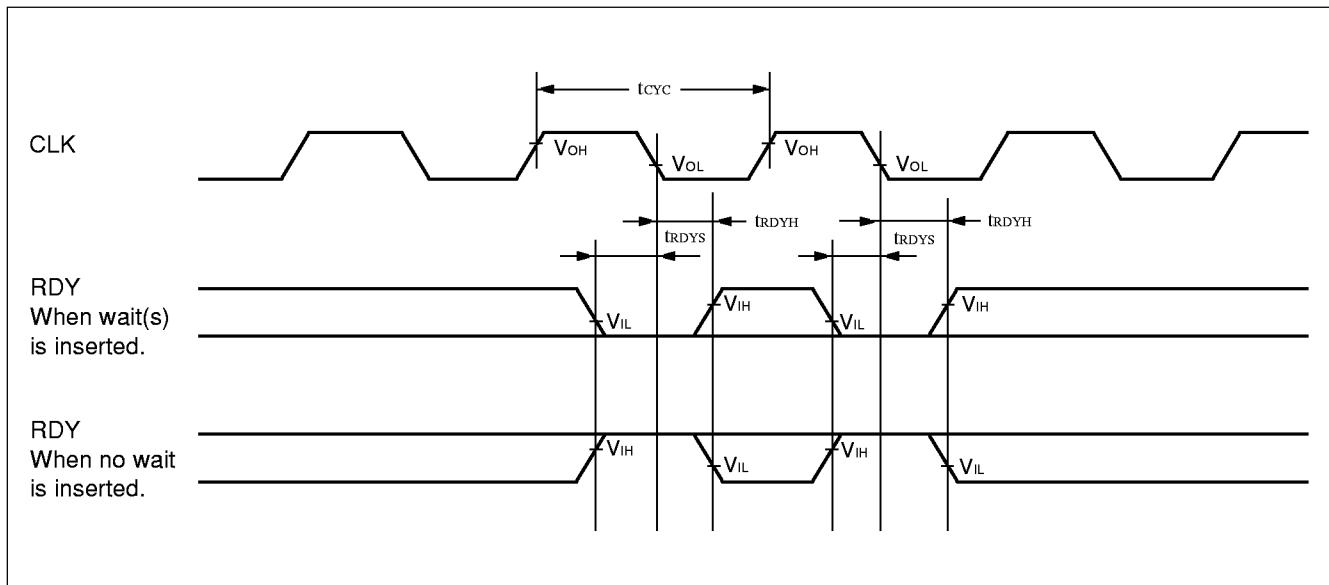
(8) Hold Timing

$(Vcc5 = 5.0 \text{ V} \pm 10\%, Vss = AVss = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

$(Vcc5 = Vcc3 = 2.7 \text{ V to } 3.6 \text{ V}, Vss = AVss = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
$\overline{BGRNT}$ delay time	t_{CHBGL}	CLK, $\overline{BGRNT}$	—	—	6	ns	
	t_{CHBGH}	CLK, $\overline{BGRNT}$		—	6	ns	
Pin floating → $\overline{BGRNT}$ ↓ time	t_{XHAL}	$\overline{BGRNT}$		$t_{CYC} - 10$	$t_{CYC} + 10$	ns	
$\overline{BGRNT}$ ↑→ pin valid time	t_{HAHV}	$\overline{BGRNT}$		$t_{CYC} - 10$	$t_{CYC} + 10$	ns	

t_{CYC} (a cycle time of peripheral system clock): Refer to "(3) Clock Output Timing."

Note: There is a delay time of more than 1 cycle from BRQ input to $\overline{BGRNT}$ change.
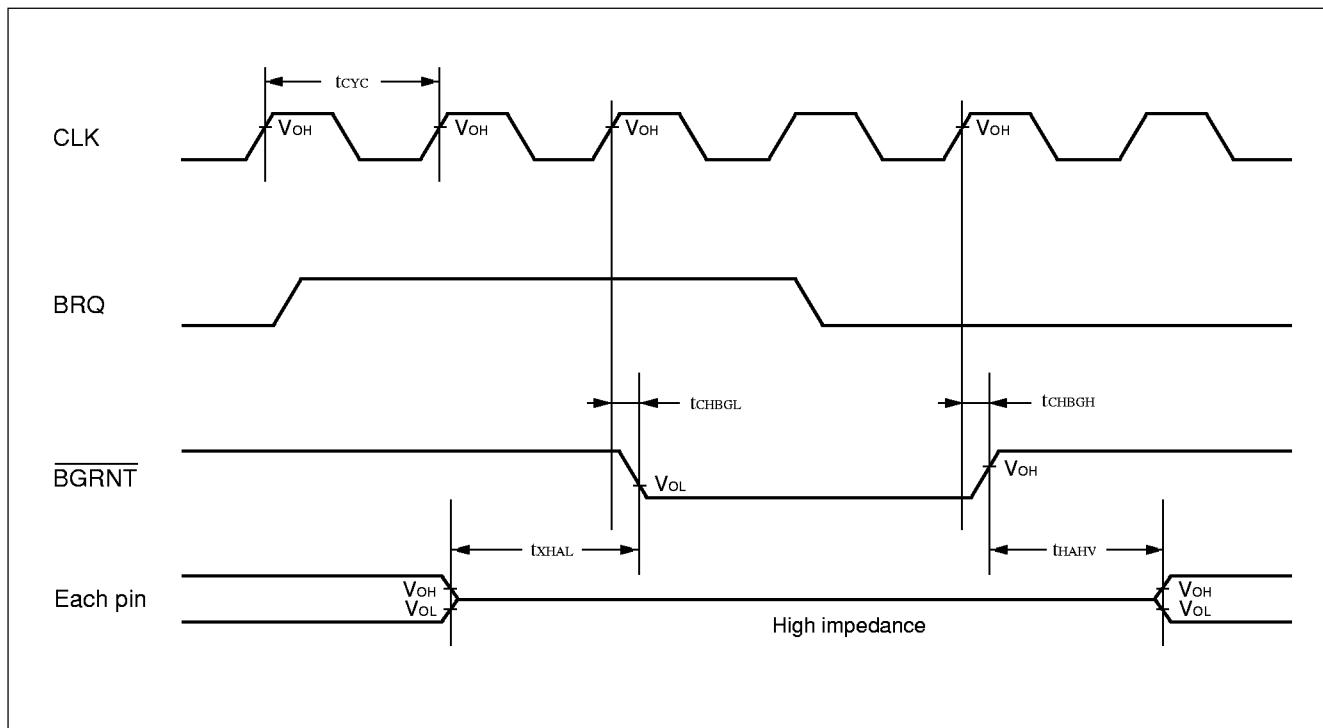
(9) Normal DRAM Mode Read/Write Cycle

(Vcc5 = 5.0 V ±10%, Vss = AVss = 0.0 V, TA = 0°C to +70°C)

(Vcc5 = Vcc3 = 2.7 V to 3.6 V, Vss = AVss = 0.0 V, TA = 0°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value Min.	Value Max.	Unit	Remarks
RAS delay time	t_{CLRAH}	CLK, RAS		—	6	ns	
	t_{CHRAL}	CLK, RAS		—	6	ns	
CAS delay time	t_{CLCASL}	CLK, CAS		—	6	ns	
	t_{CLCASH}	CLK, CAS		—	6	ns	
ROW address delay time	t_{CHRAV}	CLK, A24 to A00		—	15	ns	
COLUMN address delay time	t_{CHCAV}	CLK, A24 to A00		—	15	ns	
$\overline{DW}$ delay time	t_{CHDWL}	CLK, $\overline{DW}$	—	—	15	ns	
	t_{CHDWH}	CLK, $\overline{DW}$		—	15	ns	
Output data delay time	t_{CHDV1}	CLK, D31 to D16		—	15	ns	
RAS ↓→ valid data input time	t_{RLDV}	RAS, D31 to D16		—	$5/2 \times t_{CYC} - 16$	ns	*1 *2
CAS ↓→ valid data input time	t_{CLDV}	CAS, D31 to D16		—	$t_{CYC} - 17$	ns	*1
CAS ↑→ data hold time	t_{CADH}	CAS, D31 to D16		0	—	ns	

t_{CYC} (a cycle time of peripheral system clock): Refer to "(3) Clock Output Timing."

CAS: CS0L to CS1H pins are for CAS signal outputs.
$\overline{DW}$: $\overline{DW0}$, $\overline{DW1}$ and CS0H to CS1H are used for $\overline{WE}$ outputs.

*1: When Q1 cycle or Q4 cycle is extended for 1 cycle, add t_{CYC} time to this rating.
*2: Rating at a gear cycle of × 1.
When a gear cycle of 1/2, 1/4, 1/8 is selected, substitute "n" in the following equation with 1/2, 1/4, 1/8, respectively.
Equation: $(3 - n/2) \times t_{CYC} - 16$
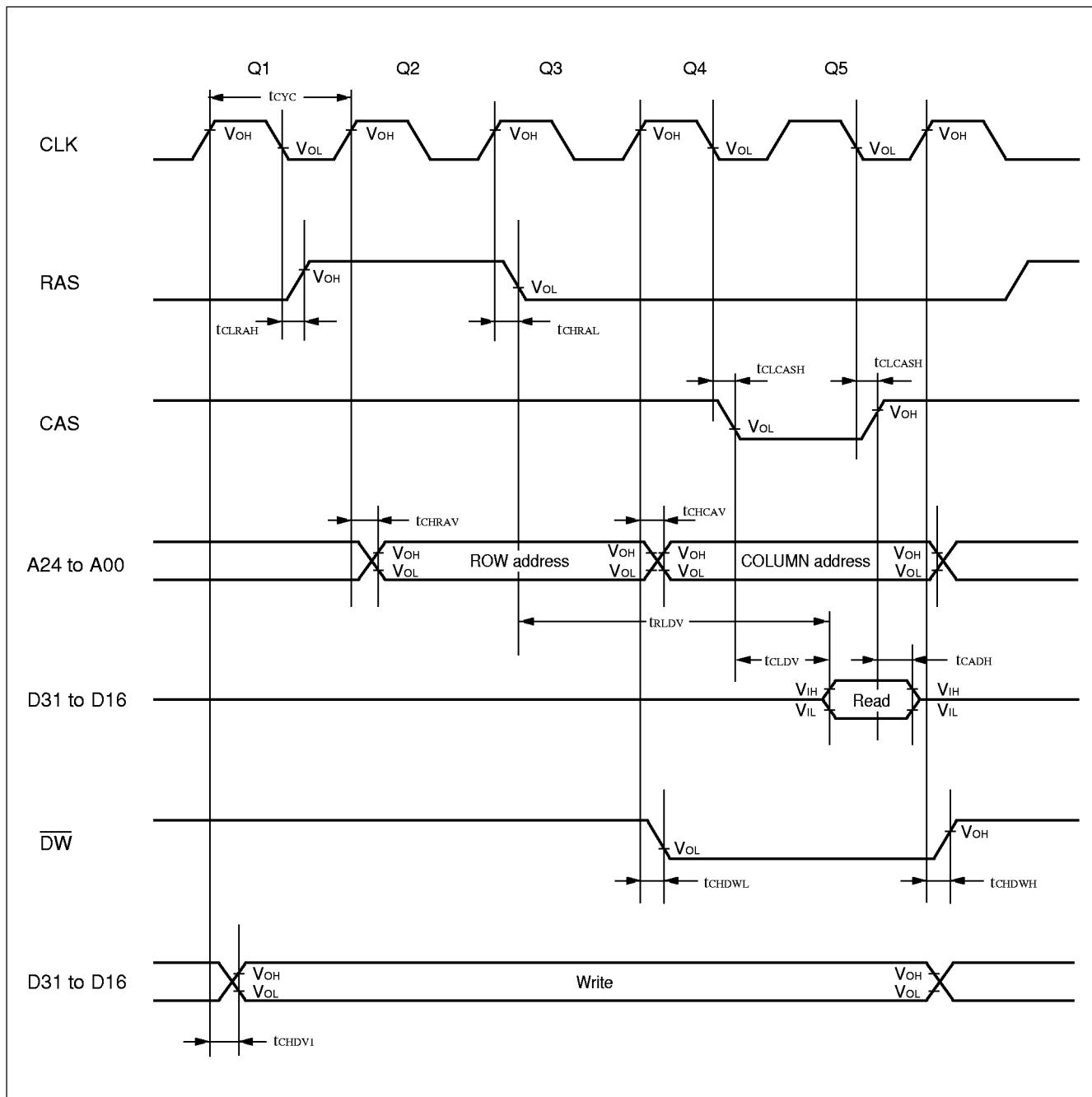
(10) Normal DRAM Mode Fast Page Read/Write Cycle

$(V_{CC}5 = 5.0 \text{ V} \pm 10\%, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

$(V_{CC}5 = V_{CC}3 = 2.7 \text{ V to } 3.6 \text{ V}, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
RAS delay time	t_{CLRAH}	CLK, RAS		—	6	ns	
CAS delay time	t_{CLCASL}	CLK, CAS		—	6	ns	
	t_{CLCASH}	CLK, CAS		—	6	ns	
COLUMN address delay time	t_{CHCAV}	CLK, A24 to A00		—	15	ns	
$\overline{DW}$ delay time	t_{CHDWH}	CLK, $\overline{DW}$	—	—	15	ns	
Output data delay time	t_{CHDV1}	CLK, D31 to D16		—	15	ns	
CAS $\downarrow\rightarrow$ valid data input time	t_{CLDV}	CAS, D31 to D16		—	$t_{CYC} - 17$	ns	*
CAS $\uparrow\rightarrow$ data hold time	t_{CADH}	CAS, D31 to D16		0	—	ns	

t_{CYC} (a cycle time of peripheral system clock): Refer to "(3) Clock Output Timing."

CAS: CS0L to CS1H pins are for CAS signal outputs.
$\overline{DW}$: $\overline{DW0}$, $\overline{DW1}$ and CS0H to CS1H are used for $\overline{WE}$ outputs.

* : When Q4 cycle is extended for 1 cycle, add t_{CYC} time to this rating.
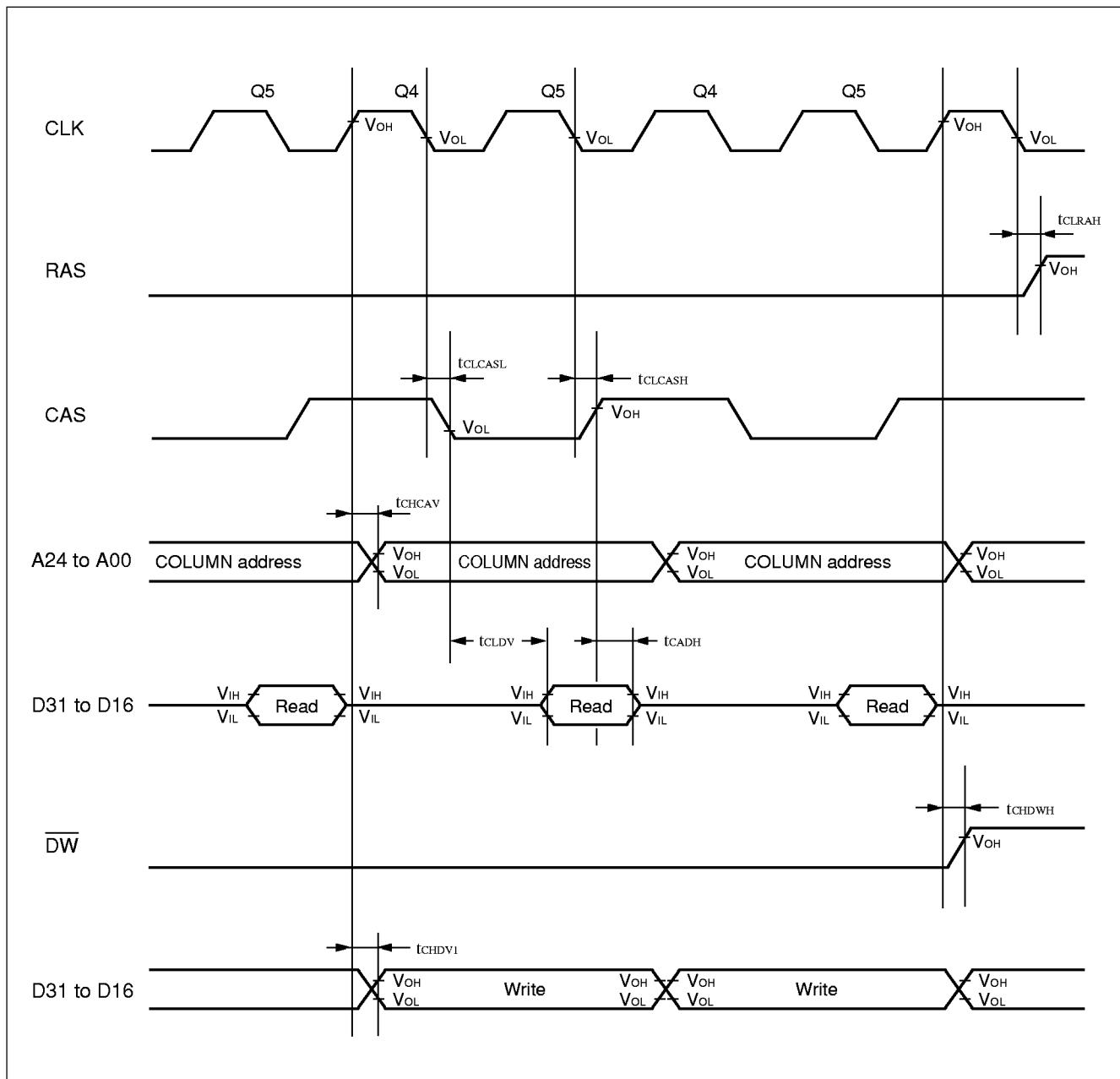
(11) Single DRAM Timing

$$(V_{CC}5 = 5.0 \text{ V} \pm 10\%, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$$
$$(V_{CC}5 = V_{CC}3 = 2.7 \text{ V to } 3.6 \text{ V}, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$$

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
RAS delay time	t_{CLRAH2}	CLK, RAS		—	6	ns	
	t_{CHRAL2}	CLK, RAS			6	ns	
CAS delay time	$t_{CHCASL2}$	CLK, CAS		—	$n/2 \times t_{CYC}$	ns	
	$t_{CHCASH2}$	CLK, CAS		—	6	ns	
ROW address delay time	t_{CHRAV2}	CLK, A24 to A00		—	15	ns	
COLUMN address delay time	t_{CHCAV2}	CLK, A24 to A00	—	—	15	ns	
DW delay time	t_{CHDWL2}	CLK, DW		—	15	ns	
	t_{CHDWH2}	CLK, DW		—	15	ns	
Output data delay time	t_{CHDV2}	CLK, D31 to D16		—	15	ns	
CAS ↓→ Valid data input time	t_{CLDV2}	CAS, D31 to D16		—	$(1 - n/2) \times t_{CYC} - 17$	ns	
CAS ↑→ data hold time	t_{CADH2}	CLK, D31 to D16		0	—	ns	

t_{CYC} (a cycle time of peripheral system clock): Refer to "(3) Clock Output Timing."

*1: Q4S indicates Q4SR (Read) of Single DRAM cycle or Q4SW (Write) cycle.
*2: ____ indicates the timing when the bus cycle begins from the high spead page mode.
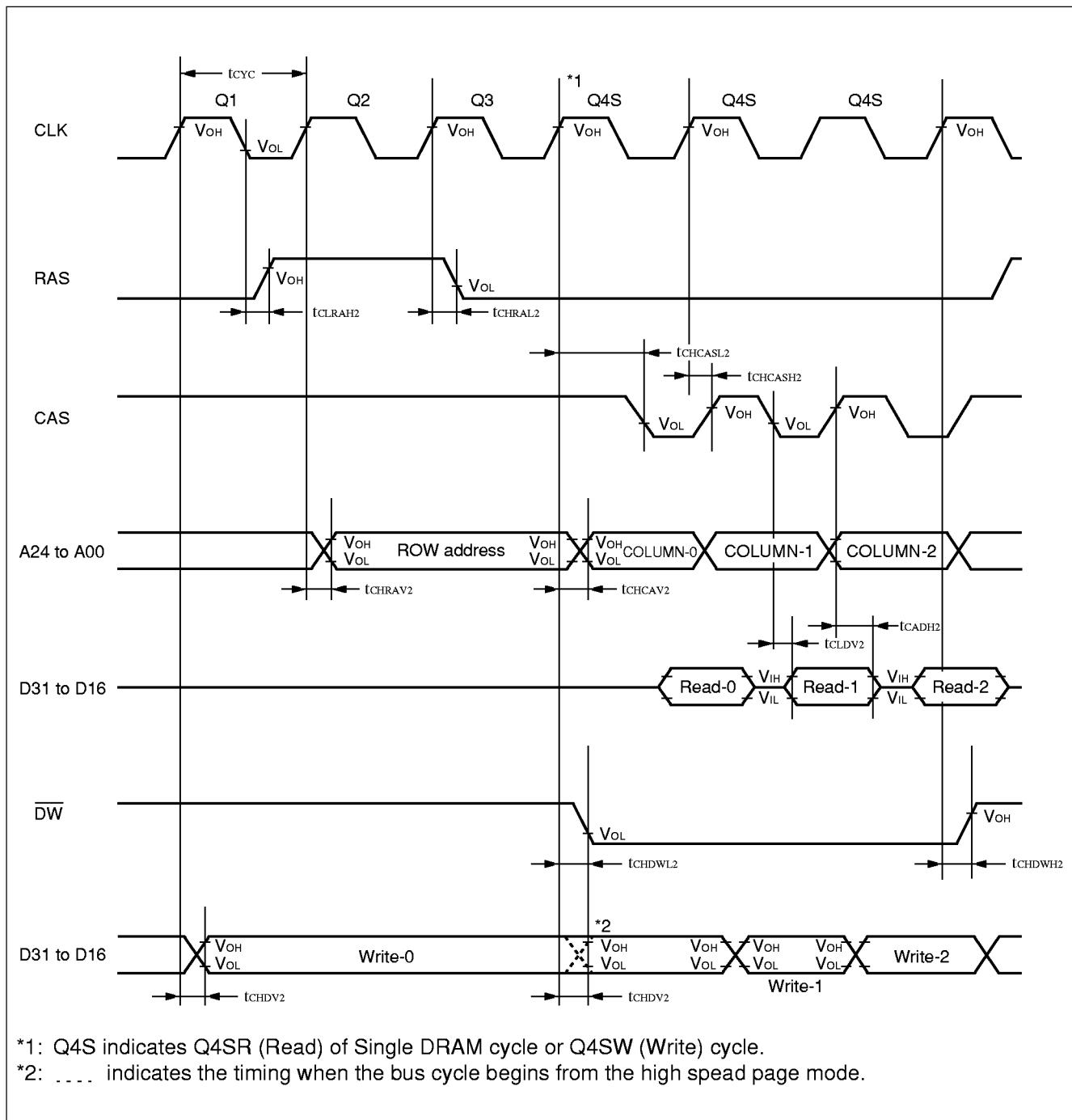
(12) Hyper DRAM Timing

$(Vcc5 = 5.0 \text{ V} \pm 10\%, Vss = AVss = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

$(Vcc5 = Vcc3 = 2.7 \text{ V to } 3.6 \text{ V}, Vss = AVss = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
RAS delay time	t_{CLRAH3}	CLK, RAS		—	6	ns	
	t_{CHRAL3}	CLK, RAS		—	6	ns	
CAS delay time	$t_{CHCASL3}$	CLK, CAS		—	$n/2 \times t_{CYC}$	ns	
	$t_{CHCASH3}$	CLK, CAS		—	6	ns	
ROW address delay time	t_{CHRAV3}	CLK, A24 to A00		—	15	ns	
COLUMN address delay time	t_{CHCAV3}	CLK, A24 to A00		—	15	ns	
RD delay time	t_{CHRL3}	CLK, RD	—	—	15	ns	
	t_{CHRH3}	CLK, RD		—	15	ns	
	t_{CLRL3}	CLK, RD		—	15	ns	
DW delay time	t_{CHDWL3}	CLK, DW		—	15	ns	
	t_{CHDWH3}	CLK, DW		—	15	ns	
Output data delay time	t_{CHDV3}	CLK, D31 to D16		—	15	ns	
CAS ↓→ valid data input time	t_{CLDV3}	CAS, D31 to D16		—	$t_{CYC} - 17$	ns	
CAS ↓→ data hold time	t_{CADH3}	CLK, D31 to D16		0	—	ns	

t_{CYC} (a cycle time of peripheral system clock): Refer to "(3) Clock Output Timing."

*1: Q4S indicates Q4SR (Read) of Single DRAM cycle or Q4SW (Write) cycle.
*2: ---- indicates the timing when the bus cycle begins from the high spead page mode.

(13) CBR Refresh

(Vcc5 = 5.0 V ±10%, Vss = AVss = 0.0 V, TA = 0°C to +70°C)

(Vcc5 = Vcc3 = 2.7 V to 3.6 V, Vss = AVss = 0.0 V, TA = 0°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
RAS delay time	t_{CLRAH}	CLK, RAS	—	—	6	ns	
	t_{CHRAL}	CLK, RAS		—	6	ns	
CAS delay time	t_{CLCASL}	CLK, CAS		—	6	ns	
	t_{CLCASH}	CLK, CAS		—	6	ns	

CAS: CS0L to CS1H pins are for CAS signal outputs.

(14) Self Refresh

$(V_{CC5} = 5.0 \text{ V} \pm 10\%, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

$(V_{CC5} = V_{CC3} = 2.7 \text{ V to } 3.6 \text{ V}, V_{SS} = AV_{SS} = 0.0 \text{ V}, T_A = 0°C \text{ to } +70°C)$

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
RAS delay time	t_{CLRAH}	CLK, RAS		—	6	ns	
	t_{CHRAL}	CLK, RAS	—	—	6	ns	
CAS delay time	t_{CLCASL}	CLK, CAS		—	6	ns	
	t_{CLCASH}	CLK, CAS		—	6	ns	

CAS: CS0L to CS1H pins are for CAS signal outputs.

(15) UART Timing

$(V_{CC}5 = 5.0\ V \pm 10\%,\ V_{SS} = AV_{SS} = 0.0\ V,\ T_A = 0°C\ to\ +70°C)$

$(V_{CC}5 = V_{CC}3 = 2.7\ V\ to\ 3.6\ V,\ V_{SS} = AV_{SS} = 0.0\ V,\ T_A = 0°C\ to\ +70°C)$

Parameter	Symbol	Pin name	Condition	Value Min.	Value Max.	Unit	Remarks
Serial clock cycle time	t_{SCYC}	—	Internal shift clock mode	$8 \times t_{CYCP}$	—	ns	
SCLK ↓→ SOUT delay time	t_{SLOV}	—		−80	80	ns	
Valid SIN → SCLK ↑	t_{IVSH}	—		100	—	ns	
SCLK ↑→ valid SIN hold time	t_{SHIX}	—		60	—	ns	
Serial clock "H" pulse width	t_{SHSL}	—	External shift clock mode	$4 \times t_{CYCP}$	—	ns	
Serial clock "L" pulse width	t_{SLSH}	—		$4 \times t_{CYCP}$	—	ns	
SCLK ↓→ SOUT delay time	t_{SLOV}	—		—	150	ns	
Valid SIN → SCLK ↑	t_{IVSH}	—		60	—	ns	
SCLK ↑→ valid SIN hold time	t_{SHIX}	—		60	—	ns	

t_{CYCP}: A cycle time of peripheral system clock

Notes: This rating is for AC characteristics in CLK synchronous mode.

• **Internal shift clock mode**
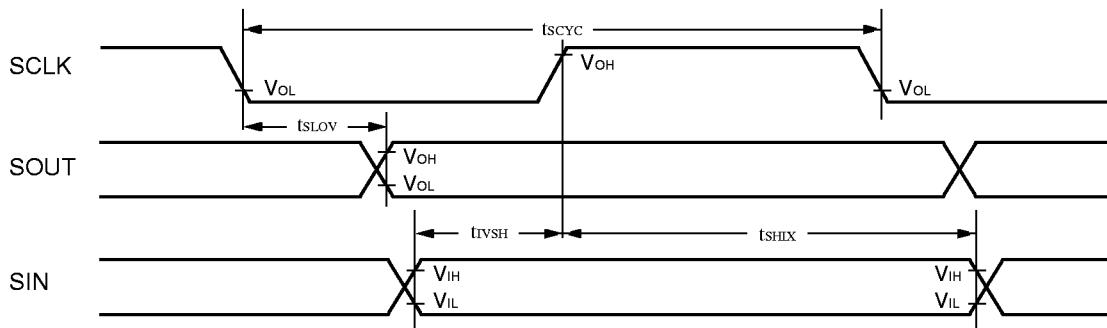
• **External shift clock mode**
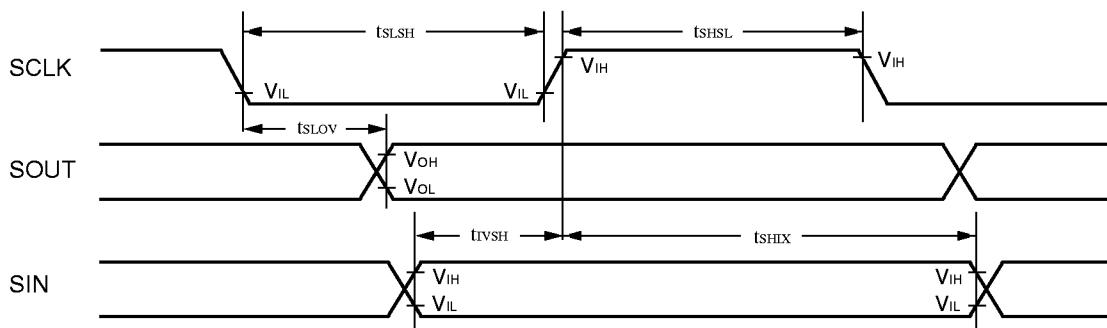
(16) Trigger System Input Timing

$$(V_{CC}5 = 5.0\ V \pm 10\%,\ V_{SS} = AV_{SS} = 0.0\ V,\ T_A = 0°C\ to\ +70°C)$$
$$(V_{CC}5 = V_{CC}3 = 2.7\ V\ to\ 3.6\ V,\ V_{SS} = AV_{SS} = 0.0\ V,\ T_A = 0°C\ to\ +70°C)$$

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
A/D start trigger input time	t_{TRGH}, t_{TRGL}	$\overline{ATG}$		$5 \times t_{CYCP}$	—	ns	
PWM external trigger input time	t_{TRGH}, t_{TRGL}	TRG0 to TRG3	—	$5 \times t_{CYCP}$	—	ns	
External interrupt input time	t_{INT}	INT0 to INT3		$5 \times t_{CYCP}$	—	ns	

t_{CYCP}: A cycle time of peripheral system clock
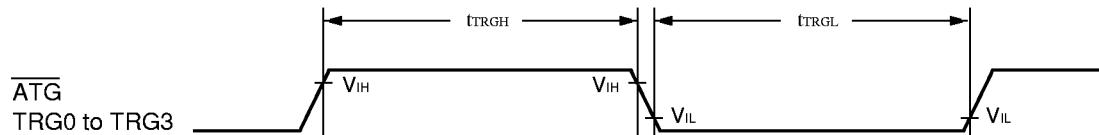
(17) DMA Controller Timing

(Vcc5 = 5.0 V ±10%, Vss = AVss = 0.0 V, TA = 0°C to +70°C)

(Vcc5 = Vcc3 = 2.7 V to 3.6 V, Vss = AVss = 0.0 V, TA = 0°C to +70°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
DREQ input pulse width	t_{DRWH}	DREQ0 to DREQ2		$2 \times t_{CYC}$	—	ns	
DACK delay time (Normal bus) (Normal DRAM)	t_{CLDL}	CLK, DACK0 to DACK2		—	6	ns	
	t_{CLDH}	CLK, DACK0 to DACK2		—	6	ns	
EOP delay time (Normal bus) (Normal DRAM)	t_{CLEL}	CLK, EOP0 to EOP2		—	6	ns	
	t_{CLEH}	CLK, EOP0 to EOP2	—	—	6	ns	
DACK delay time (Single DRAM) (Hyper DRAM)	t_{CHDL}	CLK, DACK0 to DACK2		—	$n/2 \times t_{CYC}$	ns	
	t_{CHDH}	CLK, DACK0 to DACK2		—	6	ns	
EOP delay time (Single DRAM) (Hyper DRAM)	t_{CHEL}	CLK, EOP0 to EOP2		—	$n/2 \times t_{CYC}$	ns	
	t_{CHEH}	CLK, EOP0 to EOP2		—	6	ns	

t_{CYC} (a cycle time of peripheral system clock): Refer to "(3) Clock Output Timing."
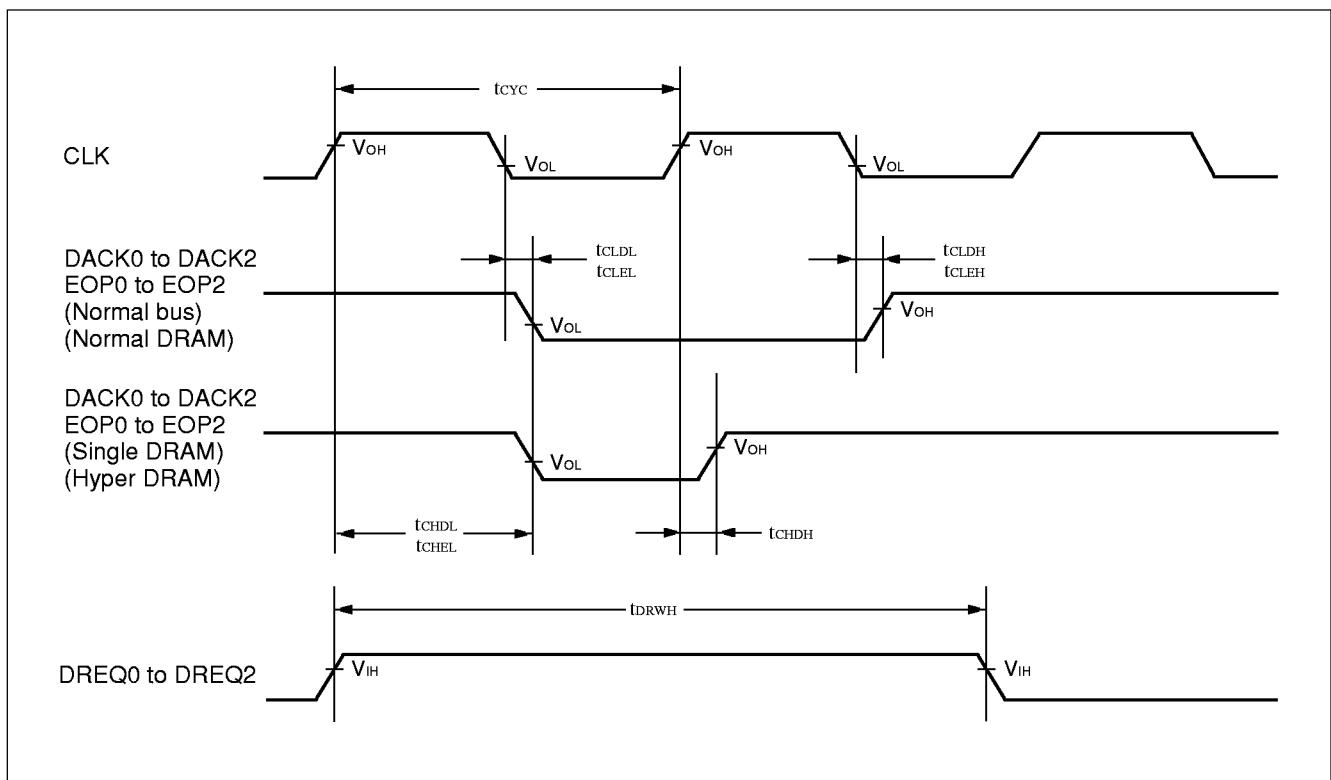
5. A/D Converter Block Electrical Characteristics

(AV$_{CC}$ = 2.7 V to 3.6 V, AV$_{SS}$ = 0.0 V, AVRH = 2.7 V, T$_A$ = 0°C to +70°C)

Parameter	Symbol	Pin name	Value			Unit
			Min.	Typ.	Max.	
Resolution	—	—	—	10	10	bit
Total error	—	—	—	—	±4.0	LSB
Linearity error	—	—	—	—	±3.5	LSB
Differentiation linearity error	—	—	—	—	±2.0	LSB
Zero transition voltage	V$_{OT}$	AN0 to AN3	−1.5	+0.5	+2.5	LSB
Full-scale transition voltage	V$_{FST}$	AN0 to AN3	AVRH − 4.5	AVRH − 1.5	AVRH + 0.5	LSB
Conversion time	—	—	5.6 *1	—	—	μs
Analog port input current	I$_{AIN}$	AN0 to AN3	—	0.1	10	μA
Analog input voltage	V$_{AIN}$	AN0 to AN3	AV$_{SS}$	—	AVRH	V
Reference voltage	—	AVRH	AV$_{SS}$	—	AV$_{CC}$	V
Power supply current	I$_A$	AV$_{CC}$	—	4	—	mA
	I$_{AH}$	AV$_{CC}$	—	—	5 *2	μA
Reference voltage supply current	I$_R$	AVRH	—	200	—	μA
	I$_{RH}$	AVRH	—	—	5 *2	μA
Conversion variance between channels	—	AN0 to AN3	—	—	4	LSB

*1: AV$_{CC}$ = 2.7 V − 3.6 V
*2: Current value for A/D converters not in operation, CPU stop mode (V$_{CC}$ = AV$_{CC}$ = AVRH = 3.6 V)

Notes: • As the absolute value of AVRH decreases, relative error increases.
     • Output impedance of external circuit of analog input under following conditions;
      Output impedance of external circuit < 10 kΩ.
      If output impedance of external circuit is too high, analog voltage sampling time may be too short for accurate sampling (sampling time is 5.6 μs for a machine clock of 25 MHz).

6. A/D Converter Glossary

- Resolution
  The smallest change in analog voltage detected by A/D converter.
- Linearity error
  A deviation of actual conversion characteristic from a line connecting the zero-traction point (between "00 0000 0000" ↔ "00 0000 0001") to the full-scale transition point (between "11 1111 1110" ↔ "11 1111 1111").
- Differential linearity error
  A deviation of a step voltage for changing the LSB of output code from ideal input voltage.
- Total error
  A difference between actual value and theoretical value. The overall error includes zero-transition error, full-scale transition error and linearity error.

Total error

Digital output

3FF
3FE

Actual conversion
characteristic

3FD

$\{1 \text{ LSB'} \times (N-1) + 0.5 \text{ LSB'}\}$

1.5 LSB'

004
003

V_{NT}
(measured value)

Actual conversion
characteristic

002

Ideal characteristic

001
0.5 LSB'

AVRL   AVRH

Analog input
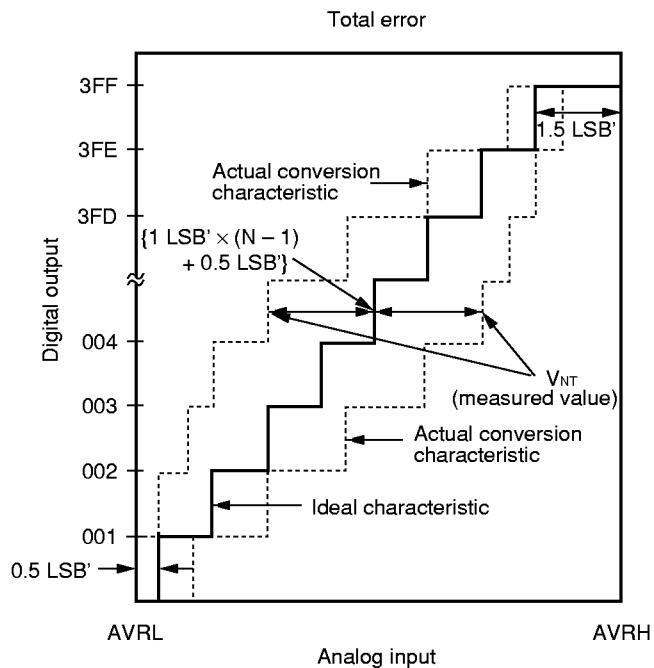
Total error of digital output N $= \dfrac{V_{NT} - \{1 \text{ LSB'} \times (N-1) + 0.5 \text{ LSB'}\}}{1 \text{ LSB'}}$ [LSB]

V_{OT}' (ideal value) $=$ AVRL + 0.5 LSB' [V]

V_{FST}' (ideal value) $=$ AVRL + 1.5 LSB' [V]

V_{NT}: A voltage for causing transition of digital output from $(N-1)$ to N

(Continued)

(Continued)

Linearity error

Differential linearity error
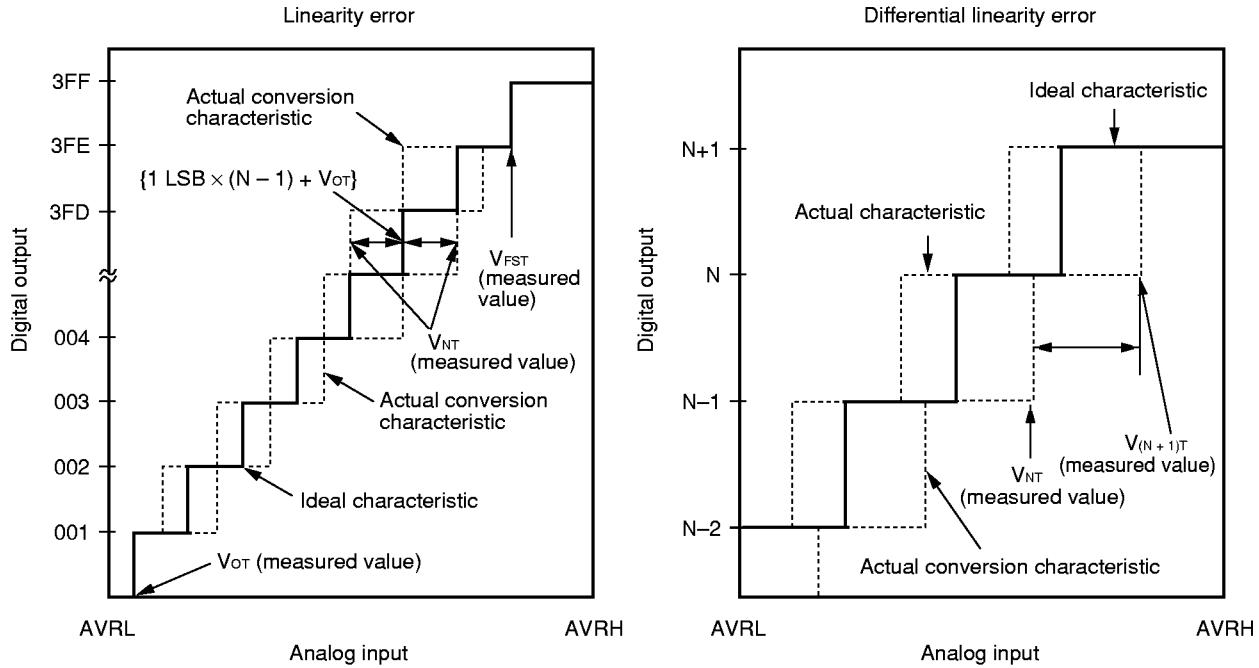
$$\text{Linearity error of digital output N} = \frac{V_{NT} - \{1\ LSB' \times (N-1) + V_{OT}\}}{1\ LSB}\ [LSB]$$

$$\text{Differential linearity error of digital output N} = \frac{V_{(N+1)T} - V_{NT}}{1\ LSB} - 1\ [LSB]$$

$$1\ LSB = \frac{V_{FST} - V_{OT}}{1022}\ [V]$$

$$1\ LSB'\ (\text{ideal value}) = \frac{AVRH - AVRL}{1024}\ [V]$$

V_{OT}: A voltage for causing transition of digital output from $(000)_H$ to $(001)_H$

V_{FST}: A voltage for causing transition of digital output from $(3FE)_H$ to $(3FF)_H$

V_{NT}: A voltage for causing transition of digital output from $(N-1)_H$ to N

■ INSTRUCTIONS (165 INSTRUCTIONS)

1. How to Read Instruction Set Summary

Mnemonic	Type	OP	CYC	NZVC	Operation	Remarks
ADD Rj, Ri	A	A6	1	CCCC	Ri + Rj → Ri	
* ADD #s5, Ri	C	A4	1	CCCC	Ri + s5 → Ri	
,	,	,	,	,	,	
,	,	,	,	,	,	

    ↓   ↓   ↓   ↓   ↓   ↓   ↓

    (1)   (2)   (3)   (4)   (5)   (6)   (7)

(1) Names of instructions
Instructions marked with * are not included in CPU specifications. These are extended instruction codes added/extended at assembly language levels.

(2) Addressing modes specified as operands are listed in symbols.
Refer to "2. Addressing mode symbols" for further information.

(3) Instruction types

(4) Hexa-decimal expressions of instructions

(5) The number of machine cycles needed for execution

   a: Memory access cycle and it has possibility of delay by Ready function.

   b: Memory access cycle and it has possibility of delay by Ready function.
      If an object register in a LD operation is referenced by an immediately following instruction, the interlock function is activated and number of cycles needed for execution increases.

   c: If an immediately following instruction operates to an object of R15, SSP or USP in read/write mode or if the instruction belongs to instruction format A group, the interlock function is activated and number of cycles needed for execution increases by 1 to make the total number of 2 cycles needed.

   d: If an immediately following instruction refers to MDH/MDL, the interlock function is activated and number of cycles needed for execution increases by 1 to make the total number of 2 cycles needed.

   For a, b, c and d, minimum execution cycle is 1.

(6) Change in flag sign
   • Flag change
    C : Change
    − : No change
    0 : Clear
    1 : Set
   • Flag meanings
    N : Negative flag
    Z : Zero flag
    V : Over flag
    C : Carry flag

(7) Operation carried out by instruction

2. Addressing Mode Symbols

Ri	: Register direct (R0 to R15, AC, FP, SP)
Rj	: Register direct (R0 to R15, AC, FP, SP)
R13	: Register direct (R13, AC)
Ps	: Register direct (Program status register)
Rs	: Register direct (TBR, RP, SSP, USP, MDH, MDL)
CRi	: Register direct (CR0 to CR15)
CRj	: Register direct (CR0 to CR15)
#i8	: Unsigned 8-bit immediate (–128 to 255)
	Note: –128 to –1 are interpreted as 128 to 255
#i20	: Unsigned 20-bit immediate (–0X80000 to 0XFFFFF)
	Note: –0X7FFFF to –1 are interpreted as 0X7FFFF to 0XFFFFF
#i32	: Unsigned 32-bit immediate (–0X80000000 to 0XFFFFFFFF)
	Note: –0X80000000 to –1 are interpreted as 0X80000000 to 0XFFFFFFFF
#s5	: Signed 5-bit immediate (–16 to 15)
#s10	: Signed 10-bit immediate (–512 to 508, multiple of 4 only)
#u4	: Unsigned 4-bit immediate (0 to 15)
#u5	: Unsigned 5-bit immediate (0 to 31)
#u8	: Unsigned 8-bit immediate (0 to 255)
#u10	: Unsigned 10-bit immediate (0 to 1020, multiple of 4 only)
@dir8	: Unsigned 8-bit direct address (0 to 0XFF)
@dir9	: Unsigned 9-bit direct address (0 to 0X1FE, multiple of 2 only)
@dir10	: Unsigned 10-bit direct address (0 to 0X3FC, multiple of 4 only)
label9	: Signed 9-bit branch address (–0X100 to 0XFC, multiple of 2 only)
label12	: Signed 12-bit branch address (–0X800 to 0X7FC, multiple of 2 only)
label20	: Signed 20-bit branch address (–0X80000 to 0X7FFFF)
label32	: Signed 32-bit branch address (–0X80000000 to 0X7FFFFFFF)
@Ri	: Register indirect (R0 to R15, AC, FP, SP)
@Rj	: Register indirect (R0 to R15, AC, FP, SP)
@(R13, Rj)	: Register relative indirect (Rj: R0 to R15, AC, FP, SP)
@(R14, disp10)	: Register relative indirect (disp10: –0X200 to 0X1FC, multiple of 4 only)
@(R14, disp9)	: Register relative indirect (disp9: –0X100 to 0XFE, multiple of 2 only)
@(R14, disp8)	: Register relative indirect (disp8: –0X80 to 0X7F)
@(R15, udisp6)	: Register relative (udisp6: 0 to 60, multiple of 4 only)
@Ri+	: Register indirect with post-increment (R0 to R15, AC, FP, SP)
@R13+	: Register indirect with post-increment (R13, AC)
@SP+	: Stack pop
@–SP	: Stack push
(reglist)	: Register list

3. Instruction Types

MSB   ──16 bits──   LSB

Type A

OP	Rj	Ri
8	4	4

Type B

OP	i8/o8	Ri
4	8	4

Type C

OP	u4/m4	Ri
8	4	4

ADD, ADDN, CMP, LSL, LSR and ASR instructions only

Type *C'

OP	s5/u5	Ri
7	5	4

Type D

OP	u8/rel8/dir/reglist
8	8

Type E

OP	SUB-OP	Ri
8	4	4

Type F

OP	rel11
5	11
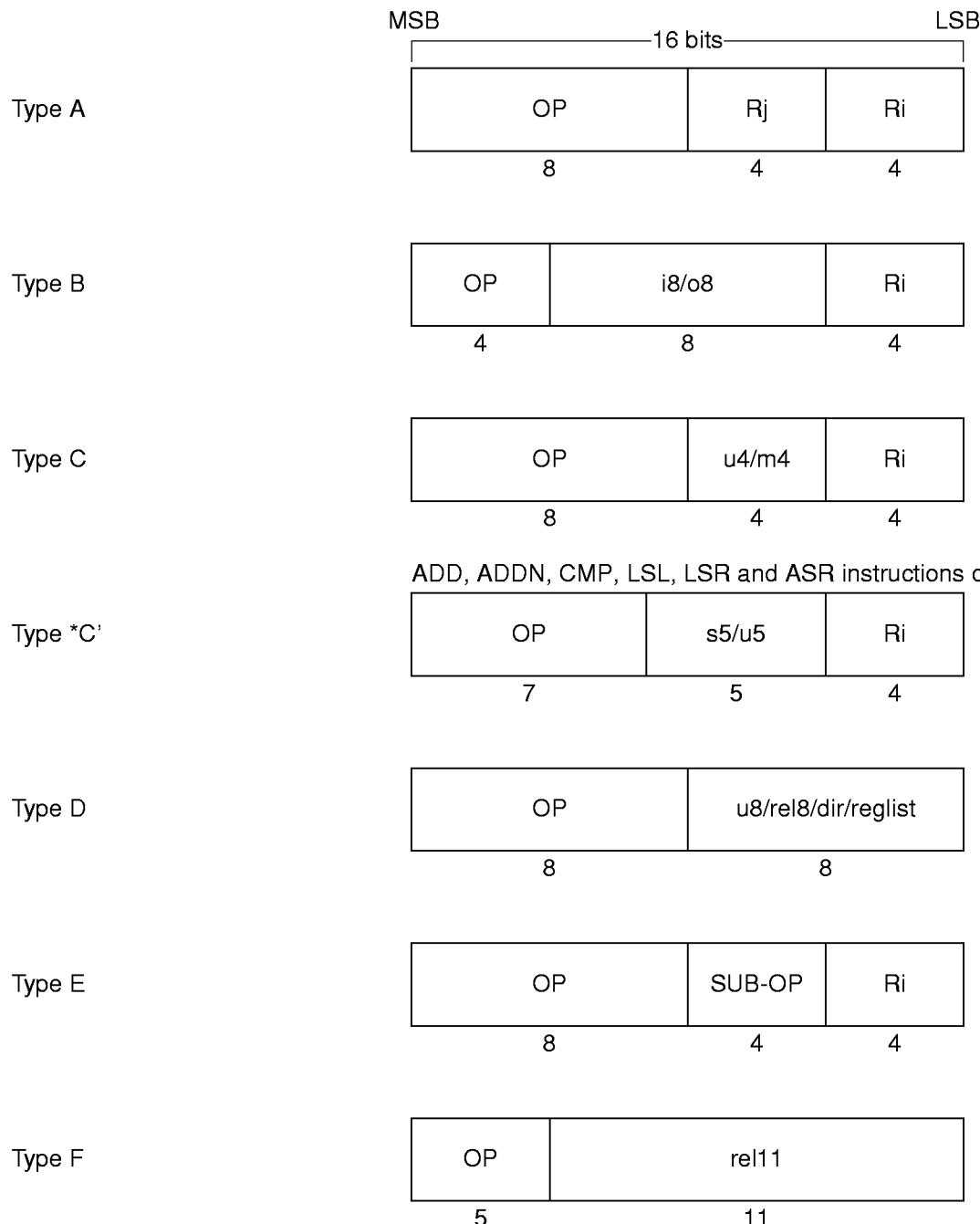
4. Detailed Description of Instructions

• Add/subtract operation instructions (10 instructions)

	Mnemonic	Type	OP	Cycle	N Z V C	Operation	Remarks
ADD	Rj, Ri	A	A6	1	C C C C	Ri + Rj → Ri	
* ADD	#s5, Ri	C'	A4	1	C C C C	Ri + s5 → Ri	MSB is interpreted as a sign in assembly language
ADD	#i4, Ri	C	A4	1	C C C C	Ri + extu (i4) → Ri	Zero-extension
ADD2	#i4, Ri	C	A5	1	C C C C	Ri + extu (i4) → Ri	Sign-extension
ADDC	Rj, Ri	A	A7	1	C C C C	Ri + Rj + c → Ri	Add operation with sign
ADDN	Rj, Ri	A	A2	1	– – – –	Ri + Rj → Ri	
* ADDN	#s5, Ri	C'	A0	1	– – – –	Ri + s5 → Ri	MSB is interpreted as a sign in assembly language
ADDN	#i4, Ri	C	A0	1	– – – –	Ri + extu (i4) → Ri	Zero-extension
ADDN2	#i4, Ri	C	A1	1	– – – –	Ri + extu (i4) → Ri	Sign-extension
SUB	Rj, Ri	A	AC	1	C C C C	Ri – Rj → Ri	
SUBC	Rj, Ri	A	AD	1	C C C C	Ri – Rj – c → Ri	Subtract operation with carry
SUBN	Rj, Ri	A	AE	1	– – – –	Ri – Rj → Ri	

• Compare operation instructions (3 instructions)

	Mnemonic	Type	OP	Cycle	N Z V C	Operation	Remarks
CMP	Rj, Ri	A	AA	1	C C C C	Ri – Rj	
* CMP	#s5, Ri	C'	A8	1	C C C C	Ri – s5	MSB is interpreted as a sign in assembly language
CMP	#i4, Ri	C	A8	1	C C C C	Ri + extu (i4)	Zero-extension
CMP2	#i4, Ri	C	A9	1	C C C C	Ri + extu (i4)	Sign-extension

• Logical operation instructions (12 instructions)

	Mnemonic	Type	OP	Cycle	N Z V C	Operation	Remarks
AND	Rj, Ri	A	82	1	C C – –	Ri & = Rj	Word
AND	Rj, @Ri	A	84	1 + 2a	C C – –	(Ri) & = Rj	Word
ANDH	Rj, @Ri	A	85	1 + 2a	C C – –	(Ri) & = Rj	Half word
ANDB	Rj, @Ri	A	86	1 + 2a	C C – –	(Ri) & = Rj	Byte
OR	Rj, Ri	A	92	1	C C – –	Ri | = Rj	Word
OR	Rj, @Ri	A	94	1 + 2a	C C – –	(Ri) | = Rj	Word
ORH	Rj, @Ri	A	95	1 + 2a	C C – –	(Ri) | = Rj	Half word
ORB	Rj, @Ri	A	96	1 + 2a	C C – –	(Ri) | = Rj	Byte
EOR	Rj, Ri	A	9A	1	C C – –	Ri ^ = Rj	Word
EOR	Rj, @Ri	A	9C	1 + 2a	C C – –	(Ri) ^ = Rj	Word
EORH	Rj, @Ri	A	9D	1 + 2a	C C – –	(Ri) ^ = Rj	Half word
EORB	Rj, @Ri	A	9E	1 + 2a	C C – –	(Ri) ^ = Rj	Byte

- **Bit manipulation arithmetic instructions (8 instructions)**

Mnemonic			Type	OP	Cycle	N Z V C	Operation	Remarks
BANDL	#u4, @Ri (u4: 0 to 0F$_H$)		C	80	1 + 2a	– – – –	(Ri) & = (F0$_H$ + u4)	Manipulate lower 4 bits
BANDH	#u4, @Ri (u4: 0 to 0F$_H$)		C	81	1 + 2a	– – – –	(Ri) & = ((u4<<4) + 0F$_H$)	Manipulate upper 4 bits
* BAND	#u8, @Ri	*1			–	– – – –	(Ri) & = u8	
BORL	#u4, @Ri (u4: 0 to 0F$_H$)		C	90	1 + 2a	– – – –	(Ri) | = u4	Manipulate lower 4 bits
BORH	#u4, @Ri (u4: 0 to 0F$_H$)		C	91	1 + 2a	– – – –	(Ri) | = (u4<<4)	Manipulate upper 4 bits
* BOR	#u8, @Ri	*2			–	– – – –	(Ri) | = u8	
BEORL	#u4, @Ri (u4: 0 to 0F$_H$)		C	98	1 + 2a	– – – –	(Ri) ^ = u4	Manipulate lower 4 bits
BEORH	#u4, @Ri (u4: 0 to 0F$_H$)		C	99	1 + 2a	– – – –	(Ri) ^ = (u4<<4)	Manipulate upper 4 bits
* BEOR	#u8, @Ri	*3			–	– – – –	(Ri) ^ = u8	
BTSTL	#u4, @Ri (u4: 0 to 0F$_H$)		C	88	2 + a	0 C – –	(Ri) & u4	Test lower 4 bits
BTSTH	#u4, @Ri (u4: 0 to 0F$_H$)		C	89	2 + a	C C – –	(Ri) & (u4<<4)	Test upper 4 bits

*1: Assembler generates BANDL if result of logical operation "u8&0x0F" leaves an active (set) bit and generates BANDH if "u8&0xF0" leaves an active bit. Depending on the value in the "u8" format, both BANDL and BANDH may be generated.

*2: Assembler generates BORL if result of logical operation "u8&0x0F" leaves an active (set) bit and generates BORH if "u8&0xF0" leaves an active bit.

*3: Assembler generates BEORL if result of logical operation "u8&0x0F" leaves an active (set) bit and generates BEORH if "u8&0xF0" leaves an active bit.

- **Add/subtract operation instructions (10 instructions)**

Mnemonic			Type	OP	Cycle	N Z V C	Operation	Remarks
MUL	Rj, Ri		A	AF	5	C C C –	Rj × Ri → MDH, MDL	32-bit × 32-bit = 64-bit
MULU	Rj, Ri		A	AB	5	C C C –	Rj × Ri → MDH, MDL	Unsigned
MULH	Rj, Ri		A	BF	3	C C – –	Rj × Ri → MDL	16-bit × 16-bit = 32-bit
MULUH	Rj, Ri		A	BB	3	C C – –	Rj × Ri → MDL	Unsigned
DIVOS	Ri		E	97 – 4	1	– – – –		Step calculation
DIVOU	Ri		E	97 – 5	1	– – – –		32-bit/32-bit = 32-bit
DIV1	Ri		E	97 – 6	d	– C – C		
DIV2	Ri		E	97 – 7	1	– C – C		
DIV3			E	9F – 6	1	– – – –		
DIV4S			E	9F – 7	1	– – – –		
* DIV	Ri	*1			–	– C – C	MDL/Ri → MDL, MDL%Ri → MDH	
* DIVU	Ri	*2			–	– C – C	MDL/Ri → MDL, MDL%Ri → MDH	Unsigned

*1: DIVOS, DIV1 × 32, DIV2, DIV3 and DIV4S are generated. A total instruction code length of 72 bytes.

*2: DIVOU and DIV1 × 32 are generated. A total instruction code length of 66 bytes.

- **Shift arithmetic instructions (9 instructions)**

Mnemonic		Type	OP	Cycle	N Z V C	Operation	Remarks
LSL	Rj, Ri	A	B6	1	C C – C	Ri<<Rj → Ri	Logical shift
* LSL	#u5, Ri	C'	B4	1	C C – C	Ri<<u5 → Ri	
LSL	#u4, Ri	C	B4	1	C C – C	Ri<<u4 → Ri	
LSL2	#u4, Ri	C	B5	1	C C – C	Ri<<(u4 + 16) → Ri	
LSR	Rj, Ri	A	B2	1	C C – C	Ri>>Rj → Ri	Logical shift
* LSR	#u5, Ri	C'	B0	1	C C – C	Ri>>u5 → Ri	
LSR	#u4, Ri	C	B0	1	C C – C	Ri>>u4 → Ri	
LSR2	#u4, Ri	C	B1	1	C C – C	Ri>>(u4 + 16) → Ri	
ASR	Rj, Ri	A	BA	1	C C – C	Ri>>Rj → Ri	Logical shift
* ASR	#u5, Ri	C'	B8	1	C C – C	Ri>>u5 → Ri	
ASR	#u4, Ri	C	B8	1	C C – C	Ri>>u4 → Ri	
ASR2	#u4, Ri	C	B9	1	C C – C	Ri>>(u4 + 16) → Ri	

- **Immediate value data transfer instruction (immediate value set/16-bit/32-bit immediate value transfer instruction) (3 instructions)**

Mnemonic		Type	OP	Cycle	N Z V C	Operation	Remarks
LDI: 32	#i32, Ri	E	9F – 8	3	– – – –	i32 → Ri	
LDI: 20	#i20, Ri	C	9B	2	– – – –	i20 → Ri	Upper 12 bits are zero-extended
LDI: 8	#i8, Ri	B	C0	1	– – – –	i8 → Ri	Upper 24 bits are zero-extended
* LDI	# {i8 | i20 | i32}, Ri *1					{i8 | i20 | i32} → Ri	

*1: If an immediate value is given in absolute, assembler automatically makes i8, i20 or i32 selection.
   If an immediate value contains relative value or external reference, assembler selects i32.

- **Memory load instructions (13 instructions)**

Mnemonic		Type	OP	Cycle	N Z V C	Operation	Remarks
LD	@Rj, Ri	A	04	b	– – – –	(Rj) → Ri	
LD	@(R13, Rj), Ri	A	00	b	– – – –	(R13 + Rj) → Ri	
LD	@(R14, disp10), Ri	B	20	b	– – – –	(R14 + disp10) → Ri	
LD	@(R15, udisp6), Ri	C	03	b	– – – –	(R15 + udisp6) → Ri	
LD	@R15 +, Ri	E	07 – 0	b	– – – –	(R15) → Ri, R15 + = 4	
LD	@R15 +, Rs	E	07 – 8	b	– – – –	(R15) → Rs, R15 + = 4	Rs: Special-purpose register
LD	@R15 +, PS	E	07 – 9	1 + a + b	C C C C	(R15) → PS, R15 + = 4	
LDUH	@Rj, Ri	A	05	b	– – – –	(Rj) → Ri	Zero-extension
LDUH	@(R13, Rj), Ri	A	01	b	– – – –	(R13 + Rj) → Ri	Zero-extension
LDUH	@(R14, disp9), Ri	B	40	b	– – – –	(R14 + disp9) → Ri	Zero-extension
LDUB	@Rj, Ri	A	06	b	– – – –	(Rj) → Ri	Zero-extension
LDUB	@(R13, Rj), Ri	A	02	b	– – – –	(R13 + Rj) → Ri	Zero-extension
LDUB	@(R14, disp8), Ri	B	60	b	– – – –	(R14 + disp8) → Ri	Zero-extension

Note: The relations between o8 field of TYPE-B and u4 field of TYPE-C in the instruction format and assembler description from disp8 to disp10 are as follows:

disp8 → o8 = disp8
disp9 → o8 = disp9>>1 } Each disp is a code extension.
disp10 → o8 = disp10>>2
udisp6 → u4 = udisp6>>2   udisp4 is a 0 extension.

• **Memory store instructions (13 instructions)**

Mnemonic		Type	OP	Cycle	N Z V C	Operation	Remarks
ST	Ri, @Rj	A	14	a	– – – –	Ri → (Rj)	Word
ST	Ri, @(R13, Rj)	A	10	a	– – – –	Ri → (R13 + Rj)	Word
ST	Ri, @(R14, disp10)	B	30	a	– – – –	Ri → (R14 + disp10)	Word
ST	Ri, @(R15, udisp6)	C	13	a	– – – –	Ri → (R15 + usidp6)	
ST	Ri, @–R15	E	17 – 0	a	– – – –	R15 – = 4, Ri → (R15)	
ST	Rs, @–R15	E	17 – 8	a	– – – –	R15 – = 4, Rs → (R15)	Rs: Special-purpose register
ST	PS, @–R15	E	17 – 9	a	– – – –	R15 – = 4, PS → (R15)	
STH	Ri, @Rj	A	15	a	– – – –	Ri → (Rj)	Half word
STH	Ri, @(R13, Rj)	A	11	a	– – – –	Ri → (R13 + Rj)	Half word
STH	Ri, @(R14, disp9)	B	50	a	– – – –	Ri → (R14 + disp9)	Half word
STB	Ri, @Rj	A	16	a	– – – –	Ri → (Rj)	Byte
STB	Ri, @(R13, Rj)	A	12	a	– – – –	Ri → (R13 + Rj)	Byte
STB	Ri, @(R14, disp8)	B	70	a	– – – –	Ri → (R14 + disp8)	Byte

Note: The relations between o8 field of TYPE-B and u4 field of TYPE-C in the instruction format and assembler description from disp8 to disp10 are as follows:

disp8 → o8 = disp8
disp9 → o8 = disp9>>1   } Each disp is a code extension.
disp10 → o8 = disp10>>2
udisp6 → u4 = udisp6>>2   udisp4 is a 0 extension.

• **Transfer instructions between registers/special-purpose registers transfer instructions (5 instructions)**

Mnemonic		Type	OP	Cycle	N Z V C	Operation	Remarks
MOV	Rj, Ri	A	8B	1	– – – –	Rj → Ri	Transfer between general-purpose registers
MOV	Rs, Ri	A	B7	1	– – – –	Rs → Ri	Rs: Special-purpose register
MOV	Ri, Rs	A	B3	1	– – – –	Ri → Rs	Rs: Special-purpose register
MOV	PS, Ri	E	17 – 1	1	– – – –	PS → Ri	
MOV	Ri, PS	E	07 – 1	c	C C C C	Ri → PS	

• **Non-delay normal branch instructions (23 instructions)**

Mnemonic		Type	OP	Cycle	N Z V C	Operation	Remarks
JMP	@Ri	E	97 − 0	2	− − − −	Ri → PC	
CALL	label12	F	D0	2	− − − −	PC + 2 → RP, PC + 2 + rel11 × 2 → PC	
CALL	@Ri	E	97 − 1	2	− − − −	PC + 2 → RP, Ri → PC	
RET		E	97 − 2	2	− − − −	RP → PC	Return
INT	#u8	D	1F	3+3a	− − − −	SSP − = 4, PS → (SSP), SSP − = 4, PC + 2 → (SSP), 0 → I flag, 0 → S flag, (TBR + 3FC − u8 × 4) → PC	
INTE		E	9F − 3	3 + 3a	− − − −	SSP − = 4, PS → (SSP), SSP − = 4, PC + 2 → (SSP), 0 → S flag, (TBR + 3D8 − u8 × 4) → PC	For emulator
RETI		E	97 − 3	2 + 2a	C C C C	(R15) → PC, R15 − = 4, (R15) → PS, R15 − = 4	
BNO	label9	D	E1	1	− − − −	Non-branch	
BRA	label9	D	E0	2	− − − −	PC + 2 + rel8 × 2 → PC	
BEQ	label9	D	E2	2/1	− − − −	PCif Z = = 1	
BNE	label9	D	E3	2/1	− − − −	PCif Z = = 0	
BC	label9	D	E4	2/1	− − − −	PCif C = = 1	
BNC	label9	D	E5	2/1	− − − −	PCif C = = 0	
BN	label9	D	E6	2/1	− − − −	PCif N = = 1	
BP	label9	D	E7	2/1	− − − −	PCif N = = 0	
BV	label9	D	E8	2/1	− − − −	PCif V = = 1	
BNV	label9	D	E9	2/1	− − − −	PCif V = = 0	
BLT	label9	D	EA	2/1	− − − −	PCif V xor N = = 1	
BGE	label9	D	EB	2/1	− − − −	PCif V xor N = = 0	
BLE	label9	D	EC	2/1	− − − −	PCif (V xor N) or Z = = 1	
BGT	label9	D	ED	2/1	− − − −	PCif (V xor N) or Z = = 0	
BLS	label9	D	EE	2/1	− − − −	PCif C or Z = = 1	
BHI	label9	D	EF	2/1	− − − −	PCif C or Z = = 0	

Notes: • "2/1" in cycle sections indicates that 2 cycles are needed for branch and 1 cycle needed for non-branch.
• The relations between rel8 field of TYPE-D and rel11 field of TYPE-F in the instruction format and assembler discription label9 and label12 are as follows.
label9 → rel8 = (label9 − PC − 2)/2
label12 → rel11 = (label12 − PC − 2)/2
• RETI must be operated while S flag = 0.

• **Branch instructions with delays (20 instructions)**

Mnemonic		Type	OP	Cycle	N Z V C	Operation	Remarks
JMP:D	@Ri	E	9F − 0	1	− − − −	Ri → PC	
CALL:D	label12	F	D8	1	− − − −	PC + 4 → RP, PC + 2 + rel11 × 2 → PC	
CALL:D	@Ri	E	9F − 1	1	− − − −	PC + 4 → RP, Ri → PC	
RET:D		E	9F − 2	1	− − − −	RP → PC	Return
BNO:D	label9	D	F1	1	− − − −	Non-branch	
BRA:D	label9	D	F0	1	− − − −	PC + 2 + rel8 × 2 → PC	
BEQ:D	label9	D	F2	1	− − − −	PCif Z = = 1	
BNE:D	label9	D	F3	1	− − − −	PCif Z = = 0	
BC:D	label9	D	F4	1	− − − −	PCif C = = 1	
BNC:D	label9	D	F5	1	− − − −	PCif C = = 0	
BN:D	label9	D	F6	1	− − − −	PCif N = = 1	
BP:D	label9	D	F7	1	− − − −	PCif N = = 0	
BV:D	label9	D	F8	1	− − − −	PCif V = = 1	
BNV:D	label9	D	F9	1	− − − −	PCif V = = 0	
BLT:D	label9	D	FA	1	− − − −	PCif V xor N = = 1	
BGE:D	label9	D	FB	1	− − − −	PCif V xor N = = 0	
BLE:D	label9	D	FC	1	− − − −	PCif (V xor N) or Z = = 1	
BGT:D	label9	D	FD	1	− − − −	PCif (V xor N) or Z = = 0	
BLS:D	label9	D	FE	1	− − − −	PCif C or Z = = 1	
BHI:D	label9	D	FF	1	− − − −	PCif C or Z = = 0	

Notes: • The relations between rel8 field of TYPE-D and rel11 field of TYPE-F in the instruction format and assembler discription label9 and label12 are as follows.

label9 → rel8 = (label9 − PC − 2)/2

label12 → rel11 = (label12 − PC − 2)/2

• Delayed branch operation always executes next instruction (delay slot) before making a branch.

• Instructions allowed to be stored in the delay slot must meet one of the following conditions. If the other instruction is stored, this device may operate other operation than defined.

The instruction described "1" in the other cycle column than branch instruction.

The instruction described "a", "b", "c" or "d" in the cycle column.

- **Direct addressing instructions**

Mnemonic		Type	OP	Cycle	N Z V C	Operation	Remarks
DMOV	@dir10, R13	D	08	b	– – – –	(dir10) → R13	Word
DMOV	R13, @dir10	D	18	a	– – – –	R13 → (dir10)	Word
DMOV	@dir10, @R13+	D	0C	2a	– – – –	(dir10) → (R13), R13 + = 4	Word
DMOV	@R13+, @dir10	D	1C	2a	– – – –	(R13) → (dir10), R13 + = 4	Word
DMOV	@dir10, @–R15	D	0B	2a	– – – –	R15 – = 4, (dir10) → (R15)	Word
DMOV	@R15+, @dir10	D	1B	2a	– – – –	(R15) → (dir10), R15 + = 4	Word
DMOVH	@dir9, R13	D	09	b	– – – –	(dir9) → R13	Half word
DMOVH	R13, @dir9	D	19	a	– – – –	R13 → (dir9)	Half word
DMOVH	@dir9, @R13+	D	0D	2a	– – – –	(dir9) → (R13), R13 + = 2	Half word
DMOVH	@R13+, @dir9	D	1D	2a	– – – –	(R13) → (dir9), R13 + = 2	Half word
DMOVB	@dir8, R13	D	0A	b	– – – –	(dir8) → R13	Byte
DMOVB	R13, @dir8	D	1A	a	– – – –	R13 → (dir8)	Byte
DMOVB	@dir8, @R13+	D	0E	2a	– – – –	(dir8) → (R13), R13 + +	Byte
DMOVB	@R13+, @dir8	D	1E	2a	– – – –	(R13) → (dir8), R13 + +	Byte

Note: The relations between the dir field of TYPE-D in the instruction format and the assembler description from
disp8 to disp10 are as follows:

disp8 → dir + disp8
disp9 → dir = disp9>>1   } Each disp is a code extension
disp10 → dir = disp10>>2

- **Resource instructions (2 instructions)**

Mnemonic		Type	OP	Cycle	N Z V C	Operation	Remarks
LDRES	@Ri+, #u4	C	BC	a	– – – –	(Ri) → u4 resource Ri + = 4	u4: Channel number
STRES	#u4, @Ri+	C	BD	a	– – – –	u4 resource → (Ri) Ri + = 4	u4: Channel number

- **Co-processor instructions (4 instructions)**

Mnemonic		Type	OP	Cycle	N Z V C	Operation	Remarks
COPOP	#u4, #CC, CRj, CRi	E	9F – C	2 + a	– – – –	Calculation	
COPLD	#u4, #CC, Rj, CRi	E	9F – D	1 + 2a	– – – –	Rj → CRi	
COPST	#u4, #CC, CRj, Ri	E	9F – E	1 + 2a	– – – –	CRj → Ri	
COPSV	#u4, #CC, CRj, Ri	E	9F – F	1 + 2a	– – – –	CRj → Ri	No error traps

• **Other instructions (16 instructions)**

Mnemonic	Type	OP	Cycle	N Z V C	Operation	Remarks
NOP	E	9F – A	1	– – – –	No changes	
ANDCCR #u8	D	83	c	C C C C	CCR and u8 → CCR	
ORCCR #u8	D	93	c	C C C C	CCR or u8 → CCR	
STILM #u8	D	87	1	– – – –	i8 → ILM	Set ILM immediate value
ADDSP #s10 *1	D	A3	1	– – – –	R15 + = s10	ADD SP instruction
EXTSB Ri	E	97 – 8	1	– – – –	Sign extension 8 → 32 bits	
EXTUB Ri	E	97 – 9	1	– – – –	Zero extension 8 → 32 bits	
EXTSH Ri	E	97 – A	1	– – – –	Sign extension 16 → 32 bits	
EXTUH Ri	E	97 – B	1	– – – –	Zero extension 16 → 32 bits	
LDM0 (reglist)	D	8C	*4	– – – –	(R15) → reglist, R15 increment	Load-multi R0 to R7
LDM1 (reglist)	D	8D	*4	– – – –	(R15) → reglist, R15 increment	Load-multi R8 to R15
* LDM (reglist) *3			–	– – – –	(R15 + +) → reglist,	Load-multi R0 to R15
STM0 (reglist)	D	8E	*6	– – – –	R15 decrement, reglist → (R15)	Store-multi R0 to R7
STM1 (reglist)	D	8F	*6	– – – –	R15 decrement, reglist → (R15)	Store-multi R8 to R15
* STM2 (reglist) *5			–	– – – –	reglist → (R15 + +)	Store-multi R0 to R15
ENTER #u10 *2	D	0F	1+a	– – – –	R14 → (R15 – 4), R15 – 4 → R14, R15 – u10 → R15	Entrance processing of function
LEAVE	E	9F – 9	b	– – – –	R14 + 4 → R15, (R15 – 4) → R14	Exit processing of function
XCHB @Rj, Ri	A	8A	2a	– – – –	Ri → TEMP, (Rj) → Ri, TEMP → (Rj)	For SEMAFO management Byte data

*1: In the ADDSP instruction, the reference between u8 of TYPE-D in the instruction format and assembler description s10 is as follows.
s10 → s8 = s10>>2
*2: In the ENTER instruction, the reference between i8 of TYPE-C in the instruction format and assembler description u10 is as follows.
u10 → u8 = u10>>2
*3: If either of R0 to R7 is specified in reglist, assembler generates LDM0. If either of R8 to R15 is specified, assembler generates LDM1. Both LDM0 and LDM1 may be generated.
*4: The number of cycles needed for execution of LDM0 (reglist) and LDM1 (reglist) is given by the following calculation; a × (n – 1) + b + 1 when "n" is number of registers specified.
*5: If either of R0 to R7 is specified in reglist, assembler generates STM0. If either of R8 to R15 is specified, assembler generates STM1. Both STM0 and STM1 may be generated.
*6: The number of cycles needed for execution of STM0 (reglist) and STM1 (reglist) is given by the following calculation; a × n + 1 when "n" is number of registers specified.

- **20-bit normal branch macro instructions**

Mnemonic	Operation	Remarks	
* CALL20 label20, Ri	Next instruction address → RP, label20 → PC	Ri: Temporary register	*1
* BRA20 label20, Ri	label20 → PC	Ri: Temporary register	*2
* BEQ20 label20, Ri	if (Z = = 1) then label20 → PC	Ri: Temporary register	*3
* BNE20 label20, Ri	ifs/Z = = 0	Ri: Temporary register	*3
* BC20 label20, Ri	ifs/C = = 1	Ri: Temporary register	*3
* BNC20 label20, Ri	ifs/C = = 0	Ri: Temporary register	*3
* BN20 label20, Ri	ifs/N = = 1	Ri: Temporary register	*3
* BP20 label20, Ri	ifs/N = = 0	Ri: Temporary register	*3
* BV20 label20, Ri	ifs/V = = 1	Ri: Temporary register	*3
* BNV20 label20, Ri	ifs/V = = 0	Ri: Temporary register	*3
* BLT20 label20, Ri	ifs/V xor N = = 1	Ri: Temporary register	*3
* BGE20 label20, Ri	ifs/V xor N = = 0	Ri: Temporary register	*3
* BLE20 label20, Ri	ifs/(V xor N) or Z = = 1	Ri: Temporary register	*3
* BGT20 label20, Ri	ifs/(V xor N) or Z = = 0	Ri: Temporary register	*3
* BLS20 label20, Ri	ifs/C or Z = = 1	Ri: Temporary register	*3
* BHI20 label20, Ri	ifs/C or Z = = 0	Ri: Temporary register	*3

*1: CALL20
   (1) If label20 − PC − 2 is between −0x800 and +0x7fe, instruction is generated as follows;
        CALL   label12
   (2) If label20 − PC − 2 is outside of the range given in (1) or includes external reference symbol, instruction is generated as follows;
        LDI:20   #label20, Ri
        CALL   @Ri
*2: BRA20
   (1) If label20 − PC − 2 is between −0x100 and +0xfe, instruction is generated as follows;
        BRA   label9
   (2) If label20 − PC − 2 is outside of the range given in (1) or includes external reference symbol, instruction is generated as follows;
        LDI:20   #label20, Ri
        JMP   @Ri
*3: Bcc20 (BEQ20 to BHI20)
   (1) If label20 − PC − 2 is between −0x100 and +0xfe, instruction is generated as follows;
        Bcc   label9
   (2) If label20 − PC − 2 is outside of the range given in (1) or includes external reference symbol, instruction is generated as follows;
        Bxcc   false   xcc is a revolt condition of cc
        LDI:20   #label20, Ri
        JMP   @Ri
        false:

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- **20-bit delayed branch macro instructions**

Mnemonic	Operation	Remarks	
* CALL20:D label20, Ri	Next instruction address + 2 → RP, label20 → PC	Ri: Temporary register	*1
* BRA20:D label20, Ri	label20 → PC	Ri: Temporary register	*2
* BEQ20:D label20, Ri	if (Z = = 1) then label20 → PC	Ri: Temporary register	*3
* BNE20:D label20, Ri	ifs/Z = = 0	Ri: Temporary register	*3
* BC20:D label20, Ri	ifs/C = = 1	Ri: Temporary register	*3
* BNC20:D label20, Ri	ifs/C = = 0	Ri: Temporary register	*3
* BN20:D label20, Ri	ifs/N = = 1	Ri: Temporary register	*3
* BP20:D label20, Ri	ifs/N = = 0	Ri: Temporary register	*3
* BV20:D label20, Ri	ifs/V = = 1	Ri: Temporary register	*3
* BNV20:D label20, Ri	ifs/V = = 0	Ri: Temporary register	*3
* BLT20:D label20, Ri	ifs/V xor N = = 1	Ri: Temporary register	*3
* BGE20:D label20, Ri	ifs/V xor N = = 0	Ri: Temporary register	*3
* BLE20:D label20, Ri	ifs/(V xor N) or Z = = 1	Ri: Temporary register	*3
* BGT20:D label20, Ri	ifs/(V xor N) or Z = = 0	Ri: Temporary register	*3
* BLS20:D label20, Ri	ifs/C or Z = = 1	Ri: Temporary register	*3
* BHI20:D label20, Ri	ifs/C or Z = = 0	Ri: Temporary register	*3

*1: CALL20:D
   (1) If label20 – PC – 2 is between –0x800 and +0x7fe, instruction is generated as follows;
       CALL:D   label12
   (2) If label20 – PC – 2 is outside of the range given in (1) or includes external reference symbol, instruction is
       generated as follows;
       LDI:20   #label20, Ri
       CALL:D   @Ri
*2: BRA20:D
   (1) If label20 – PC – 2 is between –0x100 and +0xfe, instruction is generated as follows;
       BRA:D   label9
   (2) If label20 – PC – 2 is outside of the range given in (1) or includes external reference symbol, instruction is
       generated as follows;
       LDI:20   #label20, Ri
       JMP:D   @Ri
*3: Bcc20:D (BEQ20:D to BHI20:D)
   (1) If label20 – PC – 2 is between –0x100 and +0xfe, instruction is generated as follows;
       Bcc:D   label9
   (2) If label20 – PC – 2 is outside of the range given in (1) or includes external reference symbol, instruction is
       generated as follows;
       Bxcc   false   xcc is a revolt condition of cc
       LDI:20   #label20, Ri
       JMP:D   @Ri
       false:

• **32-bit normal macro branch instructions**

Mnemonic	Operation	Remarks	
* CALL32　label32, Ri	Next instruction address → RP, label32 → PC	Ri: Temporary register	*1
* BRA32　label32, Ri	label32 → PC	Ri: Temporary register	*2
* BEQ32　label32, Ri	if (Z = = 1) then label32 → PC	Ri: Temporary register	*3
* BNE32　label32, Ri	ifs/Z = = 0	Ri: Temporary register	*3
* BC32　label32, Ri	ifs/C = = 1	Ri: Temporary register	*3
* BNC32　label32, Ri	ifs/C = = 0	Ri: Temporary register	*3
* BN32　label32, Ri	ifs/N = = 1	Ri: Temporary register	*3
* BP32　label32, Ri	ifs/N = = 0	Ri: Temporary register	*3
* BV32　label32, Ri	ifs/V = = 1	Ri: Temporary register	*3
* BNV32　label32, Ri	ifs/V = = 0	Ri: Temporary register	*3
* BLT32　label32, Ri	ifs/V xor N = = 1	Ri: Temporary register	*3
* BGE32　label32, Ri	ifs/V xor N = = 0	Ri: Temporary register	*3
* BLE32　label32, Ri	ifs/(V xor N) or Z = = 1	Ri: Temporary register	*3
* BGT32　label32, Ri	ifs/(V xor N) or Z = = 0	Ri: Temporary register	*3
* BLS32　label32, Ri	ifs/C or Z = = 1	Ri: Temporary register	*3
* BHI32　label32, Ri	ifs/C or Z = = 0	Ri: Temporary register	*3

*1: CALL32
    (1) If label32 − PC − 2 is between −0x800 and +0x7fe, instruction is generated as follows;
        CALL   label12
    (2) If label32 − PC − 2 is outside of the range given in (1) or includes external reference symbol, instruction is generated as follows;
        LDI:32   #label32, Ri
        CALL   @Ri

*2: BRA32
    (1) If label32 − PC − 2 is between −0x100 and +0xfe, instruction is generated as follows;
        BRA   label9
    (2) If label32 − PC − 2 is outside of the range given in (1) or includes external reference symbol, instruction is generated as follows;
        LDI:32   #label32, Ri
        JMP   @Ri

*3: Bcc32 (BEQ32 to BHI32)
    (1) If label32 − PC − 2 is between −0x100 and +0xfe, instruction is generated as follows;
        Bcc   label9
    (2) If label32 − PC − 2 is outside of the range given in (1) or includes external reference symbol, instruction is generated as follows;
        Bxcc   false   xcc is a revolt condition of cc
        LDI:32   #label32, Ri
        JMP   @Ri
        false:

- **32-bit delayed macro branch instructions**

Mnemonic	Operation	Remarks	
* CALL32:D label32, Ri	Next instruction address + 2 → RP, label32 → PC	Ri: Temporary register	*1
* BRA32:D label32, Ri	label32 → PC	Ri: Temporary register	*2
* BEQ32:D label32, Ri	if (Z = = 1) then label32 → PC	Ri: Temporary register	*3
* BNE32:D label32, Ri	ifs/Z = = 0	Ri: Temporary register	*3
* BC32:D label32, Ri	ifs/C = = 1	Ri: Temporary register	*3
* BNC32:D label32, Ri	ifs/C = = 0	Ri: Temporary register	*3
* BN32:D label32, Ri	ifs/N = = 1	Ri: Temporary register	*3
* BP32:D label32, Ri	ifs/N = = 0	Ri: Temporary register	*3
* BV32:D label32, Ri	ifs/V = = 1	Ri: Temporary register	*3
* BNV32:D label32, Ri	ifs/V = = 0	Ri: Temporary register	*3
* BLT32:D label32, Ri	ifs/V xor N = = 1	Ri: Temporary register	*3
* BGE32:D label32, Ri	ifs/V xor N = = 0	Ri: Temporary register	*3
* BLE32:D label32, Ri	ifs/(V xor N) or Z = = 1	Ri: Temporary register	*3
* BGT32:D label32, Ri	ifs/(V xor N) or Z = = 0	Ri: Temporary register	*3
* BLS32:D label32, Ri	ifs/C or Z = = 1	Ri: Temporary register	*3
* BHI32:D label32, Ri	ifs/C or Z = = 0	Ri: Temporary register	*3

*1: CALL32:D
   (1) If label32 − PC − 2 is between −0x800 and +0x7fe, instruction is generated as follows;
       CALL:D label12
   (2) If label32 − PC − 2 is outside of the range given in (1) or includes external reference symbol, instruction is generated as follows;
       LDI:32 #label32, Ri
       CALL:D @Ri

*2: BRA32:D
   (1) If label32 − PC − 2 is between −0x100 and +0xfe, instruction is generated as follows;
       BRA:D   label9
   (2) If label32 − PC − 2 is outside of the range given in (1) or includes external reference symbol, instruction is generated as follows;
       LDI:32 #label32, Ri
       JMP:D   @Ri

*3: Bcc32:D (BEQ32:D to BHI32:D)
   (1) If label32 − PC − 2 is between −0x100 and +0xfe, instruction is generated as follows;
       Bcc:D   label9
   (2) If label32 − PC − 2 is outside of the range given in (1) or includes external reference symbol, instruction is generated as follows;
       Bxcc   false   xcc is a revolt condition of cc
       LDI:32 #label32, Ri
       JMP:D   @Ri
   false:

MB91101 Series

■ ORDERING INFORMATION

| Part number	Package	Remarks
MB91101PFV-G-BND-R	100-pin Plastic LQFP (FPT-100P-M05)	
MB91101PF-G-BND-R	100-pin Plastic QFP (FPT-100P-M06)	

■ PACKAGE DIMENSIONS

100-pin Plastic LQFP
(FPT-100P-M05)

16.00±0.20(.630±.008)SQ

14.00±0.10(.551±.004)SQ

75

51

76

50

INDEX

100

26

LEAD No. 1

25

"A"

0.50(.0197)TYP   0.18 $^{+0.08}_{-0.03}$ ⊕ 0.08(.003) Ⓜ
(.007 $^{+.003}_{-.001}$)

0.10(.004)

1.50 $^{+0.20}_{-0.10}$ (Mounting height)
(.059 $^{+.008}_{-.004}$)

12.00   15.00
(.472)   (.591)
REF   NOM

"B"

0.127 $^{+0.05}_{-0.02}$
(.005 $^{+.002}_{-.001}$)

Details of "A" part
0.15(.006)
0.15(.006)
0.15(.006)MAX
0.40(.016)MAX

Details of "B" part
0.10±0.10 (STAND OFF)
(.004±.004)
0.50±0.20(.020±.008)
0~10°
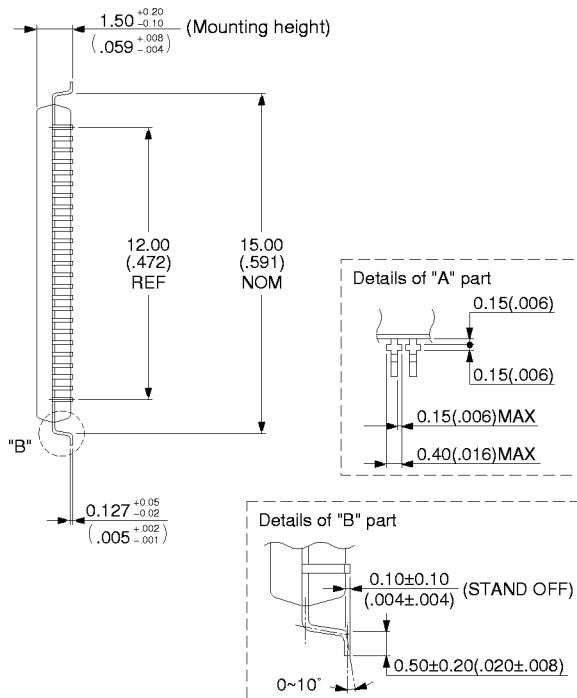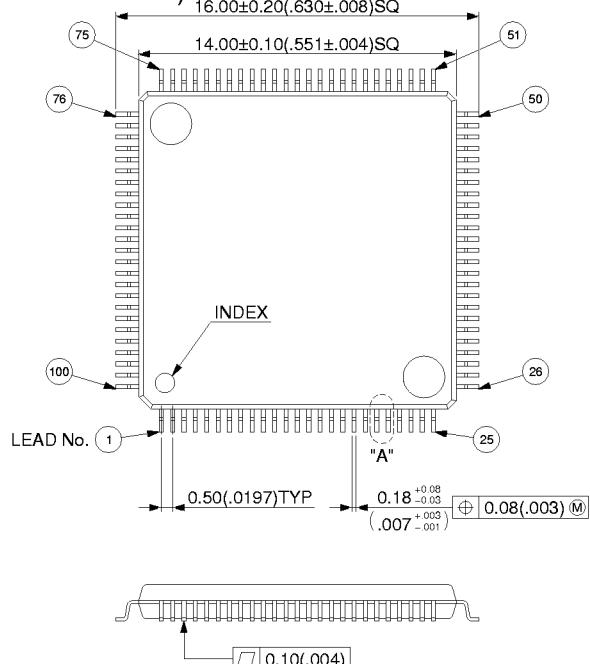
© 1995 FUJITSU LIMITED F100007S-2C-3

Dimensions in mm (inches)

MB91101 Series

100-pin Plastic QFP
(FPT-100P-M06)

23.90±0.40(.941±.016)

20.00±0.20(.787±.008)

14.00±0.20
(.551±.008)   17.90±0.40
(.705±.016)

INDEX

"A"

LEAD No. 1

0.65(.0256)TYP   0.30±0.10
(.012±.004)   ⊕ 0.13(.005) Ⓜ

3.35(.132)MAX
(Mounting height)

0.05(.002)MIN
(STAND OFF)

12.35(.486)
REF   16.30±0.40
(.642±.016)

0.15±0.05(.006±.002)

"B"

▱ 0.10(.004)

18.85(.742)REF

22.30±0.40(.878±.016)

Details of "A" part

0.25(.010)

0.30(.012)

0.18(.007)MAX

0.53(.021)MAX

Details of "B" part

0 ~ 10°

0.80±0.20
(.031±.008)
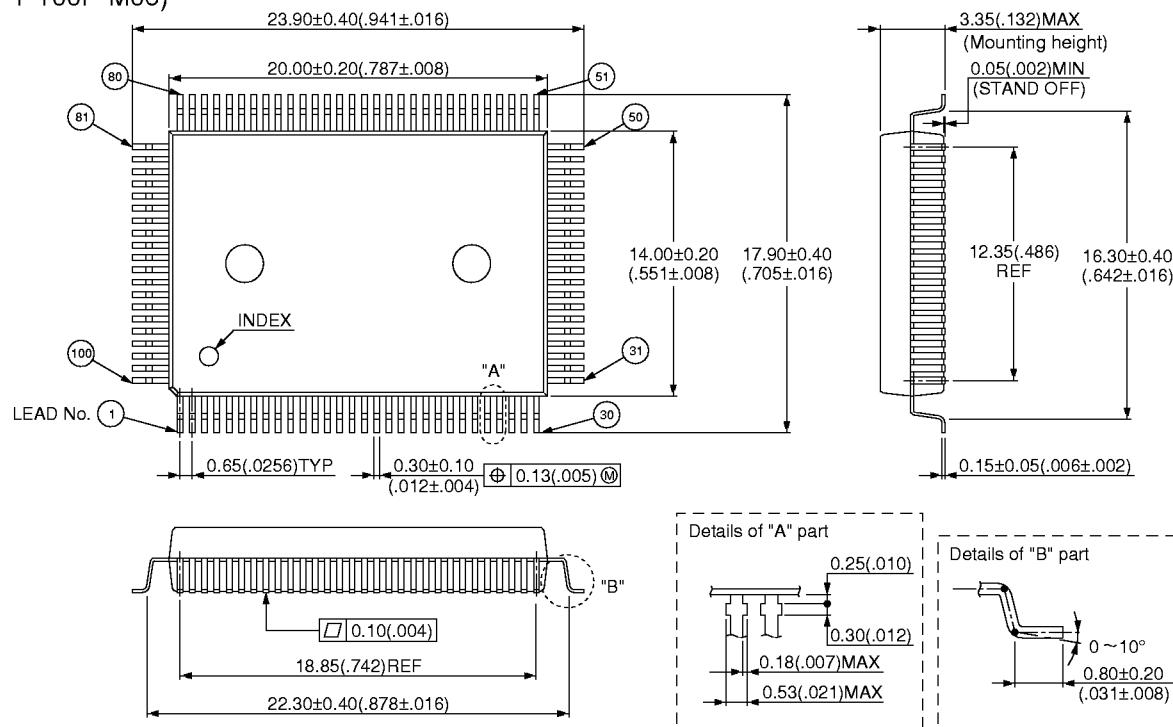
© 1994 FUJITSU LIMITED F100008-3C-2

Dimensions in mm (inches)

Note: The design may be modified changed without notice, contact to Fujitsu sales division when using the device.

FUJITSU LIMITED

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